



# MSP430F51x2, MSP430F51x1 ミクスト・シグナル・マイクロコントローラ

## 1 デバイスの概要

### 1.1 特長

- 低い電源電圧範囲: 3.6Vから最低1.8Vまで
  - 超低消費電力
    - アクティブ・モード(AM): 180 $\mu$ A/MHz
    - スタンバイ・モード(LPM3 WDTモード、3V): 1.1 $\mu$ A
    - オフ・モード(LPM4 RAMの内容保持、3V): 0.9 $\mu$ A
    - シャットダウン・モード(LPM4.5、3V): 0.25 $\mu$ A
  - スタンバイ・モードから5 $\mu$ s以内にウェークアップ
  - 16ビットRISCアーキテクチャ、拡張メモリ、命令サイクル・タイム40ns
  - 柔軟な電力管理システム
    - プログラム可能な、レギュレートされたコア電源電圧を持つ、完全に統合されたLDO
    - 電源電圧の管理、監視、およびブラウンアウト
  - 統合クロック・システム
    - FLL制御ループによる周波数安定化
    - 低電力、低周波数の内部クロック・ソース(VLO)
    - 低周波数のトリムされた内部基準ソース(REFO)
    - 32kHzの水晶振動子(XT1)
    - 最高25MHzの高周波数水晶振動子(XT1)
  - ハードウェア・マルチプライヤで32ビットの演算をサポート
  - 3チャンネルのDMA
  - 最大12の5V許容デジタル・プッシュ/プルI/Oと、最大20mAの駆動強度<sup>(1)</sup>
  - 16ビット・タイマTD0は3つのキャプチャ/コンペア・レジスタを搭載し、高分解能モードをサポート
  - 16ビット・タイマTD1は3つのキャプチャ/コンペア・レジスタを搭載し、高分解能モードをサポート
  - 16ビット・タイマTA0は3つのキャプチャ/コンペア・レジスタを搭載
  - ユニバーサル・シリアル通信インターフェイス(USCI) <sup>(1)</sup>
    - USCI\_A0でサポートされる機能
      - 自動ボーレート検出機能付きの拡張UART
      - IrDAエンコーダおよびデコーダ
      - 同期SPI
    - USCI\_B0でサポートされる機能
      - I<sup>2</sup>C
      - 同期SPI
  - 10ビット、200kspsのアナログ/デジタル・コンバータ(ADC)
    - 内部基準
    - サンプル・アンド・ホールド
    - 自動スキャン機能
    - 最大8つの外部チャンネルと2つの内部チャンネル、温度センサを含む<sup>(1)</sup>
  - 最大16チャンネルのオンチップ・コンパレータ、超低消費電力モード搭載<sup>(1)</sup>
  - シリアル・オンボード・プログラミング、外部からのプログラミング電圧は不要
  - [デバイスの比較](#) に、供給中の製品ファミリを掲載
  - 40ピンQFN (RSB)、38ピンTSSOP (DA)、40ピンのダイ・サイズBGA (YFF)パッケージで供給
- (1) 40ピンのQFNパッケージ・オプションでは、すべての機能を使用できます。他のパッケージで利用できる機能については、[信号概要](#)を参照してください。

### 1.2 アプリケーション

- アナログおよびデジタル・センサ・システム
- LEDライティング
- デジタル電源
- モータ制御
- リモート・コントロール
- サーモスタット



### 1.3 概要

TI MSPファミリの超低消費電力マイクロコントローラは複数のデバイスで構成され、それぞれが各種のアプリケーションを対象とする異なるペリフェラルを搭載しています。このアーキテクチャは5つの低消費電力モードを持ち、携帯用測定器用途でバッテリー駆動時間を延長するよう最適化されています。このデバイスには、強力な16ビットRISC CPU、16ビット・レジスタ、およびコンスタント・ジェネレータが搭載されており、コード効率が最大限に向上します。デジタル制御発振器(DCO)により、デバイスは低消費電力モードからアクティブ・モードへ5 $\mu$ s未満でウェークアップできます。

MSP430F51x2マイクロコントローラには、2つの16ビット高分解能タイマ、2つのUSCI (USCI\_A0およびUSCI\_B0)、32ビットのハードウェア乗算器、高性能の10ビットADC、オンチップ・コンパレータ、3チャンネルのDMA、5V許容のI/O、最大29本のI/Oピンが搭載されています。

MSP430F51x1マイクロコントローラには、2つの16ビット高分解能タイマ、2つのUSCI (USCI\_A0およびUSCI\_B0)、32ビットのハードウェア乗算器、オンチップ・コンパレータ、3チャンネルのDMA、5V許容のI/O、最大29本のI/Oピンが搭載されています。

これらのデバイスの代表的なアプリケーションとして、アナログおよびデジタル・センサ・システム、LEDライティング、デジタル電源、モータ制御、リモート・コントロール、サーモスタット、デジタル・タイマ、ハンドヘルド・メータが挙げられます。

モジュールの完全な説明については、『MSP430FR5xxおよびMSP430FR6xxファミリ ユーザー・ガイド』を参照してください。

#### 製品情報<sup>(1)</sup>

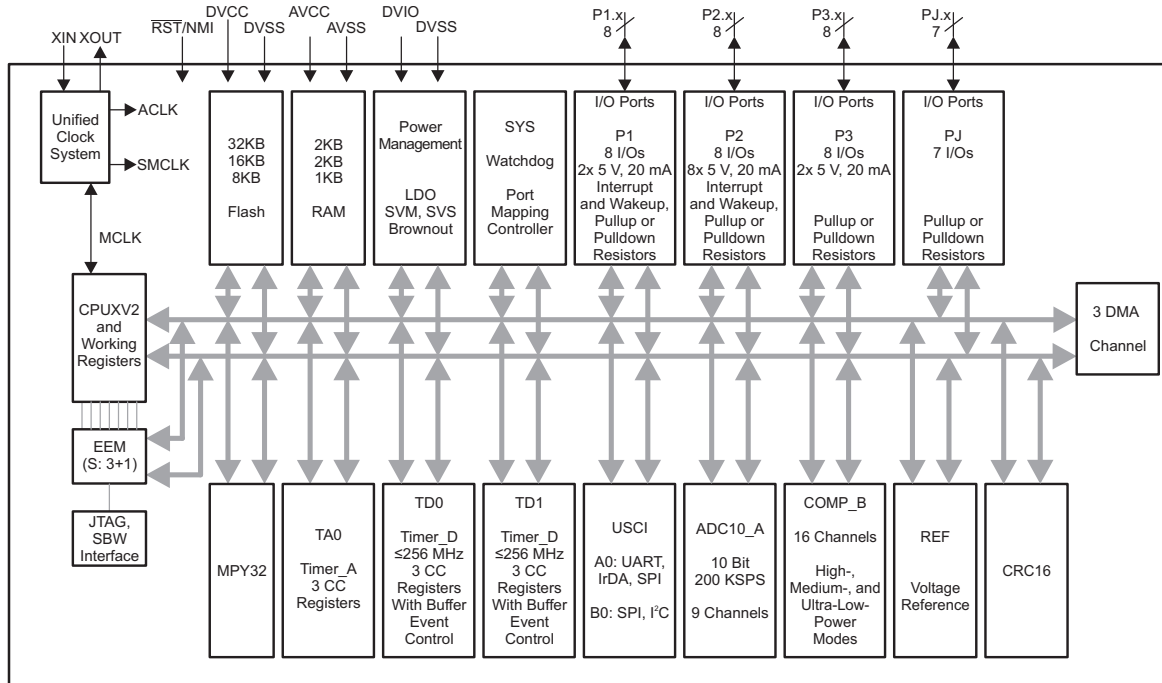
| 型番              | パッケージ      | 本体サイズ <sup>(2)</sup> |
|-----------------|------------|----------------------|
| MSP430F5172IYFF | DSBGA (40) | 8参照                  |
| MSP430F5172IRSB | WQFN (40)  | 5mm×5mm              |
| MSP430F5172IDA  | TSSOP (38) | 12.5mm×6.2mm         |

(1) 最新の製品、パッケージ、および注文情報については、8の「付録:パッケージ・オプション」、または [www.ti.com](http://www.ti.com) のTI Webサイトを参照してください。

(2) ここに記載されているサイズは概略です。許容公差を含めたパッケージの寸法については、8の「メカニカル・データ」を参照してください。

## 1.4 機能ブロック図

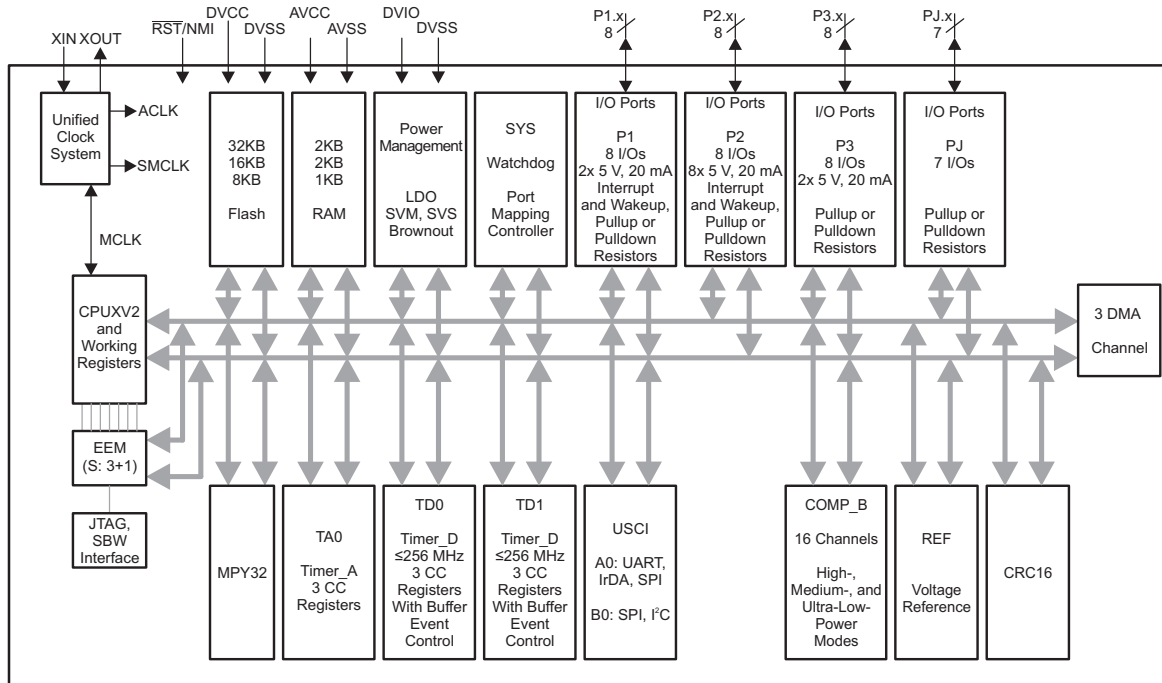
MSP430F51x2デバイスの機能ブロック図を、[図 1-1](#)に示します。



Copyright © 2017, Texas Instruments Incorporated

**図 1-1. MSP430F51x2の機能ブロック図**

MSP430F51x1デバイスの機能ブロック図を、[図 1-2](#)に示します。



Copyright © 2017, Texas Instruments Incorporated

**図 1-2. MSP430F51x1の機能ブロック図**

## Table of Contents

|          |                                                                                                                          |           |          |                                                                                |           |
|----------|--------------------------------------------------------------------------------------------------------------------------|-----------|----------|--------------------------------------------------------------------------------|-----------|
| <b>1</b> | <b>デバイスの概要</b>                                                                                                           | <b>1</b>  | 5.26     | PMM, Brownout Reset (BOR)                                                      | 31        |
| 1.1      | 特長                                                                                                                       | 1         | 5.27     | PMM, Core Voltage                                                              | 31        |
| 1.2      | アプリケーション                                                                                                                 | 1         | 5.28     | PMM, SVS High Side                                                             | 32        |
| 1.3      | 概要                                                                                                                       | 2         | 5.29     | PMM, SVM High Side                                                             | 33        |
| 1.4      | 機能ブロック図                                                                                                                  | 3         | 5.30     | PMM, SVS Low Side                                                              | 33        |
| <b>2</b> | <b>改訂履歴</b>                                                                                                              | <b>5</b>  | 5.31     | PMM, SVM Low Side                                                              | 33        |
| <b>3</b> | <b>Device Comparison</b>                                                                                                 | <b>6</b>  | 5.32     | Wake-up Times From Low-Power Modes                                             | 34        |
| 3.1      | Related Products                                                                                                         | 7         | 5.33     | Timer_A                                                                        | 34        |
| <b>4</b> | <b>Terminal Configuration and Functions</b>                                                                              | <b>8</b>  | 5.34     | USCI (UART Mode)                                                               | 34        |
| 4.1      | Pin Diagrams                                                                                                             | 8         | 5.35     | USCI (SPI Master Mode)                                                         | 35        |
| 4.2      | Signal Descriptions                                                                                                      | 11        | 5.36     | USCI (SPI Slave Mode)                                                          | 37        |
| <b>5</b> | <b>Specifications</b>                                                                                                    | <b>14</b> | 5.37     | USCI (I <sup>2</sup> C Mode)                                                   | 39        |
| 5.1      | Absolute Maximum Ratings                                                                                                 | 14        | 5.38     | 10-Bit ADC, Power Supply and Input Range Conditions (MSP430F51x2 Devices Only) | 40        |
| 5.2      | ESD Ratings                                                                                                              | 14        | 5.39     | 10-Bit ADC, Timing Parameters (MSP430F51x2 Devices Only)                       | 40        |
| 5.3      | Recommended Operating Conditions                                                                                         | 14        | 5.40     | 10-Bit ADC, Linearity Parameters (MSP430F51x2 Devices Only)                    | 41        |
| 5.4      | Active Mode Supply Current Into V <sub>CC</sub> Excluding External Current                                               | 16        | 5.41     | REF, External Reference (MSP430F51x2 Devices Only)                             | 41        |
| 5.5      | Low-Power Mode Supply Currents (Into V <sub>CC</sub> ) Excluding External Current                                        | 16        | 5.42     | REF, Built-In Reference (MSP430F51x2 Devices Only)                             | 42        |
| 5.6      | Thermal Resistance Characteristics                                                                                       | 17        | 5.43     | Comparator_B                                                                   | 43        |
| 5.7      | Schmitt-Trigger Inputs – General-Purpose I/O (P1.0 to P1.5, P3.2 to P3.7, and PJ.0 to PJ.6)                              | 17        | 5.44     | Timer_D, Power Supply and Reference Clock                                      | 44        |
| 5.8      | Schmitt-Trigger Inputs – General-Purpose I/O (P1.6 and P1.7, P2.0 to P2.7, and P3.0 and P3.1)                            | 17        | 5.45     | Timer_D, Local Clock Generator Frequency                                       | 45        |
| 5.9      | Inputs – Ports P1 and P2                                                                                                 | 17        | 5.46     | Timer_D, Trimmed Clock Frequencies                                             | 47        |
| 5.10     | Leakage Current – General-Purpose I/O                                                                                    | 18        | 5.47     | Timer_D, Frequency Multiplication Mode                                         | 47        |
| 5.11     | Outputs – Ports P1, P3, PJ (Full Drive Strength, P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6)                               | 18        | 5.48     | Timer_D, Input Capture and Output Compare Timing                               | 48        |
| 5.12     | Outputs – Ports P1 to P3 (Full Drive Strength, P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1)                               | 18        | 5.49     | Flash Memory                                                                   | 49        |
| 5.13     | Outputs – Ports P1, P3, PJ (Reduced Drive Strength, P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6)                            | 19        | 5.50     | JTAG and Spy-Bi-Wire Interface                                                 | 49        |
| 5.14     | Outputs – Ports P1 to P3 (Reduced Drive Strength, P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1)                            | 19        | <b>6</b> | <b>Detailed Description</b>                                                    | <b>50</b> |
| 5.15     | Output Frequency – Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6                                                        | 20        | 6.1      | CPU                                                                            | 50        |
| 5.16     | Output Frequency – Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1                                                      | 20        | 6.2      | Instruction Set                                                                | 51        |
| 5.17     | Typical Characteristics – Outputs, Reduced Drive Strength (PxDS.y = 0), Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6   | 21        | 6.3      | Operating Modes                                                                | 52        |
| 5.18     | Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6      | 22        | 6.4      | Interrupt Vector Addresses                                                     | 53        |
| 5.19     | Typical Characteristics – Outputs, Reduced Drive Strength (PxDS.y = 0), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1 | 23        | 6.5      | Memory Organization                                                            | 54        |
| 5.20     | Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1    | 25        | 6.6      | Bootloader (BSL)                                                               | 54        |
| 5.21     | Crystal Oscillator, XT1, Low-Frequency Mode                                                                              | 27        | 6.7      | Flash Memory                                                                   | 55        |
| 5.22     | Crystal Oscillator, XT1, High-Frequency Mode                                                                             | 28        | 6.8      | RAM                                                                            | 55        |
| 5.23     | Internal Very-Low-Power Low-Frequency Oscillator (VLO)                                                                   | 29        | 6.9      | Peripherals                                                                    | 55        |
| 5.24     | Internal Reference, Low-Frequency Oscillator (REFO)                                                                      | 29        | 6.10     | Input/Output Diagrams                                                          | 74        |
| 5.25     | DCO Frequency                                                                                                            | 30        | 6.11     | Device Descriptors                                                             | 91        |
|          |                                                                                                                          |           | <b>7</b> | <b>デバイスおよびドキュメントのサポート</b>                                                      | <b>97</b> |
|          |                                                                                                                          |           | 7.1      | 使い始めと次の手順                                                                      | 97        |
|          |                                                                                                                          |           | 7.2      | Device Nomenclature                                                            | 97        |
|          |                                                                                                                          |           | 7.3      | ツールとソフトウェア                                                                     | 99        |
|          |                                                                                                                          |           | 7.4      | ドキュメントのサポート                                                                    | 101       |
|          |                                                                                                                          |           | 7.5      | 関連リンク                                                                          | 102       |
|          |                                                                                                                          |           | 7.6      | Community Resources                                                            | 102       |
|          |                                                                                                                          |           | 7.7      | 商標                                                                             | 102       |
|          |                                                                                                                          |           | 7.8      | 静電気放電に関する注意事項                                                                  | 103       |
|          |                                                                                                                          |           | 7.9      | Export Control Notice                                                          | 103       |

|                    |                     |   |                           |                     |
|--------------------|---------------------|---|---------------------------|---------------------|
| 7.10 Glossary..... | <a href="#">103</a> | 8 | メカニカル、パッケージ、および注文情報 ..... | <a href="#">104</a> |
|--------------------|---------------------|---|---------------------------|---------------------|

## 2 改訂履歴

| 2018年7月20日発行分から2018年09月20日発行分への変更                                                                                                                                                                             | Page                                      |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------|
| <ul style="list-style-type: none"> <li>Added typical conditions statements at the beginning of <a href="#">Section 5, Specifications</a> .....</li> <li><a href="#">7.4</a>、「ドキュメントのサポート」を更新 .....</li> </ul> | <a href="#">14</a><br><a href="#">101</a> |

### 3 Device Comparison

Table 3-1 summarizes the available family members.

**Table 3-1. Device Comparison<sup>(1)(2)</sup>**

| DEVICE      | FLASH<br>(KB) | SRAM<br>(KB) | Timer_A <sup>(3)</sup> | Timer_D <sup>(4)</sup> | USCI                             |                                     | ADC10_A<br>(Ch) | Comp_B<br>(Ch) | I/Os | PACKAGE  |
|-------------|---------------|--------------|------------------------|------------------------|----------------------------------|-------------------------------------|-----------------|----------------|------|----------|
|             |               |              |                        |                        | CHANNEL A:<br>UART, IrDA,<br>SPI | CHANNEL B:<br>SPI, I <sup>2</sup> C |                 |                |      |          |
| MSP430F5172 | 32            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | 9 ext, 2 int    | 16             | 31   | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29   | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29   | 38 TSSOP |
| MSP430F5152 | 16            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | 9 ext, 2 int    | 16             | 31   | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29   | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29   | 38 TSSOP |
| MSP430F5132 | 8             | 1            | 3                      | 3, 3                   | 1                                | 1                                   | 9 ext, 2 int    | 16             | 31   | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29   | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29   | 38 TSSOP |
| MSP430F5171 | 32            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | –               | 16             | 31   | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29   | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29   | 38 TSSOP |
| MSP430F5151 | 16            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | –               | 16             | 31   | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29   | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29   | 38 TSSOP |
| MSP430F5131 | 8             | 1            | 3                      | 3, 3                   | 1                                | 1                                   | –               | 16             | 31   | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29   | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29   | 38 TSSOP |

- (1) For the most current package and ordering information, see the *Package Option Addendum* in 8, or see the TI website at [www.ti.com](http://www.ti.com).  
(2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).  
(3) Each number in the sequence represents an instantiation of Timer\_A with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_A, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.  
(4) Each number in the sequence represents an instantiation of Timer\_D with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_D, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.

### 3.1 Related Products

For information about other devices in this family of products or related products, see the following links.

**TI 16-bit and 32-bit microcontrollers** High-performance, low-power solutions to enable the autonomous future

**Products for MSP430 ultra-low-power sensing and measurement microcontrollers** One platform. One ecosystem. Endless possibilities.

**Products for MSP430 ultra-low-power microcontrollers** MCUs for metrology, monitoring, system control, and communications

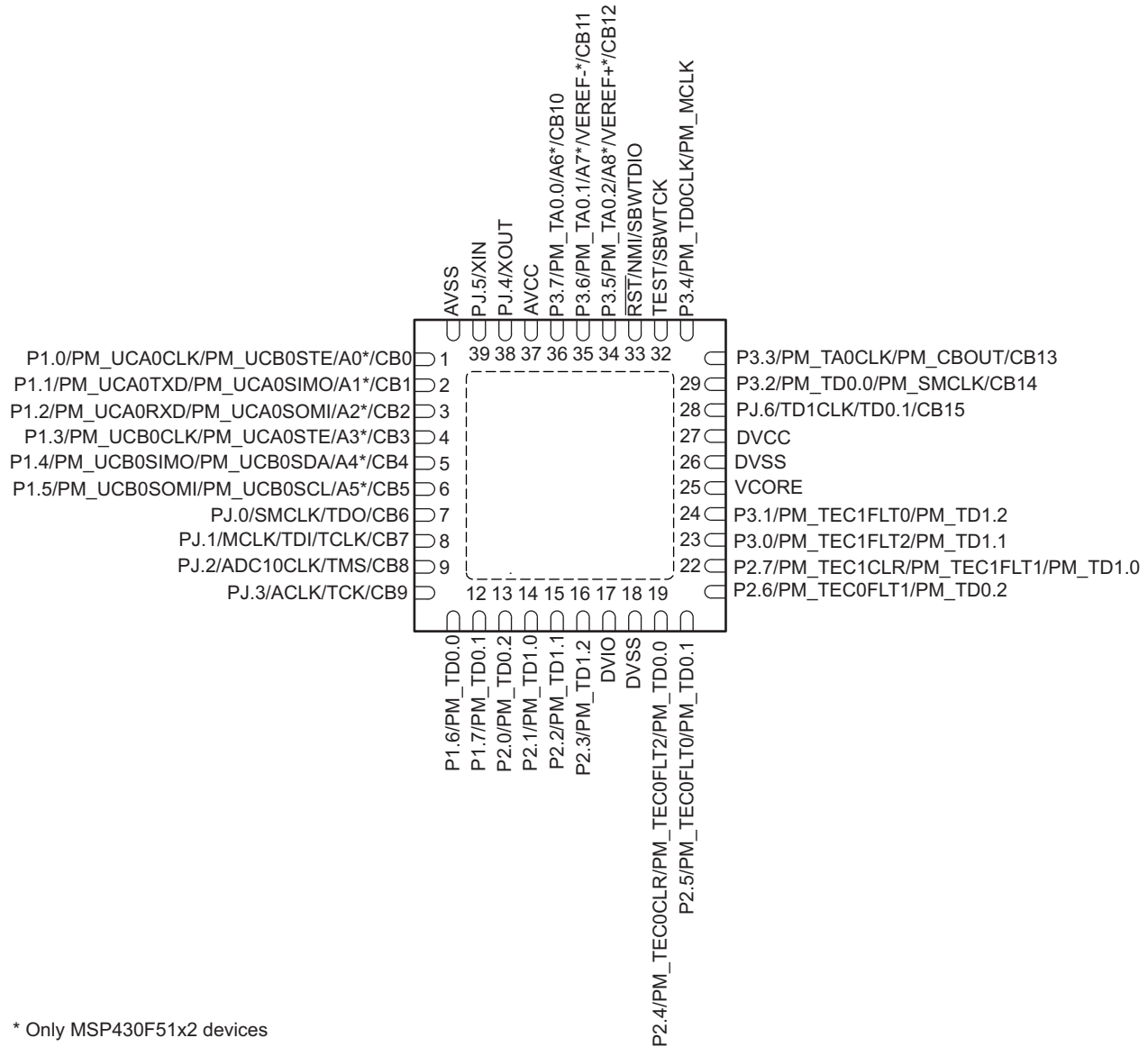
**Companion Products for MSP430F5172** Review products that are frequently purchased or used in conjunction with this product.

**Reference Designs for MSP430F5172** TI Designs Reference Design Library is a robust reference design library that spans analog, embedded processor, and connectivity. Created by TI experts to help you jump start your system design, all TI Designs include schematic or block diagrams, BOMs, and design files to speed your time to market. Search and download designs at [ti.com/tidesigns](http://ti.com/tidesigns).

## 4 Terminal Configuration and Functions

### 4.1 Pin Diagrams

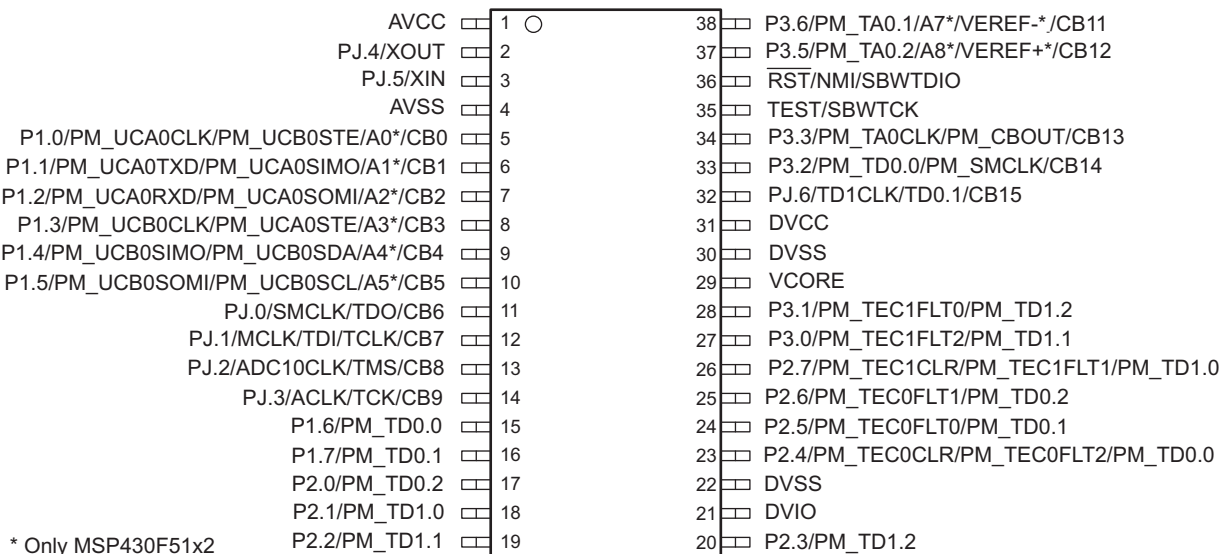
Figure 4-1 shows the pinout for the 40-pin RSB package.



\* Only MSP430F51x2 devices

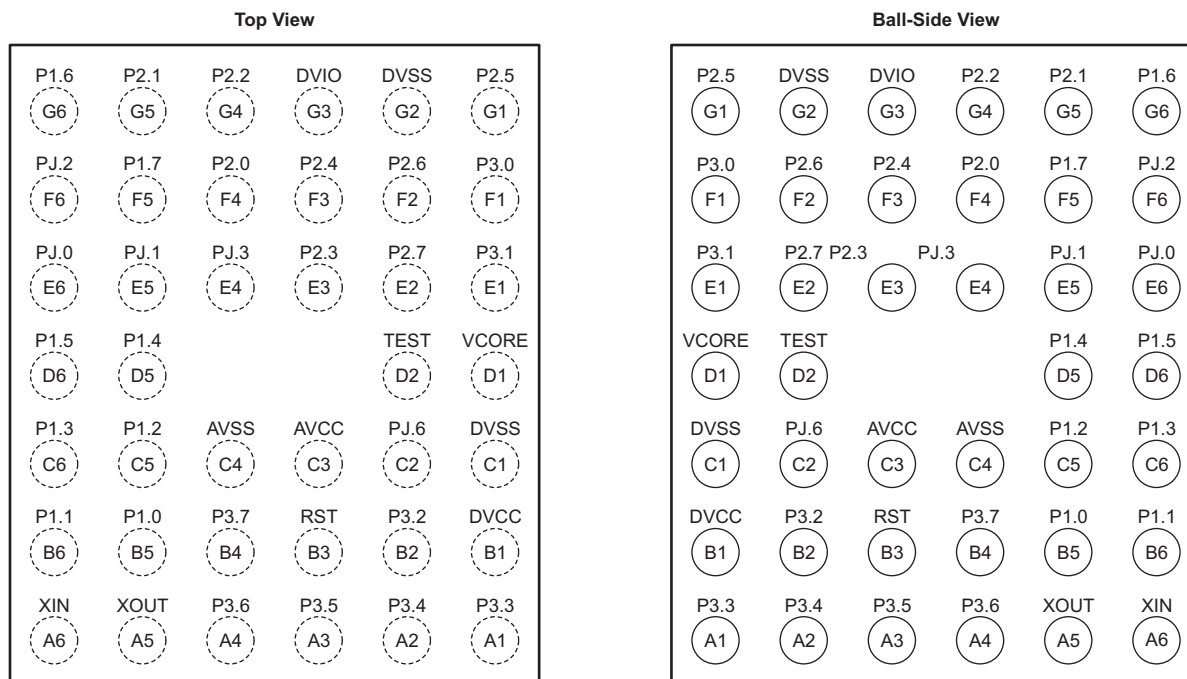
Figure 4-1. 40-Pin RSB Package (Top View)

Figure 4-2 shows the pinout for the 38-pin DA package.



**Figure 4-2. 38-Pin DA Package (Top View)**

Figure 4-3 shows the pinout for the 40-pin YFF package. For the package dimensions, see the *Mechanical Data* in 8.



### Figure 4-3. 40-Pin YFF Package (Top View and Bottom View)

## 4.2 Signal Descriptions

Table 4-1 describes the signals for all device and package variants.

**Table 4-1. Signal Descriptions**

| TERMINAL                                                              |                    |    |     | I/O <sup>(1)</sup>       | DESCRIPTION                                                                                                                                                                                                                                                                                                                                       |
|-----------------------------------------------------------------------|--------------------|----|-----|--------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                                                  | NO. <sup>(2)</sup> |    |     |                          |                                                                                                                                                                                                                                                                                                                                                   |
|                                                                       | RSB                | DA | YFF |                          |                                                                                                                                                                                                                                                                                                                                                   |
| P1.0/<br>PM_UCA0CLK/<br><br>PM_UCB0STE/<br>A0 <sup>(3)</sup> /<br>CB0 | 1                  | 5  | B5  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function <sup>(4)</sup><br>Default mapping: Clock signal input – USCI_A0 SPI slave mode; Clock signal output – USCI_A0 SPI master mode<br>Default mapping: Slave transmit enable – USCI_B0 SPI mode<br>Analog input A0 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 0 |
| P1.1/<br>PM_UCA0TXD/<br>PM_UCA0SIMO/<br>A1 <sup>(3)</sup> /<br>CB1    | 2                  | 6  | B6  | I/O                      | General-purpose digital I/O<br>Default mapping: Transmit data – USCI_A0 UART mode<br>Default mapping: Slave in, master out – USCI_A0 SPI mode<br>Analog input A1 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 1                                                                                                                              |
| P1.2/<br>PM_UCA0RXD/<br>PM_UCA0SOMI/<br>A2 <sup>(3)</sup> /<br>CB2    | 3                  | 7  | C5  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Receive data – USCI_A0 UART mode<br>Default mapping: Slave out, master in – USCI_A0 SPI mode<br>Analog input A2 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 2                                                                           |
| P1.3/<br>PM_UCB0CLK/<br><br>PM_UCA0STE/<br>A3 <sup>(3)</sup> /<br>CB3 | 4                  | 8  | C6  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Clock signal input – USCI_B0 SPI slave mode; Clock signal output – USCI_B0 SPI master mode<br>Default mapping: Slave transmit enable – USCI_A0 SPI mode<br>Analog input A3 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 3                |
| P1.4/<br>PM_UCB0SIMO/<br>PM_UCB0SDA/<br>A4 <sup>(3)</sup> /<br>CB4    | 5                  | 9  | D5  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Slave in, master out – USCI_B0 SPI mode<br>Default mapping: I <sup>2</sup> C data – USCI_B0 I <sup>2</sup> C mode<br>Analog input A4 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 4                                                      |
| P1.5/<br>PM_UCB0SOMI/<br>PM_UCB0SCL/<br>A5 <sup>(3)</sup> /<br>CB5    | 6                  | 10 | D6  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Slave out, master in – USCI_B0 SPI mode<br>Default mapping: I <sup>2</sup> C clock – USCI_B0 I <sup>2</sup> C mode<br>Analog input A5 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 5                                                     |
| PJ.0/<br>SMCLK/<br>TDO/<br>CB6                                        | 7                  | 11 | E6  | I/O                      | General-purpose digital I/O<br>SMCLK clock output<br>Test data output port<br>Comparator_B Input 6                                                                                                                                                                                                                                                |
| PJ.1/<br>MCLK/<br>TDI/TCLK/<br>CB7                                    | 8                  | 12 | E5  | I/O                      | General-purpose digital I/O<br>MCLK clock output<br>Test data input or test clock input<br>Comparator_B Input 7                                                                                                                                                                                                                                   |
| PJ.2/<br>ADC10CLK/<br>TMS/<br>CB8                                     | 9                  | 13 | F6  | I/O                      | General-purpose digital I/O<br>ADC10_A clock output<br>Test mode select<br>Comparator_B Input 8                                                                                                                                                                                                                                                   |
| PJ.3/<br>ACLK/<br>TCK/<br>CB9                                         | 10                 | 14 | E4  | I/O                      | General-purpose digital I/O<br>ACLK output port<br>Test clock<br>Comparator_B Input 9                                                                                                                                                                                                                                                             |
| P1.6/<br>PM_TD0.0                                                     | 11                 | 15 | G6  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR0 compare output/capture input                                                                                                                                                                                                         |

(1) I = input, O = output

(2) N/A = not available on this package offering

(3) The ADC10\_A module is available on MSP430F51x2 devices. The secondary pin functions Ax (ADC10\_A channel x) available only in MSP430F51x2 devices.

(4) For details on the Port Mapping Controller, see [Section 6.9.2](#).

**Table 4-1. Signal Descriptions (continued)**

| TERMINAL                                         |                    |    |     | I/O <sup>(1)</sup>       | DESCRIPTION                                                                                                                                                                                                                                                |
|--------------------------------------------------|--------------------|----|-----|--------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                             | NO. <sup>(2)</sup> |    |     |                          |                                                                                                                                                                                                                                                            |
|                                                  | RSB                | DA | YFF |                          |                                                                                                                                                                                                                                                            |
| P1.7/<br>PM_TD0.1                                | 12                 | 16 | F5  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR1 compare output/capture input                                                                                                                  |
| P2.0/<br>PM_TD0.2                                | 13                 | 17 | F4  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR2 compare output/capture input                                                                                                                  |
| P2.1/<br>PM_TD1.0                                | 14                 | 18 | G5  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 CCR0 compare output/capture input                                                                                                                  |
| P2.2/<br>PM_TD1.1                                | 15                 | 19 | G4  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 CCR1 compare output/capture input                                                                                                                  |
| P2.3/<br>PM_TD1.2                                | 16                 | 20 | E3  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 CCR2 compare output/capture input                                                                                                                  |
| DVIO                                             | 17                 | 21 | G3  |                          | 5-V tolerant digital I/O power supply                                                                                                                                                                                                                      |
| DVSS                                             | 18                 | 22 | G2  |                          | Digital ground supply                                                                                                                                                                                                                                      |
| P2.4/<br>PM_TEC0CLR/<br>PM_TEC0FLT2/<br>PM_TD0.0 | 19                 | 23 | F3  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 external clear input<br>Default mapping: TD0 fault input channel 2 (controlled by module input enable)<br>Default mapping: TD0 CCR0 compare output |
| P2.5/<br>PM_TEC0FLT0/<br>PM_TD0.1                | 20                 | 24 | G1  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 fault input channel 0<br>Default mapping: TD0 CCR1 compare output                                                                                  |
| P2.6/<br>PM_TEC0FLT1/<br>PM_TD0.2                | 21                 | 25 | F2  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 fault input channel 1<br>Default mapping: TD0 CCR2 compare output                                                                                  |
| P2.7/<br>PM_TEC1CLR/<br>PM_TEC1FLT1/<br>PM_TD1.0 | 22                 | 26 | E2  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 external clear<br>Default mapping: TD1 fault input channel 1 (controlled by module input enable)<br>Default mapping: TD1 CCR0 compare output       |
| P3.0/<br>PM_TEC1FLT2/<br>PM_TD1.1                | 23                 | 27 | F1  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 fault input channel 2<br>Default mapping: TD1 CCR1 compare output                                                                                  |
| P3.1/<br>PM_TEC1FLT0/<br>PM_TD1.2                | 24                 | 28 | E1  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 fault input channel 0<br>Default mapping: TD1 CCR2 compare output                                                                                  |
| VCORE                                            | 25                 | 29 | D1  |                          | Regulated core power supply                                                                                                                                                                                                                                |
| DVSS                                             | 26                 | 30 | C1  |                          | Digital ground supply                                                                                                                                                                                                                                      |
| DVCC                                             | 27                 | 31 | B1  |                          | Digital power supply                                                                                                                                                                                                                                       |
| PJ.6/<br>TD1CLK/<br>TD0.1/<br>CB15               | 28                 | 32 | C2  | I/O                      | General-purpose digital I/O<br>TD1 clock input<br>TD0 CCR1 compare output<br>Comparator_B Input 15                                                                                                                                                         |
| P3.2/<br>PM_TD0.0/<br>PM_SMCLK/<br>CB14          | 29                 | 33 | B2  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR0 capture input<br>Default mapping: SMCLK output<br>Comparator_B Input 14                                                                       |
| P3.3/<br>PM_TA0CLK/<br>PM_CBOUT/<br>CB13         | 30                 | 34 | A1  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 clock input<br>Default mapping: Comparator_B output<br>Comparator_B Input 13                                                                       |
| P3.4/<br>PM_TD0CLK/<br>PM_MCLK                   | 31                 | –  | A2  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 clock input<br>Default mapping: MCLK output                                                                                                        |
| TEST/<br>SBWTCK                                  | 32                 | 35 | D2  |                          | Test mode pin – select digital I/O on JTAG pins<br>Spy-Bi-Wire input clock                                                                                                                                                                                 |
| RST/<br>NMI/<br>SBWTDIO                          | 33                 | 36 | B3  |                          | Reset input active low <sup>(5)</sup><br>Nonmaskable interrupt input<br>Spy-Bi-Wire data input/output                                                                                                                                                      |

(5) When this pin is configured as reset, the internal pullup resistor is enabled by default.

**Table 4-1. Signal Descriptions (continued)**

| TERMINAL                                                     |                    |    |     | I/O <sup>(1)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                    |
|--------------------------------------------------------------|--------------------|----|-----|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                                         | NO. <sup>(2)</sup> |    |     |                    |                                                                                                                                                                                                                                                                                                                |
|                                                              | RSB                | DA | YFF |                    |                                                                                                                                                                                                                                                                                                                |
| P3.5/<br>PM TA0.2/<br>A8 <sup>(3)</sup> /<br>VEREF+/<br>CB12 | 34                 | 37 | A3  | I/O                | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 CCR2 compare output/capture input<br>Analog input A8 – 10-bit ADC <sup>(3)</sup><br>Positive terminal for the ADC reference voltage for an external applied reference voltage<br>Comparator_B Input 12 |
| P3.6/<br>PM TA0.1/<br>A7 <sup>(3)</sup> /<br>VEREF-/<br>CB11 | 35                 | 38 | A4  | I/O                | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 CCR1 compare output/capture input<br>Analog input A7 – 10-bit ADC <sup>(3)</sup><br>Negative terminal for the ADC reference voltage for an external applied reference voltage<br>Comparator_B Input 11 |
| P3.7/<br>PM TA0.0/<br>A6 <sup>(3)</sup> /<br>CB10            | 36                 | –  | B4  | I/O                | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 CCR0 compare output/capture input<br>Analog input A6 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 10                                                                                              |
| AVCC                                                         | 37                 | 1  | C3  |                    | Analog power supply                                                                                                                                                                                                                                                                                            |
| PJ.4/<br>XOUT                                                | 38                 | 2  | A5  | I/O                | General-purpose digital I/O<br>Output terminal of crystal oscillator                                                                                                                                                                                                                                           |
| PJ.5/<br>XIN                                                 | 39                 | 3  | A6  | I/O                | General-purpose digital I/O<br>Input terminal for crystal oscillator                                                                                                                                                                                                                                           |
| AVSS                                                         | 40                 | 4  | C4  |                    | Analog ground supply                                                                                                                                                                                                                                                                                           |
| QFN pad                                                      | –                  | NA | NA  |                    | Recommended to connect to DVSS externally                                                                                                                                                                                                                                                                      |

## 5 Specifications

All graphs in this section are for typical conditions, unless otherwise noted.

Typical (TYP) values are specified at  $V_{CC} = 3.3\text{ V}$  and  $T_A = 25^\circ\text{C}$ , unless otherwise noted.

### 5.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                                                                          | MIN  | MAX            | UNIT |
|--------------------------------------------------------------------------|------|----------------|------|
| Voltage $V_{CC}$ applied at DVCC to DVSS                                 | −0.3 | 4.1 V          | V    |
| Voltage $V_{IO}$ applied at VIO to DVSS                                  | −0.3 | 6.1 V          | V    |
| Voltage applied to any pin (excluding V <sub>CORE</sub> ) <sup>(2)</sup> | −0.3 | $V_{CC} + 0.3$ | V    |
| Diode current at any device pin                                          |      | ±2             | mA   |
| Maximum operating junction temperature, $T_J$                            |      | 95             | °C   |
| Storage temperature, $T_{stg}$                                           | −55  | 150            | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages referenced to  $V_{SS}$ .  $V_{CORE}$  is for internal device usage only. No external DC loading or voltage should be applied.

### 5.2 ESD Ratings

|                                     |                                                                                | VALUE | UNIT |
|-------------------------------------|--------------------------------------------------------------------------------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Pins listed as ±1000 V may actually have higher performance.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Pins listed as ±250 V may actually have higher performance.

### 5.3 Recommended Operating Conditions

|                          |                                                                                                                       | MIN                    | NOM | MAX | UNIT |
|--------------------------|-----------------------------------------------------------------------------------------------------------------------|------------------------|-----|-----|------|
| $V_{CC}$                 | Supply voltage during program execution and flash programming<br>$V_{(AVCC)} = V_{(DVCC)} = V_{CC}$ <sup>(1)(2)</sup> | PMMCOREVx = 0          | 1.8 | 3.6 | V    |
|                          |                                                                                                                       | PMMCOREVx = 0, 1       | 2.0 | 3.6 |      |
|                          |                                                                                                                       | PMMCOREVx = 0, 1, 2    | 2.2 | 3.6 |      |
|                          |                                                                                                                       | PMMCOREVx = 0, 1, 2, 3 | 2.4 | 3.6 |      |
| $V_{IO}$                 | Supply voltage of pins P1.6, P1.7, P2.0 to P2.7, P3.0, and P3.1 supplied by VIO <sup>(3)(4)</sup>                     | 1.8                    |     | 5.5 | V    |
| $V_{SS}$                 | Supply voltage $V_{(AVSS)} = V_{(DVSS)} = V_{SS}$                                                                     |                        | 0   |     | V    |
| $T_A$                    | Operating free-air temperature                                                                                        | −40                    |     | 85  | °C   |
| $T_J$                    | Operating junction temperature                                                                                        | −40                    |     | 85  | °C   |
| $C_{(VCORE)}$            | Recommended capacitor at V <sub>CORE</sub> <sup>(5)</sup>                                                             |                        | 470 |     | nF   |
| $C_{(DVCC)}/C_{(VCORE)}$ | Capacitor ratio of DVCC to V <sub>CORE</sub>                                                                          | 10                     |     |     |      |

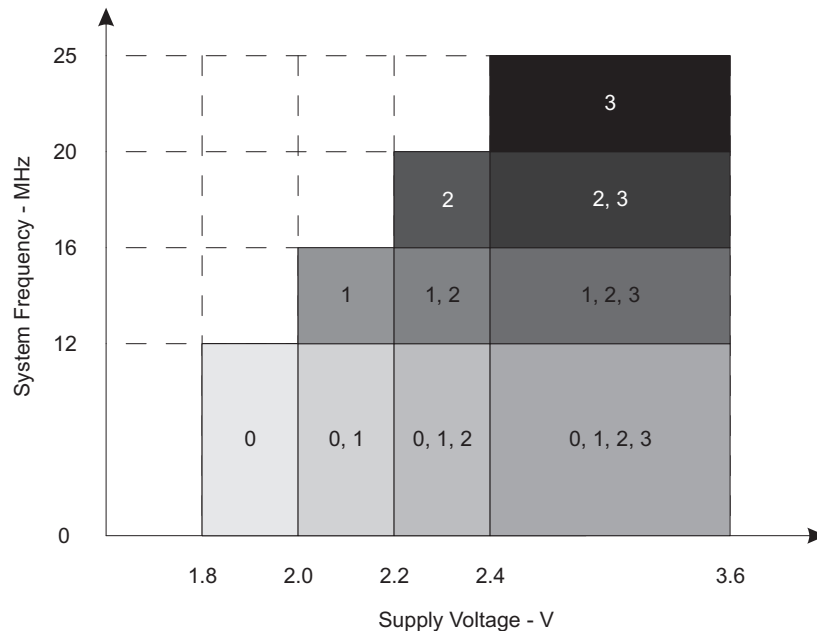
- (1) TI recommends powering AVCC and DVCC from the same source. A maximum difference of 0.3 V between  $V_{(AVCC)}$  and  $V_{(DVCC)}$  can be tolerated during power up and operation.
- (2) The minimum supply voltage is defined by the supervisor SVS levels when it is enabled. See the [Section 5.28](#) threshold parameters for the exact values and further details.
- (3) If DVIO is not supplied by the same source as DVCC, TI recommends powering AVCC and DVCC before powering DVIO. At DVCC and AVCC voltages higher than 1.8 V, the maximum difference of 0.3 V between DVIO and (DVCC and AVCC) can be exceeded. DVIO must be higher than or equal to DVCC.  
Increased cross current can flow into DVCC if DVIO is less than  $(DVCC - 0.3\text{ V})$ , with a maximum current flowing when DVIO is equal to  $DVCC/2$ . To avoid high currents into DVCC, DVIO must be higher than or equal to DVCC, DVIO must not float, and DVIO must be turned off quickly. TI recommends pulling the DVIO pins to low before disabling DVIO.
- (4) For best cross-current prevention, voltage applied to DVIO should not be lower than DVCC. However, if DVIO is switched off during operation, due to application requirements, DVIO should be pulled to ground to prevent a floating voltage.
- (5) A capacitor tolerance of ±20% or better is required.

## Recommended Operating Conditions (continued)

|                     |                                                                                                                 | MIN                                                                                                   | NOM | MAX | UNIT |     |
|---------------------|-----------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|-----|-----|------|-----|
| f <sub>SYSTEM</sub> | Processor frequency (maximum MCLK frequency) <sup>(6)</sup> <sup>(7)</sup><br>(see <a href="#">Figure 5-1</a> ) | PMMCOREVx = 0,<br>1.8 V ≤ V <sub>CC</sub> ≤ 3.6 V<br>(default condition)                              |     | 0   | 12   | MHz |
|                     |                                                                                                                 | PMMCOREVx = 1,<br>2.0 V ≤ V <sub>CC</sub> ≤ 3.6 V                                                     |     | 0   | 16   |     |
|                     |                                                                                                                 | PMMCOREVx = 2,<br>2.2 V ≤ V <sub>CC</sub> ≤ 3.6 V                                                     |     | 0   | 20   |     |
|                     |                                                                                                                 | PMMCOREVx = 3,<br>2.4 V ≤ V <sub>CC</sub> ≤ 3.6 V                                                     |     | 0   | 25   |     |
| P <sub>INT</sub>    | Internal power dissipation                                                                                      | V <sub>CC</sub> × I <sub>(DVCC)</sub>                                                                 |     |     | W    |     |
| P <sub>IO</sub>     | I/O power dissipation of the I/O pins powered by DVCC                                                           | (V <sub>CC</sub> – V <sub>IOH</sub> ) × I <sub>IOH</sub> +<br>V <sub>IOL</sub> × I <sub>IOL</sub>     |     |     | W    |     |
| P <sub>IO5</sub>    | I/O power dissipation of the I/O pins powered by VIO                                                            | (V <sub>IO</sub> – V <sub>IOH5</sub> ) × I <sub>IOH5</sub> +<br>V <sub>IOL5</sub> × I <sub>IOL5</sub> |     |     | W    |     |
| P <sub>MAX</sub>    | Maximum allowed power dissipation, P <sub>MAX</sub> > P <sub>IO</sub> + P <sub>IO5</sub> + P <sub>INT</sub>     | (T <sub>J</sub> – T <sub>A</sub> ) / Rθ <sub>JA</sub>                                                 |     |     | W    |     |

(6) The MSP430™ CPU is clocked directly with MCLK. Both the high and low phase of MCLK must not exceed the pulse duration of the specified maximum frequency.

(7) Modules may have a different maximum input clock specification. See the specification of the respective module in this data sheet.



NOTE: The numbers within the fields denote the supported PMMCOREVx settings.

**Figure 5-1. Frequency vs Supply Voltage**

## 5.4 Active Mode Supply Current Into $V_{CC}$ Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER               | EXECUTION MEMORY | V <sub>CC</sub> | PMMCORE/V <sub>X</sub> | FREQUENCY (f <sub>DCO</sub> = f <sub>MCLK</sub> = f <sub>SMCLK</sub> ) |      |       |      |        |      |        |     |        |      | UNIT |
|-------------------------|------------------|-----------------|------------------------|------------------------------------------------------------------------|------|-------|------|--------|------|--------|-----|--------|------|------|
|                         |                  |                 |                        | 1 MHz                                                                  |      | 8 MHz |      | 12 MHz |      | 20 MHz |     | 25 MHz |      |      |
|                         |                  |                 |                        | TYP                                                                    | MAX  | TYP   | MAX  | TYP    | MAX  | TYP    | MAX | TYP    | MAX  |      |
| I <sub>AM</sub> , Flash | Flash            | 3 V             | 0                      | 0.24                                                                   | 0.27 | 1.48  | 1.60 |        |      |        |     |        |      | mA   |
|                         |                  |                 | 1                      | 0.26                                                                   |      | 1.66  |      | 2.48   | 2.7  |        |     |        |      |      |
|                         |                  |                 | 2                      | 0.28                                                                   |      | 1.83  |      | 2.72   |      | 4.50   | 4.8 |        |      |      |
|                         |                  |                 | 3                      | 0.28                                                                   |      | 1.83  |      | 2.66   |      | 4.40   |     | 5.60   | 6.15 |      |
| I <sub>AM</sub> , RAM   | RAM              | 3 V             | 0                      | 0.17                                                                   | 0.2  | 0.89  | 0.97 |        |      |        |     |        |      | mA   |
|                         |                  |                 | 1                      | 0.18                                                                   |      | 1.00  |      | 1.49   | 1.62 |        |     |        |      |      |
|                         |                  |                 | 2                      | 0.20                                                                   |      | 1.14  |      | 1.68   |      | 2.75   | 3.0 |        |      |      |
|                         |                  |                 | 3                      | 0.20                                                                   |      | 1.20  |      | 1.78   |      | 2.92   |     | 3.64   | 4.0  |      |

## 5.5 Low-Power Mode Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER                                               | $V_{CC}$ | PMMCOREVx | -40°C |      | 25°C |      | 60°C |      | 85°C |     | UNIT          |
|---------------------------------------------------------|----------|-----------|-------|------|------|------|------|------|------|-----|---------------|
|                                                         |          |           | TYP   | MAX  | TYP  | MAX  | TYP  | MAX  | TYP  | MAX |               |
| $I_{LPM0, 1\text{MHz}}$ Low-power mode 0                | 2.2 V    | 0         | 82    | 90   | 85   | 90   | 87   | 95   | 85   | 100 | $\mu\text{A}$ |
|                                                         | 3 V      | 3         | 88    | 100  | 85   | 100  | 90   | 104  | 88   | 104 |               |
| $I_{LPM2}$ Low-power mode 2                             | 2.2 V    | 0         | 10    | 12.5 | 10   | 12   | 10   | 12.5 | 12.5 | 13  | $\mu\text{A}$ |
|                                                         | 3 V      | 3         | 9     | 11.5 | 11   | 13   | 11   | 15   | 12   | 14  |               |
| $I_{LPM3, \text{XT1LF}}$ Low-power mode 3, crystal mode | 2.2 V    | 0         | 1.7   | –    | 1.8  | 2.0  | 2.5  | –    | 3.5  | 6.0 | $\mu\text{A}$ |
|                                                         | 3 V      |           | 2.0   | –    | 2.0  | 2.2  | 3.0  | –    | 3.7  | 6.0 |               |
|                                                         | 2.2 V    | 1         | 1.8   | –    | 1.9  | –    | 2.5  | –    | 4.0  | –   |               |
|                                                         | 3 V      |           | 2.1   | –    | 2.2  | –    | 2.5  | –    | 4.0  | –   |               |
|                                                         | 2.2 V    | 2         | 1.8   | –    | 2.0  | –    | 2.5  | –    | 4.2  | –   |               |
|                                                         | 3 V      |           | 2.0   | –    | 2.2  | –    | 2.8  | –    | 4.2  | –   |               |
|                                                         | 2.2 V    | 3         | 1.9   | –    | 2.0  | 2.5  | 2.9  | –    | 4.8  | 6.5 |               |
|                                                         | 3 V      |           | 2.1   | –    | 2.2  | 2.5  | 3.0  | –    | 5.2  | 7.0 |               |
| $I_{LPM3, \text{VLO}}$ Low-power mode 3, VLO mode       | 2.2 V    | 0         | 1.0   | –    | 1.0  | 1.25 | 1.6  | –    | 3.5  | 4.5 | $\mu\text{A}$ |
|                                                         | 3 V      |           | 1.1   | –    | 1.2  | 1.4  | 1.5  | –    | 3.6  | 5.0 |               |
|                                                         | 2.2 V    | 1         | 1.0   | –    | 1.1  | –    | 1.8  | –    | 3.0  | –   |               |
|                                                         | 3 V      |           | 1.3   | –    | 1.1  | –    | 2.0  | –    | 3.2  | –   |               |
|                                                         | 2.2 V    | 2         | 1.1   | –    | 1.1  | –    | 1.8  | –    | 3.1  | –   |               |
|                                                         | 3 V      |           | 1.1   | –    | 1.2  | –    | 2.0  | –    | 3.2  | –   |               |
|                                                         | 2.2 V    | 3         | 1.1   | –    | 1.1  | 1.4  | 1.9  | –    | 3.5  | 5.0 |               |
|                                                         | 3 V      |           | 1.1   | –    | 1.2  | 1.5  | 2.1  | –    | 4.0  | 5.2 |               |
| $I_{LPM4}$ Low-power mode 4                             | 3 V      | 0         | 0.8   | –    | 0.9  | 1.3  | 1.4  | –    | 3.5  | 4.7 | $\mu\text{A}$ |
|                                                         |          | 1         | 0.8   | –    | 1.0  | –    | 1.4  | –    | 3.5  | –   |               |
|                                                         |          | 2         | 0.8   | –    | 1.0  | –    | 1.5  | –    | 3.6  | –   |               |
|                                                         |          | 3         | 0.9   | –    | 1.0  | 1.3  | 1.6  | –    | 3.6  | 5.0 |               |
| $I_{LPM4.5}$ Low-power mode 4.5                         | 2.2 V    | x         | 0.06  | –    | 0.20 | 0.26 | 0.33 | –    | 0.60 | 0.9 | $\mu\text{A}$ |
|                                                         | 3 V      | x         | 0.07  | –    | 0.25 | 0.29 | 0.37 | –    | 0.77 | 0.9 |               |

(1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current. DVIO = DVCC = AVCC.

(2) The currents are characterized with a Micro Crystal MS1V-T1K SMD crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 9 pF.

## 5.6 Thermal Resistance Characteristics

| THERMAL METRIC                                                  |                         |            | VALUE | UNIT |
|-----------------------------------------------------------------|-------------------------|------------|-------|------|
| $\theta_{JA}$ Junction-to-ambient thermal resistance, still air | Low-K board (JESD51-3)  | QFN (RSB)  | 87    | °C/W |
|                                                                 |                         | TSSOP (DA) | 109   |      |
|                                                                 | High-K board (JESD51-7) | QFN (RSB)  | 35    |      |
|                                                                 |                         | TSSOP (DA) | 69    |      |
| $\theta_{JC}$ Junction-to-case thermal resistance               |                         | QFN (RSB)  | 36    | °C/W |
|                                                                 |                         | TSSOP (DA) | 19    |      |

## 5.7 Schmitt-Trigger Inputs – General-Purpose I/O (P1.0 to P1.5, P3.2 to P3.7, and PJ.0 to PJ.6)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                  | TEST CONDITIONS                                                  | $V_{CC}$ | MIN  | TYP | MAX  | UNIT       |
|------------------------------------------------------------|------------------------------------------------------------------|----------|------|-----|------|------------|
| $V_{IT+}$ Positive-going input threshold voltage           |                                                                  | 1.8 V    | 0.80 |     | 1.40 | V          |
|                                                            |                                                                  | 3 V      | 1.50 |     | 2.10 |            |
| $V_{IT-}$ Negative-going input threshold voltage           |                                                                  | 1.8 V    | 0.45 |     | 1.00 | V          |
|                                                            |                                                                  | 3 V      | 0.75 |     | 1.65 |            |
| $V_{hys}$ Input voltage hysteresis ( $V_{IT+} - V_{IT-}$ ) |                                                                  | 1.8 V    | 0.3  |     | 0.8  | V          |
|                                                            |                                                                  | 3 V      | 0.4  |     | 1.0  |            |
| $R_{Pull}$ Pullup or pulldown resistor <sup>(1)</sup>      | For pullup: $V_{IN} = V_{SS}$<br>For pulldown: $V_{IN} = V_{CC}$ |          | 20   | 35  | 50   | k $\Omega$ |
| $C_I$ Input capacitance                                    | $V_{IN} = V_{SS}$ or $V_{CC}$                                    |          |      | 5   |      | pF         |

(1) Also applies to  $\overline{RST}$  pin when pullup or pulldown resistor is enabled.

## 5.8 Schmitt-Trigger Inputs – General-Purpose I/O (P1.6 and P1.7, P2.0 to P2.7, and P3.0 and P3.1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                  | TEST CONDITIONS                                                  | $V_{IO}$ | MIN  | TYP | MAX  | UNIT       |
|------------------------------------------------------------|------------------------------------------------------------------|----------|------|-----|------|------------|
| $V_{IT+}$ Positive-going input threshold voltage           |                                                                  | 1.8 V    | 0.80 |     | 1.40 | V          |
|                                                            |                                                                  | 3 V      | 1.20 |     | 2.00 |            |
|                                                            |                                                                  | 5 V      | 2.10 |     | 2.50 |            |
| $V_{IT-}$ Negative-going input threshold voltage           |                                                                  | 1.8 V    | 0.45 |     | 0.90 | V          |
|                                                            |                                                                  | 3 V      | 0.75 |     | 1.30 |            |
|                                                            |                                                                  | 5 V      | 1.10 |     | 1.60 |            |
| $V_{hys}$ Input voltage hysteresis ( $V_{IT+} - V_{IT-}$ ) |                                                                  | 1.8 V    | 0.27 |     | 0.45 | V          |
|                                                            |                                                                  | 3 V      | 0.45 |     | 0.65 |            |
|                                                            |                                                                  | 5 V      | 0.9  |     | 1.2  |            |
| $R_{Pull}$ Pullup or pulldown resistor                     | For pullup: $V_{IN} = V_{SS}$<br>For pulldown: $V_{IN} = V_{CC}$ |          | 20   | 35  | 50   | k $\Omega$ |
| $C_I$ Input capacitance                                    | $V_{IN} = V_{SS}$ or $V_{CC}$                                    |          |      | 5   |      | pF         |

## 5.9 Inputs – Ports P1 and P2<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                            | TEST CONDITIONS                                                                               | $V_{CC}$ or $V_{IO}$ | MIN | MAX | UNIT |
|------------------------------------------------------|-----------------------------------------------------------------------------------------------|----------------------|-----|-----|------|
| $t_{(int)}$ External interrupt timing <sup>(2)</sup> | Port P1.0 to P1.5,<br>external trigger pulse duration to set interrupt flag                   | 1.8 V to 3.6 V       | 20  |     | ns   |
|                                                      | Port P1.6 and P1.7 and P2.0 to P2.7,<br>external trigger pulse duration to set interrupt flag | 1.8 V to 5 V         | 25  |     |      |

(1) Some devices may contain additional ports with interrupts. See the block diagram and terminal function descriptions.

(2) An external signal sets the interrupt flag every time the minimum interrupt pulse duration  $t_{(int)}$  is met. It may be set by trigger signals shorter than  $t_{(int)}$ .

## 5.10 Leakage Current – General-Purpose I/O

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                            |                                |                                               | TEST CONDITIONS | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|--------------------------------------|--------------------------------|-----------------------------------------------|-----------------|-----------------|-----|-----|-----|------|
| I <sub>lkg</sub> (P <sub>x.y</sub> ) | High-impedance leakage current | Port P1.0 to P1.5, P3.0 to P3.7, PJ.0 to PJ.6 | See (1) (2)     | 1.8 V to 3.6 V  |     | ±1  | ±50 | nA   |
|                                      |                                | Port P1.6 and P1.7, P2.0 to P2.7              |                 | 1.8 V to 5 V    |     | ±1  | ±50 |      |

(1) The leakage current is measured with V<sub>SS</sub> or V<sub>CC</sub> applied to the corresponding pins, unless otherwise noted.

(2) The leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup or pulldown resistor is disabled.

## 5.11 Outputs – Ports P1, P3, PJ (Full Drive Strength, P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER       |                           | TEST CONDITIONS                              | V <sub>CC</sub> | MIN                    | MAX                    | UNIT |
|-----------------|---------------------------|----------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH</sub> | High-level output voltage | I <sub>(OHmax)</sub> = –3 mA <sup>(1)</sup>  | 1.8 V           | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        | V    |
|                 |                           | I <sub>(OHmax)</sub> = –10 mA <sup>(2)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
|                 |                           | I <sub>(OHmax)</sub> = –5 mA <sup>(1)</sup>  | 3 V             | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        |      |
|                 |                           | I <sub>(OHmax)</sub> = –15 mA <sup>(2)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
| V <sub>OL</sub> | Low-level output voltage  | I <sub>(OLmax)</sub> = 3 mA <sup>(1)</sup>   | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                 |                           | I <sub>(OLmax)</sub> = 10 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                 |                           | I <sub>(OLmax)</sub> = 5 mA <sup>(1)</sup>   | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                 |                           | I <sub>(OLmax)</sub> = 15 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.

(2) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±100 mA to hold the maximum voltage drop specified.

## 5.12 Outputs – Ports P1 to P3 (Full Drive Strength, P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER        |                           | TEST CONDITIONS                               | V <sub>IO</sub> | MIN                    | MAX                    | UNIT |
|------------------|---------------------------|-----------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH5</sub> | High-level output voltage | I <sub>(OH5max)</sub> = –3 mA <sup>(1)</sup>  | 1.8 V           | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        | V    |
|                  |                           | I <sub>(OH5max)</sub> = –10 mA <sup>(2)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –5 mA <sup>(1)</sup>  | 3 V             | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –15 mA <sup>(2)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –7 mA <sup>(1)</sup>  | 5 V             | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –20 mA <sup>(2)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
| V <sub>OL5</sub> | Low-level output voltage  | I <sub>(OL5max)</sub> = 3 mA <sup>(1)</sup>   | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                  |                           | I <sub>(OL5max)</sub> = 10 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                  |                           | I <sub>(OL5max)</sub> = 5 mA <sup>(1)</sup>   | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                  |                           | I <sub>(OL5max)</sub> = 15 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                  |                           | I <sub>(OL5max)</sub> = 7 mA <sup>(1)</sup>   | 5 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                  |                           | I <sub>(OL5max)</sub> = 20 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.

(2) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined should not exceed ±200 mA to hold the maximum voltage drop specified.

### 5.13 Outputs – Ports P1, P3, PJ (Reduced Drive Strength, P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                 | TEST CONDITIONS                             | V <sub>CC</sub> | MIN                    | MAX                    | UNIT |
|-------------------------------------------|---------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH</sub> High-level output voltage | I <sub>(OHmax)</sub> = –1 mA <sup>(2)</sup> | 1.8 V           | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        | V    |
|                                           | I <sub>(OHmax)</sub> = –3 mA <sup>(3)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
|                                           | I <sub>(OHmax)</sub> = –2 mA <sup>(2)</sup> | 3 V             | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        |      |
|                                           | I <sub>(OHmax)</sub> = –6 mA <sup>(3)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
| V <sub>OL</sub> Low-level output voltage  | I <sub>(OLmax)</sub> = 1 mA <sup>(2)</sup>  | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                                           | I <sub>(OLmax)</sub> = 3 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                                           | I <sub>(OLmax)</sub> = 2 mA <sup>(2)</sup>  | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                                           | I <sub>(OLmax)</sub> = 6 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) Selecting reduced drive strength may reduce EMI.

(2) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined, should not exceed ±48 mA to hold the maximum voltage drop specified.

(3) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined, should not exceed ±100 mA to hold the maximum voltage drop specified.

### 5.14 Outputs – Ports P1 to P3 (Reduced Drive Strength, P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                  | TEST CONDITIONS                               | V <sub>IO</sub> | MIN                    | MAX                    | UNIT |
|--------------------------------------------|-----------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH5</sub> High-level output voltage | I <sub>(OH5max)</sub> = –1 mA <sup>(2)</sup>  | 1.8 V           | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        | V    |
|                                            | I <sub>(OH5max)</sub> = –3 mA <sup>(3)</sup>  |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –2 mA <sup>(2)</sup>  | 3 V             | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –6 mA <sup>(3)</sup>  |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –4 mA <sup>(2)</sup>  | 5.0 V           | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –12 mA <sup>(3)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
| V <sub>OL5</sub> Low-level output voltage  | I <sub>(OL5max)</sub> = 1 mA <sup>(2)</sup>   | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                                            | I <sub>(OL5max)</sub> = 3 mA <sup>(3)</sup>   |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                                            | I <sub>(OL5max)</sub> = 2 mA <sup>(2)</sup>   | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                                            | I <sub>(OL5max)</sub> = 6 mA <sup>(3)</sup>   |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                                            | I <sub>(OH5max)</sub> = 4 mA <sup>(2)</sup>   | 5.0 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                                            | I <sub>(OL5max)</sub> = 12 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) Selecting reduced drive strength may reduce EMI.

(2) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined, should not exceed ±48 mA to hold the maximum voltage drop specified.

(3) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined, should not exceed ±200 mA to hold the maximum voltage drop specified.

## 5.15 Output Frequency – Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER       |                                   | TEST CONDITIONS                                                                               |                                             | MIN | MAX | UNIT |
|-----------------|-----------------------------------|-----------------------------------------------------------------------------------------------|---------------------------------------------|-----|-----|------|
| $f_{P_{x,y}}$   | Port output frequency (with load) | PJ.0/SMCLK<br>$C_L = 20 \text{ pF}$ , $R_L = 1 \text{ k}\Omega$ <sup>(1)</sup> <sup>(2)</sup> | $V_{CC} = 1.8 \text{ V}$ ,<br>PMMCOREVx = 0 | 16  |     | MHz  |
|                 |                                   |                                                                                               | $V_{CC} = 3 \text{ V}$ ,<br>PMMCOREVx = 3   | 25  |     |      |
| $f_{Port\_CLK}$ | Clock output frequency            | PJ.3/ACLK<br>PJ.0/SMCLK<br>PJ.1/MCLK<br>$C_L = 20 \text{ pF}$ <sup>(2)</sup>                  | $V_{CC} = 1.8 \text{ V}$ ,<br>PMMCOREVx = 0 | 16  |     | MHz  |
|                 |                                   |                                                                                               | $V_{CC} = 3 \text{ V}$ ,<br>PMMCOREVx = 3   | 25  |     |      |

(1) A resistive divider with  $2 \times 0.5 \text{ k}\Omega$  between  $V_{CC}$  and  $V_{SS}$  is used as load. The output is connected to the center tap of the divider.

(2) The output voltage reaches at least 10% and 90%  $V_{CC}$  at the specified toggle frequency.

## 5.16 Output Frequency – Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

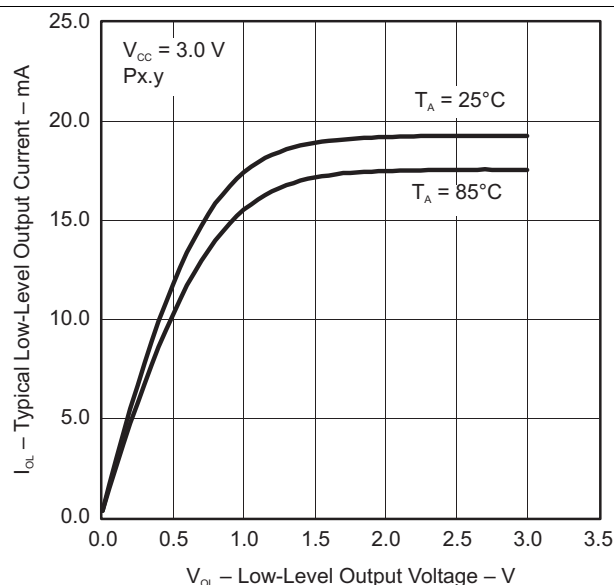
| PARAMETER       |                                   | TEST CONDITIONS                                                                                                      |                                                                        | MIN | MAX | UNIT |
|-----------------|-----------------------------------|----------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------|-----|-----|------|
| $f_{P_{x,y}}$   | Port output frequency (with load) | P1.6 port mapper SMCLK from P3.4,<br>$C_L = 20 \text{ pF}$ , $R_L = 1 \text{ k}\Omega$ <sup>(1)</sup> <sup>(2)</sup> | $V_{CC} = 1.8 \text{ V}$ , $V_{IO} = 1.8 \text{ V}$ ,<br>PMMCOREVx = 0 | 16  |     | MHz  |
|                 |                                   |                                                                                                                      | $V_{CC} = 3 \text{ V}$ , $V_{IO} = 3 \text{ V}$ ,<br>PMMCOREVx = 3     | 25  |     |      |
|                 |                                   |                                                                                                                      | $V_{CC} = 3 \text{ V}$ , $V_{IO} = 5 \text{ V}$ ,<br>PMMCOREVx = 3     | 25  |     |      |
| $f_{Port\_CLK}$ | Clock output frequency            | P1.6 port mapper SMCLK from P3.4,<br>$C_L = 20 \text{ pF}$ <sup>(2)</sup>                                            | $V_{CC} = 1.8 \text{ V}$ , $V_{IO} = 1.8 \text{ V}$ ,<br>PMMCOREVx = 0 | 16  |     | MHz  |
|                 |                                   |                                                                                                                      | $V_{CC} = 3 \text{ V}$ , $V_{IO} = 3 \text{ V}$ ,<br>PMMCOREVx = 3     | 25  |     |      |
|                 |                                   |                                                                                                                      | $V_{CC} = 3 \text{ V}$ , $V_{IO} = 5 \text{ V}$ ,<br>PMMCOREVx = 3     | 25  |     |      |

(1) A resistive divider with  $2 \times 0.5 \text{ k}\Omega$  between  $V_{CC}$  and  $V_{SS}$  is used as load. The output is connected to the center tap of the divider.

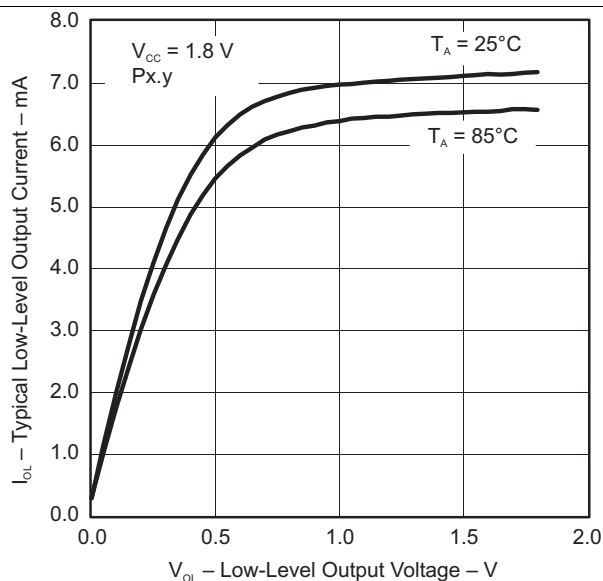
(2) The output voltage reaches at least 10% and 90%  $V_{CC}$  at the specified toggle frequency.

## 5.17 Typical Characteristics – Outputs, Reduced Drive Strength (PxDS.y = 0), Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6

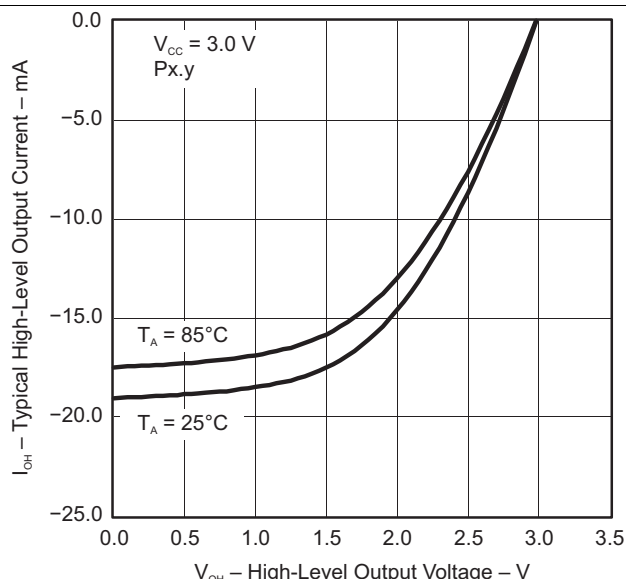
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



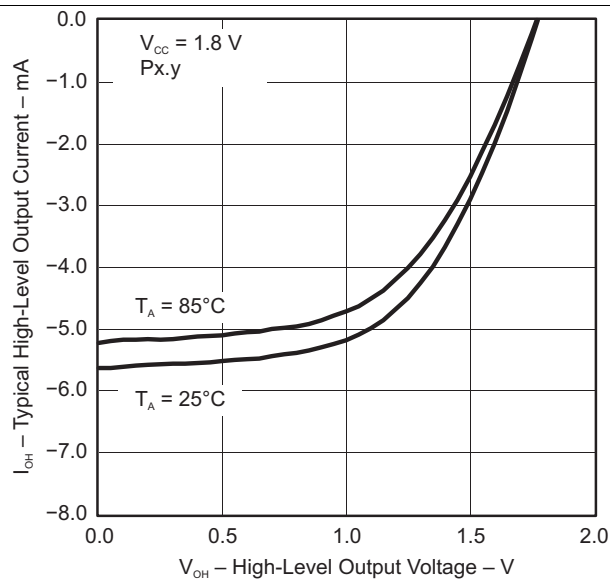
**Figure 5-2. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-3. Typical Low-Level Output Current vs Low-Level Output Voltage**



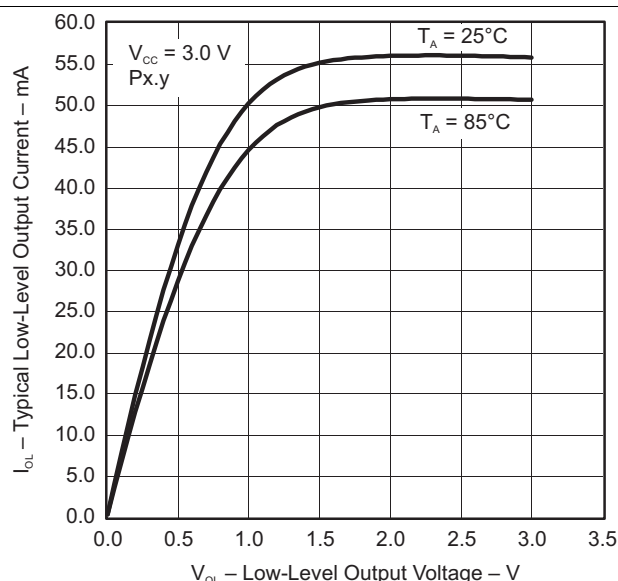
**Figure 5-4. Typical High-Level Output Current vs High-Level Output Voltage**



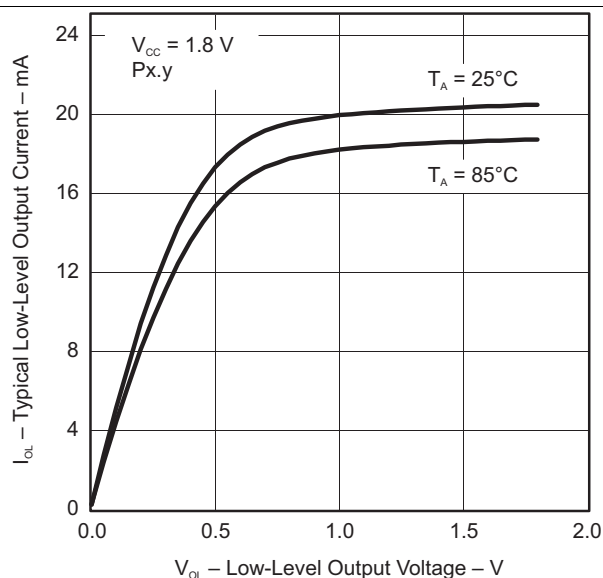
**Figure 5-5. Typical High-Level Output Current vs High-Level Output Voltage**

## 5.18 Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6

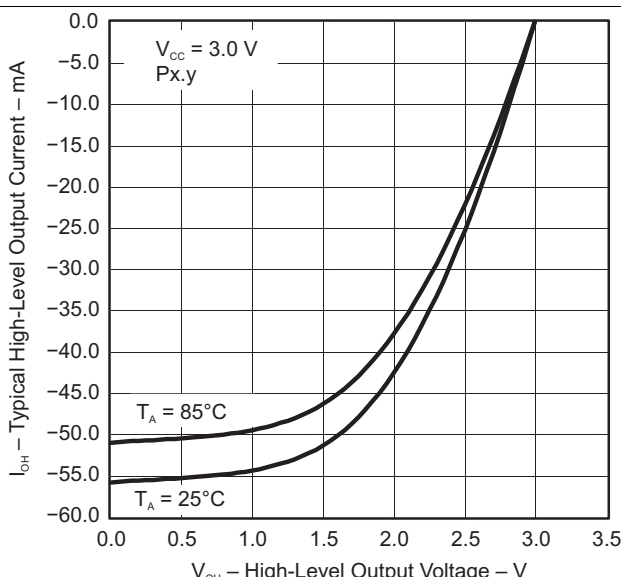
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



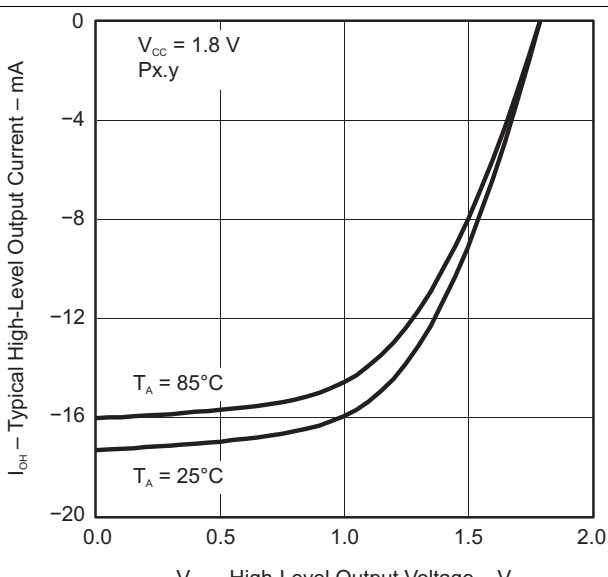
**Figure 5-6. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-7. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-8. Typical High-Level Output Current vs High-Level Output Voltage**



**Figure 5-9. Typical High-Level Output Current vs High-Level Output Voltage**

## 5.19 Typical Characteristics – Outputs, Reduced Drive Strength (PxDS.y = 0), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

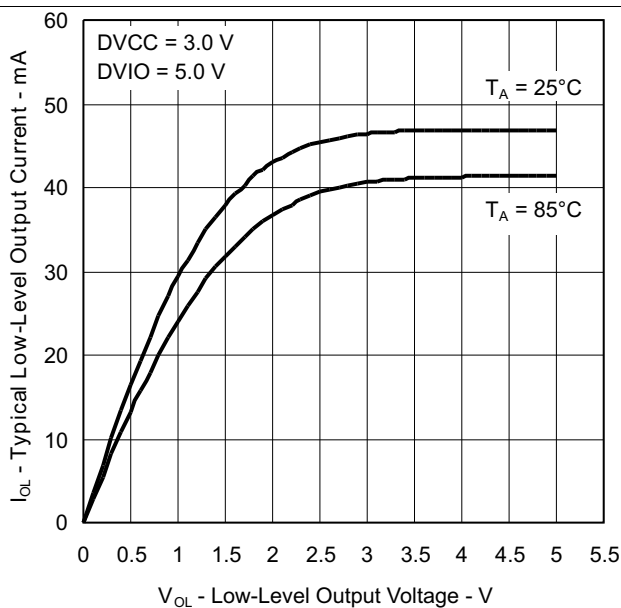


Figure 5-10. Typical Low-Level Output Current vs Low-Level Output Voltage

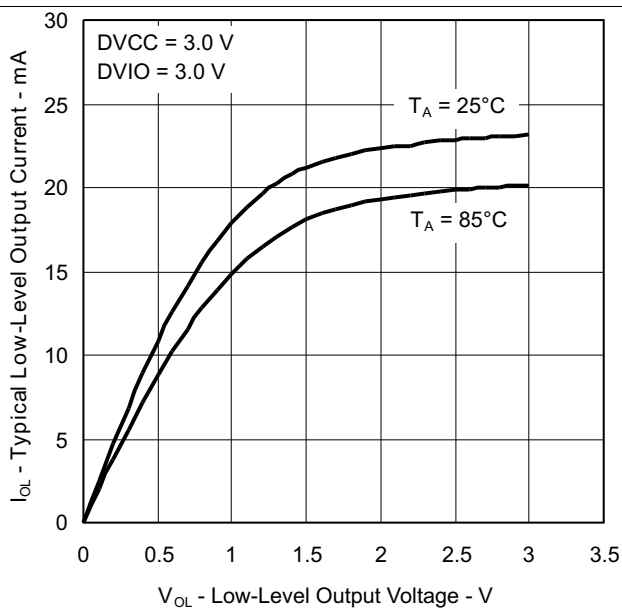


Figure 5-11. Typical Low-Level Output Current vs Low-Level Output Voltage

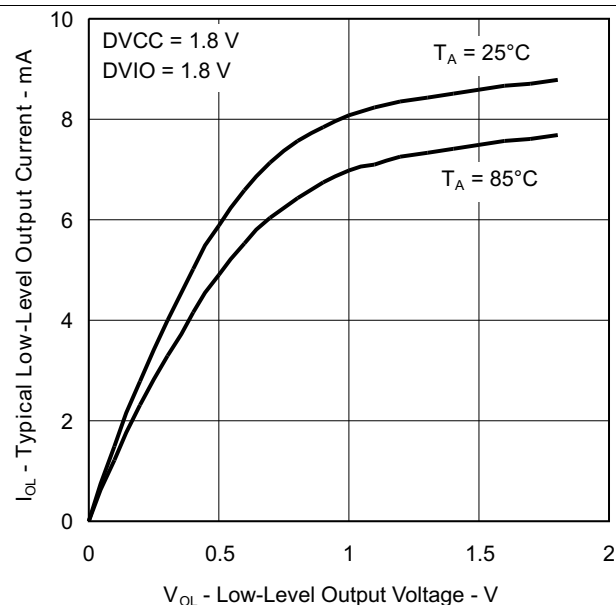


Figure 5-12. Typical Low-Level Output Current vs Low-Level Output Voltage

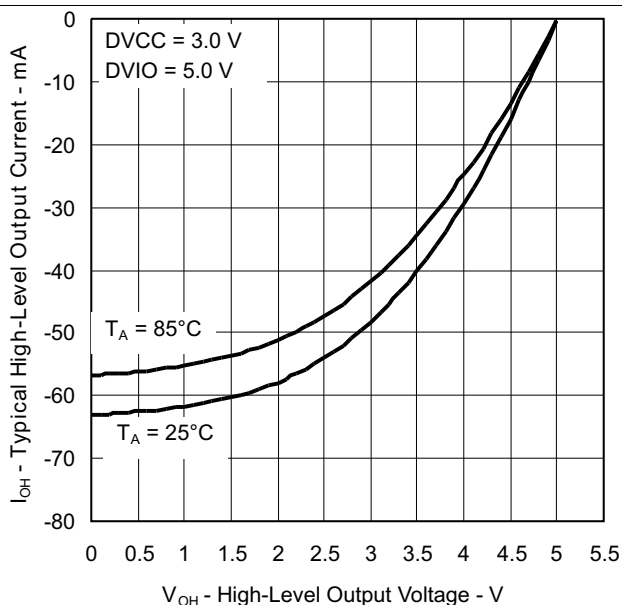
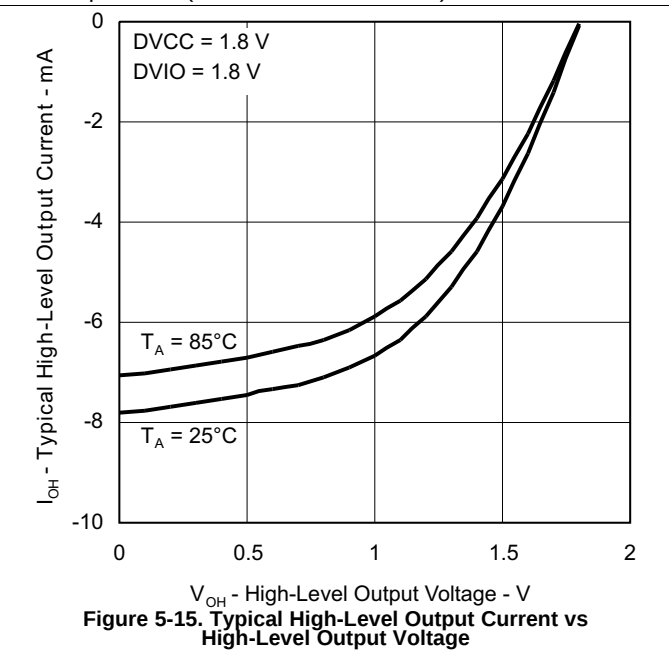
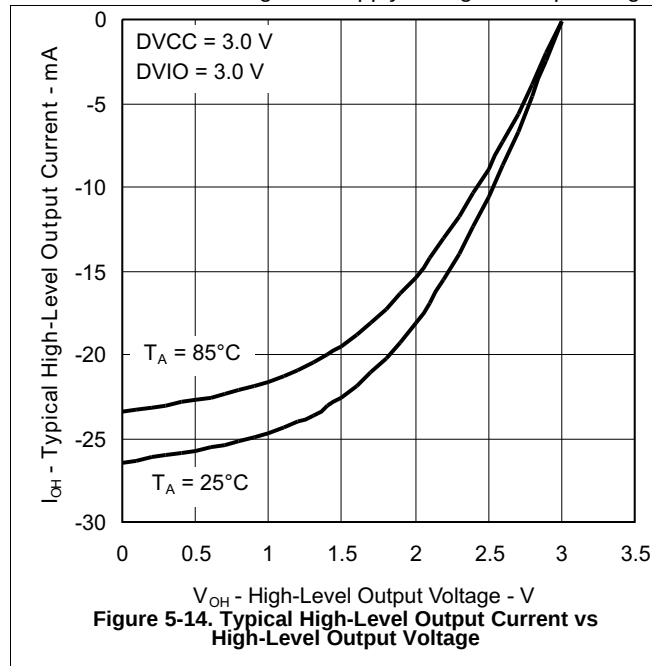


Figure 5-13. Typical High-Level Output Current vs High-Level Output Voltage

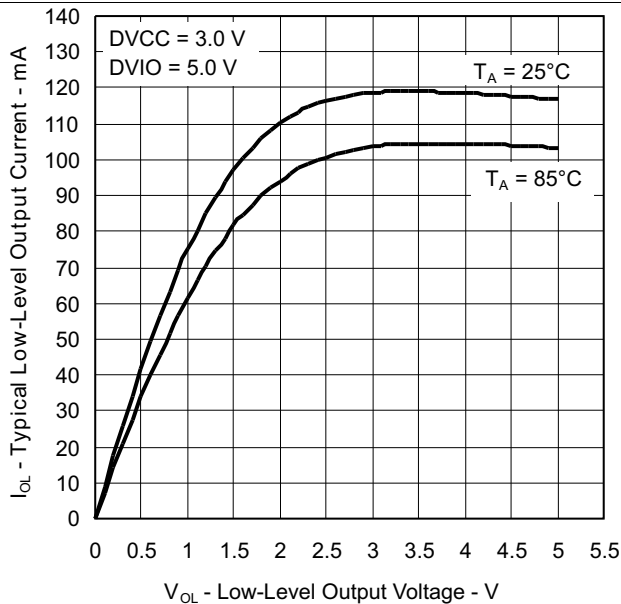
## Typical Characteristics – Outputs, Reduced Drive Strength ( $P_{xDS.y} = 0$ ), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1 (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

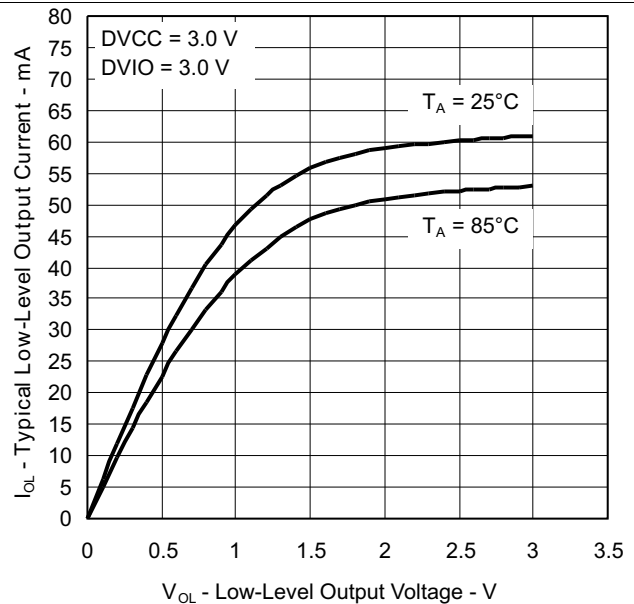


## 5.20 Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1

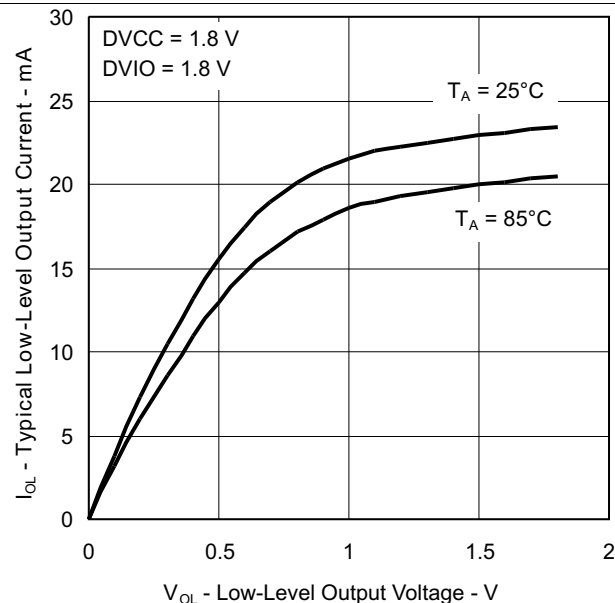
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



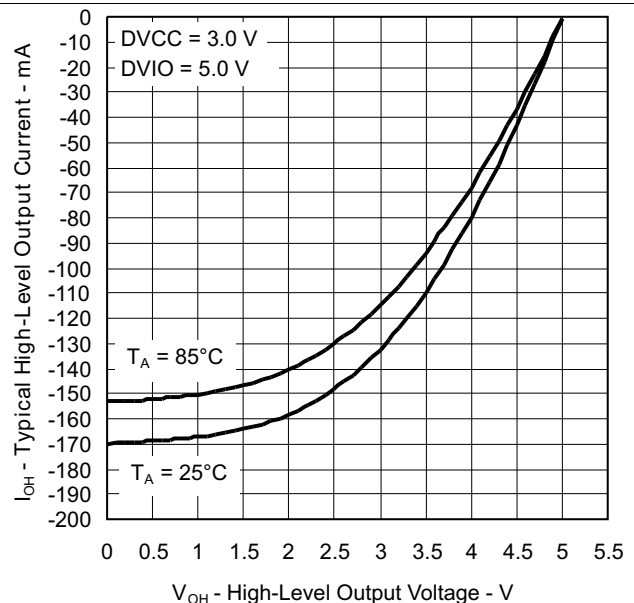
**Figure 5-16. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-17. Typical Low-Level Output Current vs Low-Level Output Voltage**



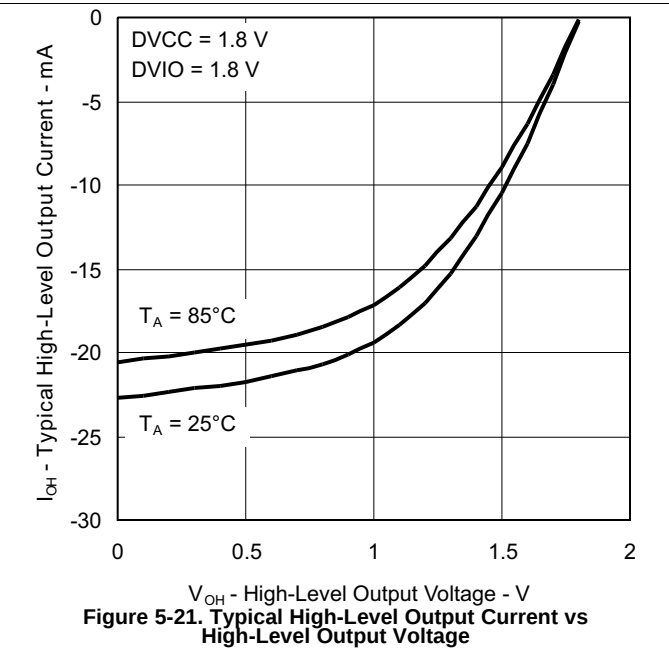
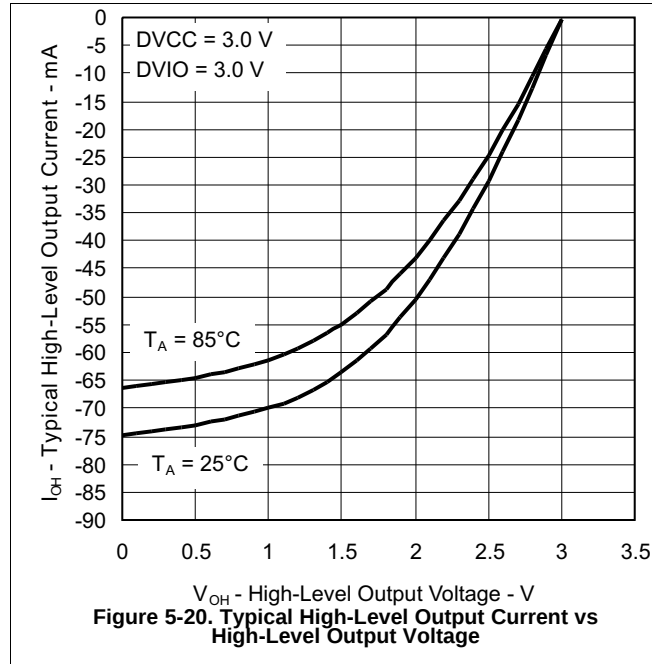
**Figure 5-18. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-19. Typical High-Level Output Current vs High-Level Output Voltage**

## Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1 (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



## 5.21 Crystal Oscillator, XT1, Low-Frequency Mode

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                                                                                            | TEST CONDITIONS                                                                                                                   | V <sub>CC</sub> | MIN   | TYP    | MAX | UNIT |
|------------------------|--------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|-----------------|-------|--------|-----|------|
| I <sub>DVCC,LF</sub>   | Differential XT1 oscillator crystal current consumption from lowest drive setting, LF mode | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1, T <sub>A</sub> = 25°C                             | 3 V             | 0.075 |        |     | μA   |
|                        |                                                                                            | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 2, T <sub>A</sub> = 25°C                             |                 | 0.170 |        |     |      |
|                        |                                                                                            | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3, T <sub>A</sub> = 25°C                             |                 | 0.290 |        |     |      |
| f <sub>XT1,LF0</sub>   | XT1 oscillator crystal frequency, LF mode                                                  | XTS = 0, XT1BYPASS = 0                                                                                                            |                 | 32768 |        |     | Hz   |
| f <sub>XT1,LF,SW</sub> | XT1 oscillator logic-level square-wave input frequency, LF mode                            | XTS = 0, XT1BYPASS = 1                                                                                                            |                 | 10    | 32.768 | 50  | kHz  |
| O <sub>A,LF</sub>      | Oscillation allowance for LF crystals                                                      | XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0, f <sub>XT1,LF</sub> = 32768 Hz, C <sub>L,eff</sub> = 6 pF                      |                 | 210   |        |     | kΩ   |
|                        |                                                                                            | XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1, f <sub>XT1,LF</sub> = 32768 Hz, C <sub>L,eff</sub> = 12 pF                     |                 | 300   |        |     |      |
| C <sub>L,eff</sub>     | Integrated effective load capacitance, LF mode                                             | XTS = 0, XCAP <sub>x</sub> = 0                                                                                                    |                 | 1     |        |     | pF   |
|                        |                                                                                            | XTS = 0, XCAP <sub>x</sub> = 1                                                                                                    |                 | 5.5   |        |     |      |
|                        |                                                                                            | XTS = 0, XCAP <sub>x</sub> = 2                                                                                                    |                 | 8.5   |        |     |      |
|                        |                                                                                            | XTS = 0, XCAP <sub>x</sub> = 3                                                                                                    |                 | 12.0  |        |     |      |
| Duty cycle, LF mode    |                                                                                            | XTS = 0, Measured at ACLK, f <sub>XT1,LF</sub> = 32768 Hz                                                                         |                 | 30%   | 70%    |     |      |
| f <sub>Fault,LF</sub>  | Oscillator fault frequency, LF mode                                                        | XTS = 0                                                                                                                           |                 | 10    | 10000  |     | Hz   |
| t <sub>START,LF</sub>  | Start-up time, LF mode                                                                     | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0, T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12 pF | 3 V             | 1000  |        |     | ms   |
|                        |                                                                                            | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3, T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12 pF |                 | 500   |        |     |      |

## 5.22 Crystal Oscillator, XT1, High-Frequency Mode<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                                          | TEST CONDITIONS                                                                                                                        | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|--------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| I <sub>DVCC,HF</sub><br>Differential XT1 oscillator crystal current consumption from lowest drive setting, HF mode | f <sub>OSC</sub> = 4 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 0,<br>T <sub>A</sub> = 25°C              | 3 V             |     | 200 |     | μA   |
|                                                                                                                    | f <sub>OSC</sub> = 12 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 1,<br>T <sub>A</sub> = 25°C             |                 |     | 260 |     |      |
|                                                                                                                    | f <sub>OSC</sub> = 20 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 2,<br>T <sub>A</sub> = 25°C             |                 |     | 325 |     |      |
|                                                                                                                    | f <sub>OSC</sub> = 32 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 3,<br>T <sub>A</sub> = 25°C             |                 |     | 450 |     |      |
| f <sub>XT1,HF0</sub><br>XT1 oscillator crystal frequency, HF mode 0                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 0 <sup>(2)</sup>                                                                   |                 | 4   |     | 8   | MHz  |
| f <sub>XT1,HF1</sub><br>XT1 oscillator crystal frequency, HF mode 1                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 1 <sup>(2)</sup>                                                                   |                 | 8   |     | 16  | MHz  |
| f <sub>XT1,HF2</sub><br>XT1 oscillator crystal frequency, HF mode 2                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 2 <sup>(2)</sup>                                                                   |                 | 16  |     | 24  | MHz  |
| f <sub>XT1,HF3</sub><br>XT1 oscillator crystal frequency, HF mode 3                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 3 <sup>(2)</sup>                                                                   |                 | 24  |     | 32  | MHz  |
| f <sub>XT1,HF,SW</sub><br>XT1 oscillator logic-level square-wave input frequency, HF mode                          | XTS = 1,<br>XT1BYPASS = 1 <sup>(3) (2)</sup>                                                                                           |                 | 0.7 |     | 32  | MHz  |
| O <sub>AHF</sub><br>Oscillation allowance for HF crystals <sup>(4)</sup>                                           | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 0,<br>f <sub>XT1,HF</sub> = 6 MHz, C <sub>L,eff</sub> = 15 pF                      |                 |     | 450 |     | Ω    |
|                                                                                                                    | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 1,<br>f <sub>XT1,HF</sub> = 12 MHz, C <sub>L,eff</sub> = 15 pF                     |                 |     | 320 |     |      |
|                                                                                                                    | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 2,<br>f <sub>XT1,HF</sub> = 20 MHz, C <sub>L,eff</sub> = 15 pF                     |                 |     | 200 |     |      |
|                                                                                                                    | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 3,<br>f <sub>XT1,HF</sub> = 32 MHz, C <sub>L,eff</sub> = 15 pF                     |                 |     | 200 |     |      |
| t <sub>START,HF</sub><br>Start-up time, HF mode                                                                    | f <sub>OSC</sub> = 6 MHz, XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 0,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 15 pF  | 3 V             |     | 0.5 |     | ms   |
|                                                                                                                    | f <sub>OSC</sub> = 20 MHz, XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>Ex</sub> = 2,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 15 pF |                 |     | 0.3 |     |      |
| C <sub>L,eff</sub><br>Integrated effective load capacitance, HF mode <sup>(5) (6)</sup>                            | XTS = 1                                                                                                                                |                 |     | 1   |     | pF   |

- (1) To improve EMI on the XT1 oscillator the following guidelines should be observed.
- Keep the traces between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins XIN and XOUT.
  - Avoid running PCB traces underneath or adjacent to the XIN and XOUT pins.
  - Use assembly materials and processes that avoid any parasitic load on the oscillator XIN and XOUT pins.
  - If conformal coating is used, make sure that it does not induce capacitive or resistive leakage between the oscillator pins.

(2) Maximum frequency of operation of the entire device cannot be exceeded.

(3) When XT1BYPASS is set, the VLO, REFO, XT1 circuits are automatically powered down.

(4) Oscillation allowance is based on a safety factor of 5 for recommended crystals.

(5) Includes parasitic bond and package capacitance (approximately 2 pF per pin).

Because the PCB adds additional capacitance, verify the correct load by measuring the ACLK frequency. For a correct setup, the effective load capacitance should always match the specification of the used crystal.

(6) Requires external capacitors at both terminals. Values are specified by crystal manufacturers.

## Crystal Oscillator, XT1, High-Frequency Mode<sup>(1)</sup> (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                   | TEST CONDITIONS                                             | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------------------------------------------------------------|-------------------------------------------------------------|-----------------|-----|-----|-----|------|
| Duty cycle, HF mode                                                         | XTS = 1, Measured at ACLK,<br>f <sub>XT1,HF2</sub> = 20 MHz |                 | 40% | 50% | 60% |      |
| f <sub>Fault,HF</sub> Oscillator fault frequency,<br>HF mode <sup>(7)</sup> | XTS = 1 <sup>(8)</sup>                                      |                 | 30  |     | 300 | kHz  |

(7) Frequencies below the MIN specification set the fault flag. Frequencies above the MAX specification do not set the fault flag. Frequencies between the MIN and MAX specifications might set the flag.

(8) Measured with logic-level input frequency but also applies to operation with crystals.

## 5.23 Internal Very-Low-Power Low-Frequency Oscillator (VLO)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                              | TEST CONDITIONS                 | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|------------------------------------------------------------------------|---------------------------------|-----------------|-----|-----|-----|------|
| f <sub>VLO</sub> VLO frequency                                         | Measured at ACLK                | 1.8 V to 3.6 V  | 6   | 9.4 | 14  | kHz  |
| df <sub>VLO</sub> /dT VLO frequency temperature drift                  | Measured at ACLK <sup>(1)</sup> | 1.8 V to 3.6 V  |     | 0.5 |     | %/°C |
| df <sub>VLO</sub> /dV <sub>CC</sub> VLO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup> | 1.8 V to 3.6 V  |     | 4   |     | %/V  |
| Duty cycle                                                             | Measured at ACLK                | 1.8 V to 3.6 V  | 40% | 50% | 60% |      |

(1) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(85°C – (–40°C)). The coefficient is negative.

(2) Calculated using the box method: (MAX(1.8 V to 3.6 V) – MIN(1.8 V to 3.6 V)) / MIN(1.8 V to 3.6 V) / (3.6 V – 1.8 V). The coefficient is positive.

## 5.24 Internal Reference, Low-Frequency Oscillator (REFO)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                | TEST CONDITIONS                    | V <sub>CC</sub>        | MIN            | TYP   | MAX   | UNIT |
|--------------------------------------------------------------------------|------------------------------------|------------------------|----------------|-------|-------|------|
| I <sub>REFO</sub> REFO oscillator current consumption                    | T <sub>A</sub> = 25°C              | 1.8 V to 3.6 V         |                | 3     |       | μA   |
| f <sub>REFO</sub>                                                        | REFO frequency calibrated          | Measured at ACLK       | 1.8 V to 3.6 V | 32768 |       | Hz   |
|                                                                          | REFO absolute tolerance calibrated | Full temperature range | 1.8 V to 3.6 V |       | ±3.5% |      |
|                                                                          |                                    | T <sub>A</sub> = 25°C  | 3 V            |       | ±1.5% |      |
| df <sub>REFO</sub> /dT REFO frequency temperature drift                  | Measured at ACLK <sup>(1)</sup>    | 1.8 V to 3.6 V         |                | 0.01  |       | %/°C |
| df <sub>REFO</sub> /dV <sub>CC</sub> REFO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup>    | 1.8 V to 3.6 V         |                | 1.0   |       | %/V  |
| Duty cycle                                                               | Measured at ACLK                   | 1.8 V to 3.6 V         | 40%            | 50%   | 60%   |      |
| t <sub>START</sub> REFO start-up time                                    | 40%/60% duty cycle                 | 1.8 V to 3.6 V         |                | 25    |       | μs   |

(1) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(85°C – (–40°C))

(2) Calculated using the box method: (MAX(1.8 V to 3.6 V) – MIN(1.8 V to 3.6 V)) / MIN(1.8 V to 3.6 V) / (3.6 V – 1.8 V)

## 5.25 DCO Frequency

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-22](#))

| PARAMETER                                                          | TEST CONDITIONS                                                          | MIN  | TYP | MAX  | UNIT  |
|--------------------------------------------------------------------|--------------------------------------------------------------------------|------|-----|------|-------|
| $f_{DCO(0,0)}$ DCO frequency (0, 0) <sup>(1)</sup>                 | DCORSELx = 0, DCOx = 0, MODx = 0                                         | 0.07 |     | 0.20 | MHz   |
| $f_{DCO(0,31)}$ DCO frequency (0, 31) <sup>(1)</sup>               | DCORSELx = 0, DCOx = 31, MODx = 0                                        | 0.70 |     | 1.70 | MHz   |
| $f_{DCO(1,0)}$ DCO frequency (1, 0) <sup>(1)</sup>                 | DCORSELx = 1, DCOx = 0, MODx = 0                                         | 0.15 |     | 0.38 | MHz   |
| $f_{DCO(1,31)}$ DCO frequency (1, 31) <sup>(1)</sup>               | DCORSELx = 1, DCOx = 31, MODx = 0                                        | 1.47 |     | 3.45 | MHz   |
| $f_{DCO(2,0)}$ DCO frequency (2, 0) <sup>(1)</sup>                 | DCORSELx = 2, DCOx = 0, MODx = 0                                         | 0.32 |     | 0.75 | MHz   |
| $f_{DCO(2,31)}$ DCO frequency (2, 31) <sup>(1)</sup>               | DCORSELx = 2, DCOx = 31, MODx = 0                                        | 3.17 |     | 7.38 | MHz   |
| $f_{DCO(3,0)}$ DCO frequency (3, 0) <sup>(1)</sup>                 | DCORSELx = 3, DCOx = 0, MODx = 0                                         | 0.64 |     | 1.51 | MHz   |
| $f_{DCO(3,31)}$ DCO frequency (3, 31) <sup>(1)</sup>               | DCORSELx = 3, DCOx = 31, MODx = 0                                        | 6.07 |     | 14.0 | MHz   |
| $f_{DCO(4,0)}$ DCO frequency (4, 0) <sup>(1)</sup>                 | DCORSELx = 4, DCOx = 0, MODx = 0                                         | 1.3  |     | 3.2  | MHz   |
| $f_{DCO(4,31)}$ DCO frequency (4, 31) <sup>(1)</sup>               | DCORSELx = 4, DCOx = 31, MODx = 0                                        | 12.3 |     | 28.2 | MHz   |
| $f_{DCO(5,0)}$ DCO frequency (5, 0) <sup>(1)</sup>                 | DCORSELx = 5, DCOx = 0, MODx = 0                                         | 2.5  |     | 6.0  | MHz   |
| $f_{DCO(5,31)}$ DCO frequency (5, 31) <sup>(1)</sup>               | DCORSELx = 5, DCOx = 31, MODx = 0                                        | 23.7 |     | 54.1 | MHz   |
| $f_{DCO(6,0)}$ DCO frequency (6, 0) <sup>(1)</sup>                 | DCORSELx = 6, DCOx = 0, MODx = 0                                         | 4.6  |     | 10.7 | MHz   |
| $f_{DCO(6,31)}$ DCO frequency (6, 31) <sup>(1)</sup>               | DCORSELx = 6, DCOx = 31, MODx = 0                                        | 39.0 |     | 88.0 | MHz   |
| $f_{DCO(7,0)}$ DCO frequency (7, 0) <sup>(1)</sup>                 | DCORSELx = 7, DCOx = 0, MODx = 0                                         | 8.5  |     | 19.6 | MHz   |
| $f_{DCO(7,31)}$ DCO frequency (7, 31) <sup>(1)</sup>               | DCORSELx = 7, DCOx = 31, MODx = 0                                        | 60   |     | 135  | MHz   |
| $S_{DCORSEL}$ Frequency step between range DCORSEL and DCORSEL + 1 | $S_{RSEL} = f_{DCO(DCORSEL+1,DCO)} / f_{DCO(DCORSEL,DCO)}$               | 1.2  |     | 2.4  | ratio |
| $S_{DCO}$ Frequency step between tap DCO and DCO + 1               | $S_{DCO} = f_{DCO(DCORSEL,DCO+1)} / f_{DCO(DCORSEL,DCO)}$                | 1.02 |     | 1.12 | ratio |
| Duty cycle                                                         | Measured at SMCLK                                                        | 40%  | 50% | 60%  |       |
| $df_{DCO}/dT$ DCO frequency temperature drift                      | $f_{DCO} = 1 \text{ MHz}$ , $V_{CORE} = 1.2 \text{ V}$ , $2.0 \text{ V}$ |      | 0.1 |      | %/°C  |
| $df_{DCO}/dV_{CORE}$ DCO frequency voltage drift                   | $f_{DCO} = 1 \text{ MHz}$                                                |      | 1.9 |      | %/V   |

- (1) When selecting the proper DCO frequency range (DCORSELx), the target DCO frequency,  $f_{DCO}$ , should be set to reside within the range of  $f_{DCO(n,0),MAX} \leq f_{DCO} \leq f_{DCO(n,31),MIN}$ , where  $f_{DCO(n,0),MAX}$  represents the maximum frequency specified for the DCO frequency, range n, tap 0 (DCOx = 0) and  $f_{DCO(n,31),MIN}$  represents the minimum frequency specified for the DCO frequency, range n, tap 31 (DCOx = 31). This ensures that the target DCO frequency resides within the range selected. It should also be noted that if the actual  $f_{DCO}$  frequency for the selected range causes the FLL or the application to select tap 0 or 31, the DCO fault flag is set to report that the selected range is at its minimum or maximum tap setting.

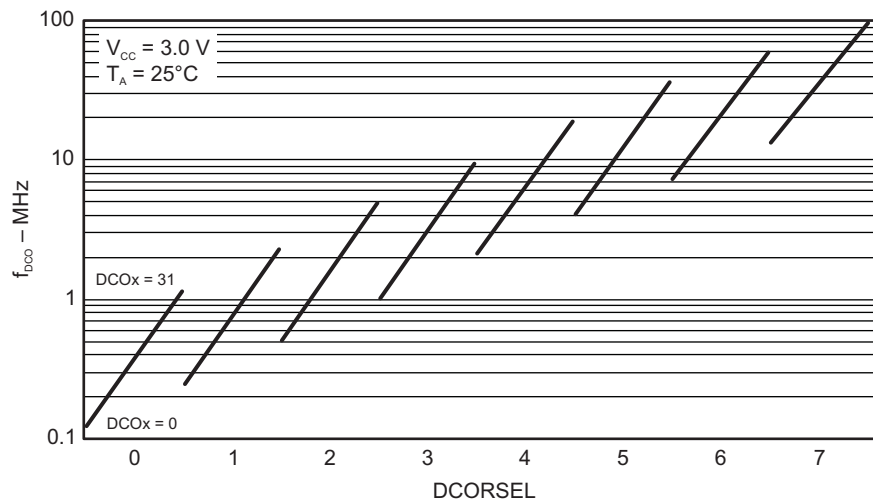


Figure 5-22. Typical DCO Frequency

## 5.26 PMM, Brownout Reset (BOR)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER               |                                                                                  | TEST CONDITIONS                   | MIN  | TYP  | MAX  | UNIT |
|-------------------------|----------------------------------------------------------------------------------|-----------------------------------|------|------|------|------|
| $V_{(DVCC\_BOR\_IT-)}$  | BOR <sub>H</sub> on voltage, DV <sub>CC</sub> falling level                      | $dDV_{CC}/dt < 3 \text{ V/s}$     |      |      | 1.45 | V    |
| $V_{(DVCC\_BOR\_IT+)}$  | BOR <sub>H</sub> off voltage, DV <sub>CC</sub> rising level                      | $dDV_{CC}/dt < 3 \text{ V/s}$     | 0.80 | 1.30 | 1.50 | V    |
| $V_{(DVCC\_BOR\_hys)}$  | BOR <sub>H</sub> hysteresis                                                      |                                   | 40   |      | 275  | mV   |
| $V_{(VCORE\_BOR\_IT-)}$ | BOR <sub>L</sub> on voltage, V <sub>CORE</sub> falling level                     | DV <sub>CC</sub> = 1.8 V to 3.6 V | 0.69 |      | 0.87 | V    |
| $V_{(VCORE\_BOR\_IT+)}$ | BOR <sub>L</sub> off voltage, V <sub>CORE</sub> rising level                     | DV <sub>CC</sub> = 1.8 V to 3.6 V | 0.83 |      | 1.05 | V    |
| $V_{(VCORE\_BOR\_hys)}$ | BOR <sub>L</sub> hysteresis                                                      |                                   | 60   |      | 200  | mV   |
| $t_{dBOR}$              | BOR <sub>L</sub> reset release time                                              |                                   |      |      | 2000 | μs   |
| $t_{RESET}$             | Pulse duration required at $\overline{RST}/\overline{NMI}$ pin to accept a reset |                                   | 2    |      |      | μs   |

## 5.27 PMM, Core Voltage

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER        |                                              | TEST CONDITIONS                                                                                      | MIN | TYP  | MAX | UNIT |
|------------------|----------------------------------------------|------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| $V_{CORE3(AM)}$  | Core voltage, active mode, PMMCOREV = 3      | $2.4 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 25 \text{ mA}$ |     | 1.90 |     | V    |
| $V_{CORE2(AM)}$  | Core voltage, active mode, PMMCOREV = 2      | $2.2 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 21 \text{ mA}$ |     | 1.80 |     | V    |
| $V_{CORE1(AM)}$  | Core voltage, active mode, PMMCOREV = 1      | $2.0 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 17 \text{ mA}$ |     | 1.60 |     | V    |
| $V_{CORE0(AM)}$  | Core voltage, active mode, PMMCOREV = 0      | $1.8 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 13 \text{ mA}$ |     | 1.40 |     | V    |
| $V_{CORE3(LPM)}$ | Core voltage, active mode, PMMCOREV = 3      | $2.4 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.94 |     | V    |
| $V_{CORE2(LPM)}$ | Core voltage, low-current mode, PMMCOREV = 2 | $2.2 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ μA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.84 |     | V    |
| $V_{CORE1(LPM)}$ | Core voltage, low-current mode, PMMCOREV = 1 | $2.0 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ μA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.64 |     | V    |
| $V_{CORE0(LPM)}$ | Core voltage, low-current mode, PMMCOREV = 0 | $1.8 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ μA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.44 |     | V    |

## 5.28 PMM, SVS High Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER         |                                       | TEST CONDITIONS                                                      | MIN  | TYP  | MAX  | UNIT          |
|-------------------|---------------------------------------|----------------------------------------------------------------------|------|------|------|---------------|
| $I_{(SVSH)}$      | SVS current consumption               | SVSHE = 0, $DV_{CC} = 3.6\text{ V}$                                  |      | 0    |      | nA            |
|                   |                                       | SVSHE = 1, $DV_{CC} = 3.6\text{ V}$ , SVSHFP = 0                     |      | 200  |      |               |
|                   |                                       | SVSHE = 1, $DV_{CC} = 3.6\text{ V}$ , SVSHFP = 1                     |      | 2    |      | $\mu\text{A}$ |
| $V_{(SVSH\_IT-)}$ | SVS <sub>H</sub> on voltage level     | SVSHE = 1, SVSHRVL = 0                                               | 1.59 | 1.64 | 1.69 | V             |
|                   |                                       | SVSHE = 1, SVSHRVL = 1                                               | 1.79 | 1.84 | 1.91 |               |
|                   |                                       | SVSHE = 1, SVSHRVL = 2                                               | 1.98 | 2.04 | 2.11 |               |
|                   |                                       | SVSHE = 1, SVSHRVL = 3                                               | 2.10 | 2.16 | 2.23 |               |
| $V_{(SVSH\_IT+)}$ | SVS <sub>H</sub> off voltage level    | SVSHE = 1, SVSMHRRRL = 0                                             | 1.62 | 1.74 | 1.81 | V             |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 1                                             | 1.88 | 1.94 | 2.01 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 2                                             | 2.07 | 2.14 | 2.21 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 3                                             | 2.20 | 2.26 | 2.33 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 4                                             | 2.32 | 2.40 | 2.48 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 5                                             | 2.56 | 2.70 | 2.84 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 6                                             | 2.85 | 3.00 | 3.15 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 7                                             | 2.85 | 3.00 | 3.15 |               |
| $t_{pd(SVSH)}$    | SVS <sub>H</sub> propagation delay    | SVSHE = 1, $dV_{DVCC}/dt = 10\text{ mV}/\mu\text{s}$ , SVSHFP = 1    |      | 2.5  |      | $\mu\text{s}$ |
|                   |                                       | SVSHE = 1, $dV_{DVCC}/dt = \pm 1\text{ mV}/\mu\text{s}$ , SVSHFP = 0 |      | 25   |      |               |
| $t_{(SVSH)}$      | SVS <sub>H</sub> on or off delay time | SVSHE = 0 $\rightarrow$ 1, SVSHFP = 1                                |      | 12.5 |      | $\mu\text{s}$ |
|                   |                                       | SVSHE = 0 $\rightarrow$ 1, SVSHFP = 0                                |      | 100  |      |               |
| $dV_{DVCC}/dt$    | $DV_{CC}$ rise time                   |                                                                      | 0    |      | 1000 | V/s           |

## 5.29 PMM, SVM High Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                             | TEST CONDITIONS                                          | MIN  | TYP  | MAX  | UNIT |
|-------------------------------------------------------|----------------------------------------------------------|------|------|------|------|
| $I_{(SVMH)}$ SVM <sub>H</sub> current consumption     | SVMHE = 0, DV <sub>CC</sub> = 3.6 V                      |      | 0    |      | nA   |
|                                                       | SVMHE = 1, DV <sub>CC</sub> = 3.6 V, SVMHFP = 0          |      | 200  |      |      |
|                                                       | SVMHE = 1, DV <sub>CC</sub> = 3.6 V, SVMHFP = 1          |      | 2.0  |      | μA   |
| $V_{(SVMH)}$ SVM <sub>H</sub> on or off voltage level | SVMHE = 1, SVSMHRRRL = 0                                 | 1.65 | 1.74 | 1.86 | V    |
|                                                       | SVMHE = 1, SVSMHRRRL = 1                                 | 1.85 | 1.94 | 2.02 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 2                                 | 2.02 | 2.14 | 2.22 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 3                                 | 2.18 | 2.26 | 2.35 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 4                                 | 2.32 | 2.40 | 2.48 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 5                                 | 2.56 | 2.70 | 2.84 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 6                                 | 2.85 | 3.00 | 3.15 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 7                                 | 2.85 | 3.00 | 3.15 |      |
| $t_{pd(SVMH)}$ SVM <sub>H</sub> propagation delay     | SVMHE = 1, dV <sub>DVCC</sub> /dt = 10 mV/μs, SVMHFP = 1 |      | 2.5  |      | μs   |
|                                                       | SVMHE = 1, dV <sub>DVCC</sub> /dt = 1 mV/μs, SVMHFP = 0  |      | 20   |      | μs   |
| $t_{(SVMH)}$ SVM <sub>H</sub> on or off delay time    | SVMHE = 0 → 1, SVSHFP = 1                                |      | 12.5 |      | μs   |
|                                                       | SVMHE = 0 → 1, SVSHFP = 0                                |      | 100  |      |      |

## 5.30 PMM, SVS Low Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                          | TEST CONDITIONS                                          | MIN | TYP  | MAX | UNIT |
|----------------------------------------------------|----------------------------------------------------------|-----|------|-----|------|
| $I_{(SVSL)}$ SVS <sub>L</sub> current consumption  | SVSLE = 0, PMMCOREV = 2                                  |     | 0    |     | nA   |
|                                                    | SVSLE = 1, PMMCOREV = 2, SVSLFP = 0                      |     | 200  |     |      |
|                                                    | SVSLE = 1, PMMCOREV = 2, SVSLFP = 1                      |     | 2.0  |     | μA   |
| $t_{(SVSL)}$ SVS <sub>L</sub> on or off delay time | SVSLE = 1, dV <sub>CORE</sub> /dt = 10 mV/μs, SVSLFP = 1 |     | 6    |     | μs   |
|                                                    | SVSLE = 1, dV <sub>CORE</sub> /dt = 1 mV/μs, SVSLFP = 0  |     | 50   |     |      |
| $t_{pd(SVSL)}$ SVS <sub>L</sub> propagation delay  | SVMHE = 0 → 1, SVSLFP = 1                                |     | 12.5 |     | μs   |
|                                                    | SVMHE = 0 → 1, SVSLFP = 0                                |     | 100  |     |      |

## 5.31 PMM, SVM Low Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                          | TEST CONDITIONS                                          | MIN | TYP  | MAX | UNIT |
|----------------------------------------------------|----------------------------------------------------------|-----|------|-----|------|
| $I_{(SVML)}$ SVM <sub>L</sub> current consumption  | SVMLE = 0, PMMCOREV = 2                                  |     | 0    |     | nA   |
|                                                    | SVMLE = 1, PMMCOREV = 2, SVMLFP = 0                      |     | 200  |     |      |
|                                                    | SVMLE = 1, PMMCOREV = 2, SVMLFP = 1                      |     | 2.0  |     | μA   |
| $t_{pd(SVML)}$ SVM <sub>L</sub> propagation delay  | SVMLE = 1, dV <sub>CORE</sub> /dt = 10 mV/μs, SVMLFP = 1 |     | 2.5  |     | μs   |
|                                                    | SVMLE = 1, dV <sub>CORE</sub> /dt = 1 mV/μs, SVMLFP = 0  |     | 30   |     |      |
| $t_{(SVML)}$ SVM <sub>L</sub> on or off delay time | SVMLE = 0 → 1, SVSLFP = 1                                |     | 12.5 |     | μs   |
|                                                    | SVMLE = 0 → 1, SVSLFP = 0                                |     | 100  |     |      |

## 5.32 Wake-up Times From Low-Power Modes

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                  | TEST CONDITIONS                                                                                                                           | MIN                                               | TYP | MAX | UNIT          |
|----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|-----|-----|---------------|
| $t_{\text{FAST-WAKE-UP}}$  | Wake-up time from LPM2, LPM3, or LPM4 to active mode <sup>(1)</sup><br>PMMCOREVx = SVSMLRRLx = n (where n = 0, 1, 2, or 3), SVSLFP = 1    | $f_{\text{MCLK}} \geq 4 \text{ MHz}$              |     | 3   | 6.5           |
|                            |                                                                                                                                           | $1 \text{ MHz} < f_{\text{MCLK}} < 4 \text{ MHz}$ |     | 4   | 8.0           |
| $t_{\text{SLOW-WAKE-UP}}$  | Wake-up time from LPM2, LPM3, or LPM4 to active mode <sup>(2)(3)</sup><br>PMMCOREVx = SVSMLRRLx = n (where n = 0, 1, 2, or 3), SVSLFP = 0 |                                                   | 150 | 165 | $\mu\text{s}$ |
| $t_{\text{WAKE-UP LPM5}}$  | Wake-up time from LPM4.5 to active mode <sup>(4)</sup>                                                                                    |                                                   | 2   | 3   | ms            |
| $t_{\text{WAKE-UP-RESET}}$ | Wake-up time from RST or BOR event to active mode <sup>(4)</sup>                                                                          |                                                   | 2   | 3   | ms            |

- (1) This value represents the time from the wake-up event to the first active edge of MCLK. The wake-up time depends on the performance mode of the low-side supervisor (SVSL) and low-side monitor (SVM<sub>L</sub>).  $t_{\text{WAKE-UP-FAST}}$  is possible with SVSL and SVM<sub>L</sub> in full performance mode or disabled. For specific register settings, see the *Low-Side SVS and SVM Control and Performance Mode Selection* section in the *Power Management Module and Supply Voltage Supervisor* chapter of the [MSP430x5xx and MSP430x6xx Family User's Guide](#).
- (2) This value represents the time from the wake-up event to the first active edge of MCLK. The wake-up time depends on the performance mode of the low-side supervisor (SVSL) and low-side monitor (SVM<sub>L</sub>).  $t_{\text{WAKE-UP-SLOW}}$  is set with SVSL and SVM<sub>L</sub> in normal mode (low current mode). For specific register settings, see the *Low-Side SVS and SVM Control and Performance Mode Selection* section in the *Power Management Module and Supply Voltage Supervisor* chapter of the [MSP430x5xx and MSP430x6xx Family User's Guide](#).
- (3) The wake-up times from LPM0 and LPM1 to AM are not specified. They are proportional to MCLK cycle time but are not affected by the performance mode settings as for LPM2, LPM3, and LPM4.
- (4) This value represents the time from the wake-up event to the reset vector execution.

## 5.33 Timer\_A

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                     | TEST CONDITIONS                                                            | V <sub>CC</sub> | MIN | MAX | UNIT |
|-----------------------------------------------|----------------------------------------------------------------------------|-----------------|-----|-----|------|
| $f_{\text{TA}}$ Timer_A input clock frequency | Internal: SMCLK or ACLK,<br>External: TACLK,<br>Duty cycle = 50% $\pm$ 10% | 1.8 V, 3 V      |     | 25  | MHz  |
| $t_{\text{TA,cap}}$ Timer_A capture timing    | All capture inputs, minimum pulse duration required for capture.           | 1.8 V, 3 V      | 20  |     | ns   |

## 5.34 USCI (UART Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                         | TEST CONDITIONS                                                           | V <sub>CC</sub> | MIN | TYP                 | MAX | UNIT |
|---------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------|-----------------|-----|---------------------|-----|------|
| $f_{\text{USCI}}$ USCI input clock frequency                                                      | Internal: SMCLK or ACLK,<br>External: UCLK,<br>Duty cycle = 50% $\pm$ 10% |                 |     | $f_{\text{SYSTEM}}$ |     | MHz  |
| $f_{\text{max,BITCLK}}$ Maximum BITCLK clock frequency (equals baud rate in MBaud) <sup>(1)</sup> |                                                                           |                 | 1   |                     |     | MHz  |
| $t_{\text{r}}$ UART receive deglitch time                                                         |                                                                           | 2.2 V           | 50  | 150                 | 200 | ns   |
|                                                                                                   |                                                                           | 3 V             | 50  | 150                 | 200 |      |

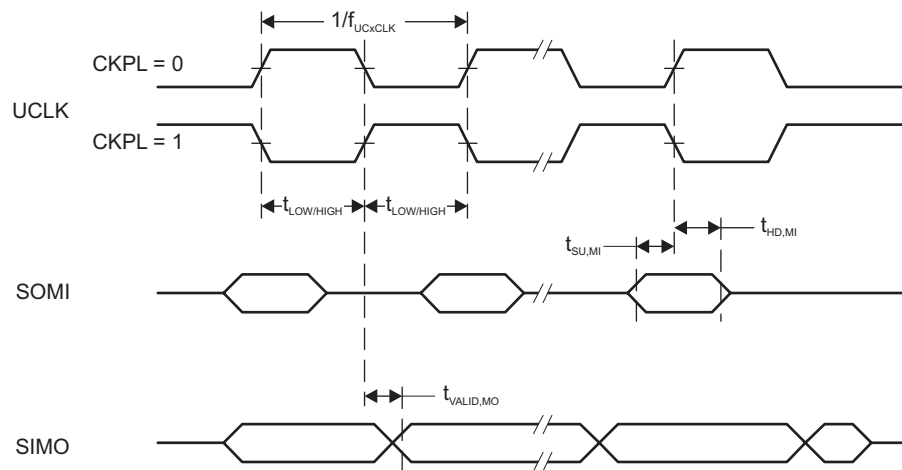
- (1) The DCO wake-up time must be considered in LPM3 and LPM4. The wake-up time must be considered in LPMx.5.

### 5.35 USCI (SPI Master Mode)

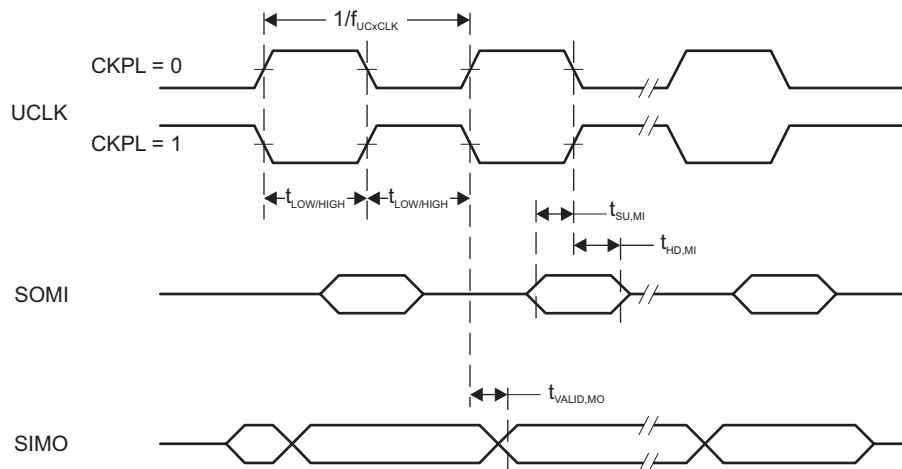
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup> (see [Figure 5-23](#) and [Figure 5-24](#))

| PARAMETER             |                                            | TEST CONDITIONS                                                  | V <sub>CC</sub> | MIN                 | MAX | UNIT |
|-----------------------|--------------------------------------------|------------------------------------------------------------------|-----------------|---------------------|-----|------|
| f <sub>USCI</sub>     | USCI input clock frequency                 | SMCLK or ACLK,<br>Duty cycle = 50% ±10%                          |                 | f <sub>SYSTEM</sub> |     | MHz  |
| t <sub>SU,MI</sub>    | SOMI input data setup time                 | PMMCOREV = 0                                                     | 1.8 V           | 55                  |     | ns   |
|                       |                                            |                                                                  | 3 V             | 38                  |     |      |
|                       |                                            | PMMCOREV = 3                                                     | 2.4 V           | 30                  |     |      |
|                       |                                            |                                                                  | 3 V             | 25                  |     |      |
| t <sub>HD,MI</sub>    | SOMI input data hold time                  | PMMCOREV = 0                                                     | 1.8 V           | 0                   |     | ns   |
|                       |                                            |                                                                  | 3 V             | 0                   |     |      |
|                       |                                            | PMMCOREV = 3                                                     | 2.4 V           | 0                   |     |      |
|                       |                                            |                                                                  | 3 V             | 0                   |     |      |
| t <sub>VALID,MO</sub> | SIMO output data valid time <sup>(2)</sup> | UCLK edge to SIMO valid,<br>C <sub>L</sub> = 20 pF, PMMCOREV = 0 | 1.8 V           | 20                  |     | ns   |
|                       |                                            |                                                                  | 3 V             | 18                  |     |      |
|                       |                                            | UCLK edge to SIMO valid,<br>C <sub>L</sub> = 20 pF, PMMCOREV = 3 | 2.4 V           | 16                  |     |      |
|                       |                                            |                                                                  | 3 V             | 15                  |     |      |
| t <sub>HD,MO</sub>    | SIMO output data hold time <sup>(3)</sup>  | C <sub>L</sub> = 20 pF, PMMCOREV = 0                             | 1.8 V           | –10                 |     | ns   |
|                       |                                            |                                                                  | 3 V             | –8                  |     |      |
|                       |                                            | C <sub>L</sub> = 20 pF, PMMCOREV = 3                             | 2.4 V           | –10                 |     |      |
|                       |                                            |                                                                  | 3 V             | –8                  |     |      |

- (1)  $f_{UCxCLK} = 1/2t_{LO/HI}$  with  $t_{LO/HI} \geq \max(t_{VALID,MO}(USCI) + t_{SU,SI}(Slave), t_{SU,MI}(USCI) + t_{VALID,SO}(Slave))$   
For the slave parameters  $t_{SU,SI}(Slave)$  and  $t_{VALID,SO}(Slave)$ , see the SPI parameters of the attached slave.
- (2) Specifies the time to drive the next valid data to the SIMO output after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-23](#) and [Figure 5-24](#).
- (3) Specifies how long data on the SIMO output is valid after the output changing UCLK clock edge. Negative values indicate that the data on the SIMO output can become invalid before the output changing clock edge observed on UCLK. See the timing diagrams in [Figure 5-23](#) and [Figure 5-24](#).



**Figure 5-23. SPI Master Mode, CKPH = 0**



**Figure 5-24. SPI Master Mode, CKPH = 1**

### 5.36 USCI (SPI Slave Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup> (see [Figure 5-25](#) and [Figure 5-26](#))

| PARAMETER                                                       | TEST CONDITIONS                                               | V <sub>CC</sub> | MIN | MAX | UNIT |
|-----------------------------------------------------------------|---------------------------------------------------------------|-----------------|-----|-----|------|
| $t_{STE,LEAD}$ STE lead time, STE low to clock                  | PMMCOREV = 0                                                  | 1.8 V           | 11  |     | ns   |
|                                                                 |                                                               | 3 V             | 8   |     |      |
|                                                                 | PMMCOREV = 3                                                  | 2.4 V           | 7   |     |      |
|                                                                 |                                                               | 3 V             | 6   |     |      |
| $t_{STE,LAG}$ STE lag time, Last clock to STE high              | PMMCOREV = 0                                                  | 1.8 V           | 3   |     | ns   |
|                                                                 |                                                               | 3 V             | 3   |     |      |
|                                                                 | PMMCOREV = 3                                                  | 2.4 V           | 3   |     |      |
|                                                                 |                                                               | 3 V             | 3   |     |      |
| $t_{STE,ACC}$ STE access time, STE low to SOMI data out         | PMMCOREV = 0                                                  | 1.8 V           |     | 66  | ns   |
|                                                                 |                                                               | 3 V             |     | 50  |      |
|                                                                 | PMMCOREV = 3                                                  | 2.4 V           |     | 36  |      |
|                                                                 |                                                               | 3 V             |     | 30  |      |
| $t_{STE,DIS}$ STE disable time, STE high to SOMI high impedance | PMMCOREV = 0                                                  | 1.8 V           |     | 30  | ns   |
|                                                                 |                                                               | 3 V             |     | 23  |      |
|                                                                 | PMMCOREV = 3                                                  | 2.4 V           |     | 16  |      |
|                                                                 |                                                               | 3 V             |     | 13  |      |
| $t_{SU,SI}$ SIMO input data setup time                          | PMMCOREV = 0                                                  | 1.8 V           | 5   |     | ns   |
|                                                                 |                                                               | 3 V             | 5   |     |      |
|                                                                 | PMMCOREV = 3                                                  | 2.4 V           | 2   |     |      |
|                                                                 |                                                               | 3 V             | 2   |     |      |
| $t_{HD,SI}$ SIMO input data hold time                           | PMMCOREV = 0                                                  | 1.8 V           | 5   |     | ns   |
|                                                                 |                                                               | 3 V             | 5   |     |      |
|                                                                 | PMMCOREV = 3                                                  | 2.4 V           | 5   |     |      |
|                                                                 |                                                               | 3 V             | 5   |     |      |
| $t_{VALID,SO}$ SOMI output data valid time <sup>(2)</sup>       | UCLK edge to SOMI valid, C <sub>L</sub> = 20 pF, PMMCOREV = 0 | 1.8 V           |     | 76  | ns   |
|                                                                 |                                                               | 3 V             |     | 60  |      |
|                                                                 | UCLK edge to SOMI valid, C <sub>L</sub> = 20 pF, PMMCOREV = 3 | 2.4 V           |     | 44  |      |
|                                                                 |                                                               | 3 V             |     | 40  |      |
| $t_{HD,SO}$ SOMI output data hold time <sup>(3)</sup>           | C <sub>L</sub> = 20 pF, PMMCOREV = 0                          | 1.8 V           | 18  |     | ns   |
|                                                                 |                                                               | 3 V             | 12  |     |      |
|                                                                 | C <sub>L</sub> = 20 pF, PMMCOREV = 3                          | 2.4 V           | 10  |     |      |
|                                                                 |                                                               | 3 V             | 8   |     |      |

(1)  $f_{UCXCLK} = 1/2t_{LO/HI}$  with  $t_{LO/HI} \geq \max(t_{VALID,MO(Master)} + t_{SU,SI(USCI)}, t_{SU,MI(Master)} + t_{VALID,SO(USCI)})$

For the master parameters  $t_{SU,MI(Master)}$  and  $t_{VALID,MO(Master)}$ , see the SPI parameters of the attached master.

(2) Specifies the time to drive the next valid data to the SOMI output after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-25](#) and [Figure 5-26](#).

(3) Specifies how long data on the SOMI output is valid after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-25](#) and [Figure 5-26](#).

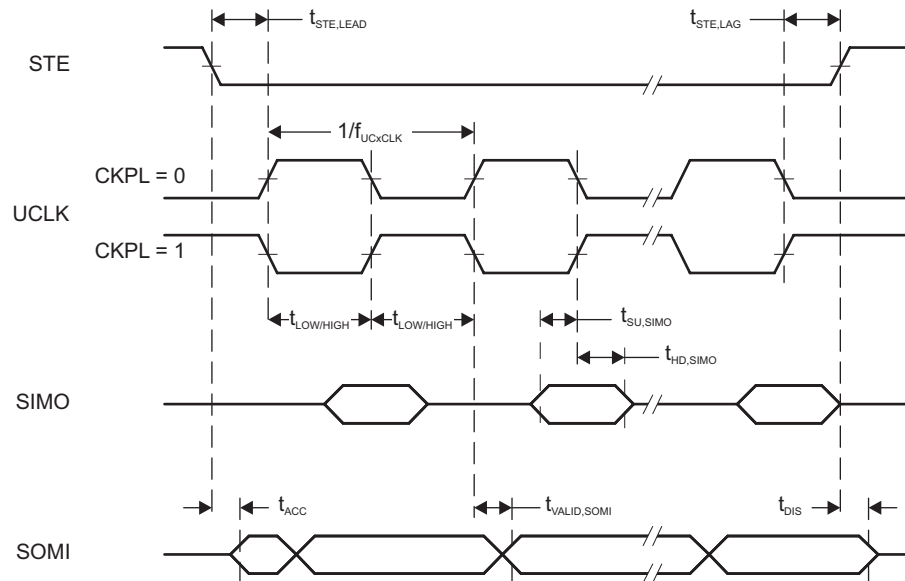


Figure 5-25. SPI Slave Mode, CKPH = 0

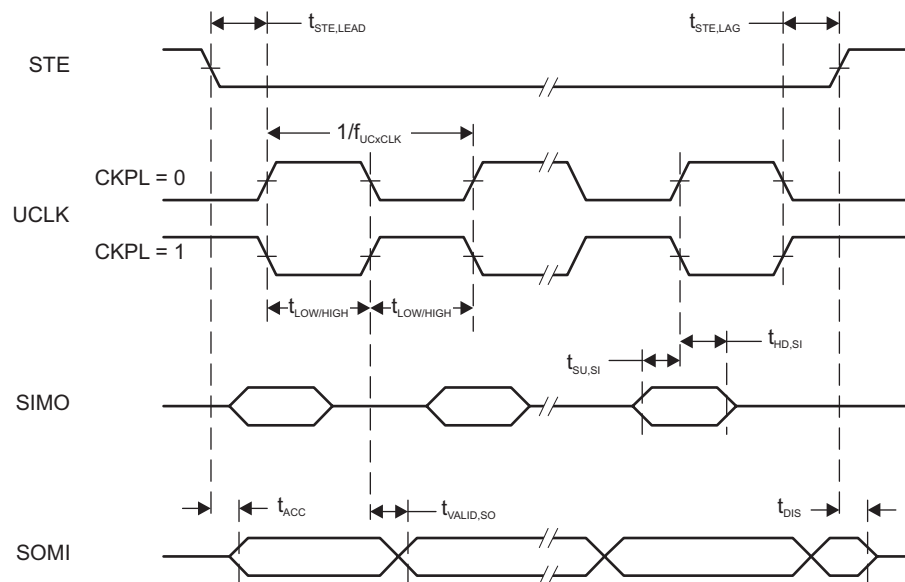
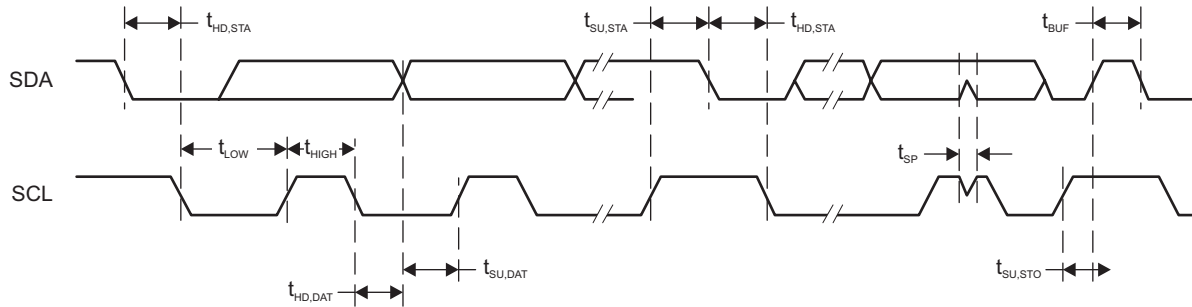


Figure 5-26. SPI Slave Mode, CKPH = 1

### 5.37 USCI (I<sup>2</sup>C Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-27](#))

| PARAMETER                                                           | TEST CONDITIONS                                                      | V <sub>CC</sub> | MIN                 | MAX | UNIT |
|---------------------------------------------------------------------|----------------------------------------------------------------------|-----------------|---------------------|-----|------|
| f <sub>USCI</sub> USCI input clock frequency                        | Internal: SMCLK or ACLK,<br>External: UCLK,<br>Duty cycle = 50% ±10% |                 | f <sub>SYSTEM</sub> |     | MHz  |
| f <sub>SCL</sub> SCL clock frequency                                |                                                                      | 2.2 V, 3 V      | 0                   | 400 | kHz  |
| t <sub>HD,STA</sub> Hold time (repeated) START                      | f <sub>SCL</sub> ≤ 100 kHz                                           | 2.2 V, 3 V      | 4.0                 |     | μs   |
|                                                                     | f <sub>SCL</sub> > 100 kHz                                           |                 | 0.6                 |     |      |
| t <sub>SU,STA</sub> Setup time for a repeated START                 | f <sub>SCL</sub> ≤ 100 kHz                                           | 2.2 V, 3 V      | 4.7                 |     | μs   |
|                                                                     | f <sub>SCL</sub> > 100 kHz                                           |                 | 0.6                 |     |      |
| t <sub>HD,DAT</sub> Data hold time                                  |                                                                      | 2.2 V, 3 V      | 0                   |     | ns   |
| t <sub>SU,DAT</sub> Data setup time                                 |                                                                      | 2.2 V, 3 V      | 250                 |     | ns   |
| t <sub>SU,STO</sub> Setup time for STOP                             | f <sub>SCL</sub> ≤ 100 kHz                                           | 2.2 V, 3 V      | 4.0                 |     | μs   |
|                                                                     | f <sub>SCL</sub> > 100 kHz                                           |                 | 0.6                 |     |      |
| t <sub>SP</sub> Pulse duration of spikes suppressed by input filter |                                                                      | 2.2 V           | 50                  | 600 | ns   |
|                                                                     |                                                                      | 3 V             | 50                  | 600 |      |



**Figure 5-27. I<sup>2</sup>C Mode Timing**

### 5.38 10-Bit ADC, Power Supply and Input Range Conditions (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER            |                                                                                   | TEST CONDITIONS                                                                                                                                                                   | V <sub>CC</sub> | MIN | TYP | MAX              | UNIT |
|----------------------|-----------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|------------------|------|
| AV <sub>CC</sub>     | Analog supply voltage                                                             | AV <sub>CC</sub> and DV <sub>CC</sub> are connected together,<br>AV <sub>SS</sub> and DV <sub>SS</sub> are connected together,<br>V <sub>(AVSS)</sub> = V <sub>(DVSS)</sub> = 0 V |                 | 1.8 |     | 3.6              | V    |
| V <sub>(Ax)</sub>    | Analog input voltage range <sup>(2)</sup>                                         | All ADC10_A pins: P1.0 to P1.5 and P3.6 and P3.7 terminals                                                                                                                        |                 | 0   |     | AV <sub>CC</sub> | V    |
| I <sub>ADC10_A</sub> | Operating supply current into AVCC terminal, REF module and reference buffer off  | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 00                                                                           | 2.2 V           |     | 60  | 90               | μA   |
|                      |                                                                                   |                                                                                                                                                                                   | 3 V             |     | 75  | 100              |      |
|                      | Operating supply current into AVCC terminal, REF module on, reference buffer on   | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 1, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 01                                                                           | 3 V             |     | 113 | 130              |      |
|                      | Operating supply current into AVCC terminal, REF module off, reference buffer on  | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 10, VREF = 2.5 V                                                             | 3 V             |     | 105 | 125              |      |
| I <sub>ADC10_A</sub> | Operating supply current into AVCC terminal, REF module off, reference buffer off | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 11, VREF = 2.5 V                                                             | 3 V             |     | 70  | 95               | μA   |
|                      |                                                                                   |                                                                                                                                                                                   |                 |     |     |                  |      |
| C <sub>I</sub>       | Input capacitance                                                                 | Only one terminal Ax can be selected at one time from the pad to the ADC10_A capacitor array including wiring and pad                                                             | 2.2 V           |     | 3.5 |                  | pF   |
| R <sub>I</sub>       | Input MUX ON resistance                                                           | AV <sub>CC</sub> > 2.0 V, 0 V ≤ V <sub>Ax</sub> ≤ AV <sub>CC</sub>                                                                                                                |                 |     |     | 36               | kΩ   |
|                      |                                                                                   | 1.8V < AV <sub>CC</sub> < 2.0 V, 0 V ≤ V <sub>Ax</sub> ≤ AV <sub>CC</sub>                                                                                                         |                 |     |     | 96               |      |

(1) The leakage current is defined in the leakage current table with P6.x/Ax parameter.

(2) The analog input voltage range must be within the selected reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results. The external reference voltage requires decoupling capacitors.

Two decoupling capacitors, 10 μF and 100 nF, should be connected to VREF to decouple the dynamic current required for an external reference source if it is used for the ADC10\_A. Also see the [MSP430x5xx and MSP430x6xx Family User's Guide](#).

### 5.39 10-Bit ADC, Timing Parameters (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                            | TEST CONDITIONS                                                                                         | V <sub>CC</sub> | MIN  | TYP                               | MAX | UNIT |
|-----------------------|--------------------------------------------|---------------------------------------------------------------------------------------------------------|-----------------|------|-----------------------------------|-----|------|
| f <sub>ADC10CLK</sub> |                                            | For specified performance of ADC10_A linearity parameters                                               | 2.2 V, 3 V      | 0.45 | 5                                 | 5.5 | MHz  |
| f <sub>ADC10OSC</sub> | Internal ADC10_A oscillator <sup>(1)</sup> | ADC10DIV = 0, f <sub>ADC10CLK</sub> = f <sub>ADC10OSC</sub>                                             | 2.2 V, 3 V      | 4.2  | 4.8                               | 5.4 | MHz  |
| t <sub>CONVERT</sub>  | Conversion time                            | REFON = 0, Internal oscillator, 12 ADC10CLK cycles, 10-bit mode, f <sub>ADC10OSC</sub> = 4 MHz to 5 MHz | 2.2 V, 3 V      | 2.4  |                                   | 3.0 | μs   |
|                       |                                            | External f <sub>ADC10CLK</sub> from ACLK, MCLK or SMCLK, ADC10SSEL ≠ 0                                  |                 |      | 12 ×<br>1 / f <sub>ADC10CLK</sub> |     |      |
| t <sub>ADC10ON</sub>  | Turnon settling time of the ADC            | See <sup>(2)</sup>                                                                                      |                 |      |                                   | 100 | ns   |
| t <sub>Sample</sub>   | Sampling time                              | R <sub>S</sub> = 1000 Ω, R <sub>I</sub> = 96 kΩ, C <sub>I</sub> = 3.5 pF <sup>(3)</sup>                 | 1.8 V           | 3    |                                   |     | μs   |
|                       |                                            | R <sub>S</sub> = 1000 Ω, R <sub>I</sub> = 36 kΩ, C <sub>I</sub> = 3.5 pF <sup>(3)</sup>                 | 3 V             | 1    |                                   |     |      |

(1) The ADC10OSC is sourced directly from MODOSC inside the UCS.

(2) The condition is that the error in a conversion started after t<sub>ADC10ON</sub> is less than ±0.5 LSB. The reference and input signal are already settled.

(3) Approximately eight Tau (τ) are required for an error of less than ±0.5 LSB

## 5.40 10-Bit ADC, Linearity Parameters (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER      |                                            | TEST CONDITIONS                                                                                               | MIN | TYP | MAX   | UNIT |
|----------------|--------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----|-----|-------|------|
| E <sub>I</sub> | Integral linearity error                   | 1.4 V ≤ (VEREF+ – VREF-) ≤ 1.6 V, C <sub>VEREF+</sub> = 20 pF                                                 |     |     | ±1.0  | LSB  |
|                |                                            | 1.6 V < (VEREF+ – VREF-) ≤ V <sub>AVCC</sub> , C <sub>VEREF+</sub> = 20 pF                                    |     |     | ±1.0  |      |
| E <sub>D</sub> | Differential linearity error               | 1.4 V ≤ (VEREF+ – VREF-),<br>C <sub>VEREF+</sub> = 20 pF                                                      |     |     | ±1.0  | LSB  |
| E <sub>O</sub> | Offset error                               | 1.4 V ≤ (VEREF+ – VREF-), C <sub>VEREF+</sub> = 20 pF,<br>Internal impedance of source R <sub>S</sub> < 100 Ω |     |     | ±1.0  | LSB  |
| E <sub>G</sub> | Gain error, external reference             | 1.4 V ≤ (VEREF+ – VREF-), C <sub>VEREF+</sub> = 20 pF                                                         |     |     | ±1.0  | LSB  |
|                | Gain error, external reference, buffered   |                                                                                                               |     |     | ±5    |      |
|                | Gain error, internal reference             | See <sup>(1)</sup>                                                                                            |     |     | ±1.5% | VREF |
| E <sub>T</sub> | Total unadjusted error, internal reference | See <sup>(1)</sup>                                                                                            |     |     | ±1.5% | VREF |

(1) Dominated by the absolute voltage of the integrated reference voltage.

## 5.41 REF, External Reference (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                        |                                               | TEST CONDITIONS                                                                                                          | V <sub>CC</sub> | MIN | TYP  | MAX              | UNIT |
|--------------------------------------------------|-----------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|------------------|------|
| VEREF+                                           | Positive external reference voltage input     | VEREF+ > VREF- <sup>(2)</sup>                                                                                            |                 | 1.4 |      | AV <sub>CC</sub> | V    |
| VEREF-                                           | Negative external reference voltage input     | VEREF+ > VREF- <sup>(3)</sup>                                                                                            |                 | 0   |      | 1.2              | V    |
| VEREF+ – VREF-                                   | Differential external reference voltage input | VEREF+ > VREF- <sup>(4)</sup>                                                                                            |                 | 1.4 |      | AV <sub>CC</sub> | V    |
| I <sub>(VEREF+)</sub> ,<br>I <sub>(VEREF-)</sub> | Static input current                          | 1.4 V ≤ VREF+ ≤ V(AVCC), VREF- = 0 V,<br>f <sub>ADC10CLK</sub> = 5 MHz, ADC10SHTX = 0x0001,<br>Conversion rate 200 ksp/s | 2.2 V, 3 V      |     | ±8.5 | ±26              | μA   |
|                                                  |                                               | 1.4 V ≤ VREF+ ≤ V(AVCC), VREF- = 0 V,<br>f <sub>ADC10CLK</sub> = 5 MHz, ADC10SHTX = 0x1000,<br>Conversion rate 20 ksp/s  | 2.2 V, 3 V      |     |      | ±1               |      |
| C <sub>(VEREF+/-)</sub>                          | Capacitance at VREF+ and VREF- terminals      | See <sup>(5)</sup>                                                                                                       |                 | 10  |      |                  | μF   |

(1) The external reference is used during ADC conversion to charge and discharge the capacitance array. The input capacitance, C<sub>I</sub>, is also the dynamic load for an external reference during conversion. The dynamic impedance of the reference supply should follow the recommendations on analog-source impedance to allow the charge to settle for 10-bit accuracy.

(2) The accuracy limits the minimum positive external reference voltage. Lower reference voltage levels may be applied with reduced accuracy requirements.

(3) The accuracy limits the maximum negative external reference voltage. Higher reference voltage levels may be applied with reduced accuracy requirements.

(4) The accuracy limits minimum external differential reference voltage. Lower differential reference voltage levels may be applied with reduced accuracy requirements.

(5) Two decoupling capacitors, 10 μF and 100 nF, should be connected to VREF to decouple the dynamic current required for an external reference source if it is used for the ADC10\_A. Also see the [MSP430x5xx and MSP430x6xx Family User's Guide](#).

## 5.42 REF, Built-In Reference (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                       | TEST CONDITIONS                                                                                                                                                       | V <sub>CC</sub>                | MIN  | TYP   | MAX  | UNIT       |
|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|------|-------|------|------------|
| V <sub>REF+</sub>               | REFVSEL = {2} for 2.5 V, REFON = 1                                                                                                                                    | 3 V                            | 2.51 | ±1.5% |      | V          |
|                                 | REFVSEL = {1} for 2.0 V, REFON = 1                                                                                                                                    | 3 V                            | 1.99 | ±1.5% |      |            |
|                                 | REFVSEL = {0} for 1.5 V, REFON = 1                                                                                                                                    | 2.2 V,<br>3 V                  | 1.5  | ±1.5% |      |            |
| AV <sub>CC(min)</sub>           | REFVSEL = {0} for 1.5 V                                                                                                                                               |                                | 1.8  |       |      | V          |
|                                 | REFVSEL = {1} for 2.0 V                                                                                                                                               |                                | 2.3  |       |      |            |
|                                 | REFVSEL = {2} for 2.5 V                                                                                                                                               |                                | 2.8  |       |      |            |
| I <sub>REF+</sub>               | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1,<br>REFBURST = 0, REFVSEL = {0} for 1.5 V                                                                                    | 3 V                            | 15.5 |       | 19   | μA         |
|                                 | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1,<br>REFBURST = 0, REFVSEL = {1} for 2.0 V                                                                                    | 3 V                            | 18   |       | 24   |            |
|                                 | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1,<br>REFBURST = 0, REFVSEL = {2} for 2.5 V                                                                                    | 3 V                            | 21   |       | 30   |            |
| TC <sub>REF+</sub>              | REFVSEL = {0, 1, 2}, REFON = 1                                                                                                                                        |                                | 30   |       | 50   | ppm/<br>°C |
| I <sub>SENSOR</sub>             | REFON = 1, INCH = 0Ah,<br>ADC10ON = 1, T <sub>A</sub> = 30°C                                                                                                          | 2.2 V                          | 150  |       | 180  | μA         |
|                                 |                                                                                                                                                                       | 3 V                            | 150  |       | 190  |            |
| V <sub>SENSOR</sub>             | REFON = 1, INCH = 0Ah,<br>ADC10ON = 1, T <sub>A</sub> = 30°C                                                                                                          | 2.2 V                          | 765  |       |      | mV         |
|                                 |                                                                                                                                                                       | 3 V                            | 765  |       |      |            |
| V <sub>MID</sub>                | ADC10ON = 1, INCH = 0Bh,<br>V <sub>MID</sub> ≈ 0.5 × V <sub>AVCC</sub>                                                                                                | 2.2 V                          | 1.06 | 1.1   | 1.14 | V          |
|                                 |                                                                                                                                                                       | 3 V                            | 1.46 | 1.5   | 1.54 |            |
| t <sub>SENSOR</sub><br>(sample) | ADC10ON = 1, INCH = 0Ah,<br>Error of conversion result ≤ 1 LSB                                                                                                        |                                | 30   |       |      | μs         |
| t <sub>VMID</sub><br>(sample)   | ADC10ON = 1, INCH = 0Bh,<br>Error of conversion result ≤ 1 LSB                                                                                                        |                                | 1    |       |      | μs         |
| PSRR <sub>DC</sub>              | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to AV <sub>CC(max)</sub> ,<br>T <sub>A</sub> = 25°C, REFVSEL = {0, 1, 2}, REFON = 1                                          |                                | 120  |       | 300  | μV/V       |
| PSRR <sub>AC</sub>              | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to AV <sub>CC(max)</sub> ,<br>T <sub>A</sub> = 25°C, f = 1 kHz, ΔV <sub>pp</sub> = 100 mV,<br>REFVSEL = {0, 1, 2}, REFON = 1 |                                | 6.4  |       |      | mV/V       |
| t <sub>SETTLE</sub>             | AV <sub>CC</sub> = AV <sub>CC(min)</sub> to<br>AV <sub>CC(max)</sub> ,<br>REFVSEL = {0, 1, 2},<br>REFON = 0 → 1                                                       | T <sub>A</sub> = –40°C to 85°C |      | 23    | 125  | μs         |
|                                 |                                                                                                                                                                       | T <sub>A</sub> = 25°C          |      | 23    | 50   |            |
|                                 |                                                                                                                                                                       | T <sub>A</sub> = 85°C          |      | 16    | 25   |            |

- (1) The leakage current is defined in the leakage current table with P6.x/Ax parameter.
- (2) The internal reference current is supplied through the AV<sub>CC</sub> terminal. Consumption is independent of the ADC10ON control bit, unless a conversion is active. The REFON bit enables to settle the built-in reference before starting an A/D conversion.
- (3) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C)).
- (4) The sensor current I<sub>SENSOR</sub> is consumed if (ADC10ON = 1 and REFON = 1) or (ADC10ON = 1 and INCH = 0Ah and sample signal is high). When REFON = 1, I<sub>SENSOR</sub> is already included in I<sub>REF+</sub>.
- (5) The temperature sensor offset can be as much as ±20°C. TI recommends a single-point calibration to minimize the offset error of the built-in temperature sensor.
- (6) The typical equivalent impedance of the sensor is 51 kΩ. The sample time required includes the sensor-on time t<sub>SENSOR(on)</sub>.
- (7) The on-time t<sub>VMID(on)</sub> is included in the sampling time t<sub>VMID(sample)</sub>; no additional on time is needed.
- (8) The condition is that the error in a conversion started after t<sub>REFON</sub> is less than ±0.5 LSB.

## 5.43 Comparator\_B

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                                                                                   | TEST CONDITIONS                                                                     | V <sub>CC</sub> | MIN                  | TYP                | MAX                  | UNIT   |
|------------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|-----------------|----------------------|--------------------|----------------------|--------|
| V <sub>CC</sub>        | Supply voltage                                                                    |                                                                                     |                 | 1.8                  |                    | 3.6                  | V      |
| I <sub>AVCC_COMP</sub> | Comparator operating supply current into AVCC, Excludes reference resistor ladder | CBPWRMD = 00, CBON = 1, CBR <sub>Sx</sub> = 00                                      | 1.8 V           |                      |                    | 38                   | μA     |
|                        |                                                                                   |                                                                                     | 2.2 V           |                      | 31                 | 38                   |        |
|                        |                                                                                   |                                                                                     | 3 V             |                      | 32                 | 39                   |        |
|                        |                                                                                   | CBPWRMD = 01, CBON = 1, CBR <sub>Sx</sub> = 00                                      | 2.2 V, 3 V      |                      | 10                 | 17                   |        |
|                        |                                                                                   | CBPWRMD = 10, CBON = 1, CBR <sub>Sx</sub> = 00                                      | 2.2 V, 3 V      |                      | 0.2                | 0.85                 |        |
| V <sub>REF</sub>       | Reference voltage level                                                           | CBREFL <sub>x</sub> = 01, CBREFACC = 0                                              | ≥1.8 V          | 1.42                 | 1.44               | 1.46                 | V      |
|                        |                                                                                   | CBREFL <sub>x</sub> = 10, CBREFACC = 0                                              | ≥2.2 V          | 1.89                 | 1.92               | 1.95                 |        |
|                        |                                                                                   | CBREFL <sub>x</sub> = 11, CBREFACC = 0                                              | ≥3.0 V          | 2.35                 | 2.39               | 2.43                 |        |
| I <sub>AVCC_REF</sub>  | Quiescent current of resistor ladder into AVCC, Including REF module current      | CBREFACC = 1, CBREFL <sub>x</sub> = 01, CBR <sub>Sx</sub> = 10, REFON = 0, CBON = 0 | 2.2 V, 3 V      |                      | 10                 | 17                   | μA     |
|                        |                                                                                   | CBREFACC = 0, CBREFL <sub>x</sub> = 01, CBR <sub>Sx</sub> = 10, REFON = 0, CBON = 0 | 2.2 V, 3 V      |                      | 33                 | 40                   |        |
| V <sub>IC</sub>        | Common mode input range                                                           |                                                                                     |                 | 0                    |                    | V <sub>CC</sub> – 1  | V      |
| V <sub>OFFSET</sub>    | Input offset voltage                                                              | CBPWRMD = 00                                                                        |                 |                      |                    | ±20                  | mV     |
|                        |                                                                                   | CBPWRMD = 01, 10                                                                    |                 |                      |                    | ±10                  |        |
| C <sub>IN</sub>        | Input capacitance                                                                 |                                                                                     |                 |                      | 5                  |                      | pF     |
| R <sub>SIN</sub>       | Series input resistance                                                           | On (switch closed)                                                                  |                 |                      | 3                  | 4                    | kΩ     |
|                        |                                                                                   | Off (switch opened)                                                                 |                 | 50                   |                    |                      | MΩ     |
| t <sub>PD</sub>        | Propagation delay, response time                                                  | CBPWRMD = 00, CBF = 0                                                               |                 |                      |                    | 450                  | ns     |
|                        |                                                                                   | CBPWRMD = 01, CBF = 0                                                               |                 |                      |                    | 600                  |        |
|                        |                                                                                   | CBPWRMD = 10, CBF = 0                                                               |                 |                      |                    | 50                   | μs     |
| t <sub>PD,filter</sub> | Propagation delay with filter active                                              | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 00                            |                 | 0.35                 | 0.6                | 1.5                  | μs     |
|                        |                                                                                   | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 01                            |                 | 0.6                  | 1.0                | 1.8                  |        |
|                        |                                                                                   | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 10                            |                 | 1.0                  | 1.8                | 3.4                  |        |
|                        |                                                                                   | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 11                            |                 | 1.8                  | 3.4                | 6.5                  |        |
| t <sub>EN_CMP</sub>    | Comparator enable time                                                            | CBON = 0 → 1, CBPWRMD = 00 or 01                                                    |                 |                      | 1                  | 2                    | μs     |
|                        |                                                                                   | CBON = 0 → 1, CBPWRMD = 10                                                          |                 |                      |                    | 100                  |        |
| t <sub>EN_REF</sub>    | Resistor reference enable time                                                    | CBON = 0 to CBON = 1                                                                |                 |                      | 1.0                | 1.5                  | μs     |
| TC <sub>CB_REF</sub>   | Temperature coefficient reference of V <sub>CB_REF</sub>                          |                                                                                     |                 |                      |                    | 50                   | ppm/°C |
| V <sub>CB_REF</sub>    | Reference voltage for a given tap                                                 | VIN = reference into resistor ladder, n = 0 to 31                                   |                 | VIN × (n + 0.5) / 32 | VIN × (n + 1) / 32 | VIN × (n + 1.5) / 32 | V      |

## 5.44 Timer\_D, Power Supply and Reference Clock

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER              |                                                                    | TEST CONDITIONS                                                                 | V <sub>CC</sub>                       | MIN | TYP | MAX  | UNIT |
|------------------------|--------------------------------------------------------------------|---------------------------------------------------------------------------------|---------------------------------------|-----|-----|------|------|
| DV <sub>CC</sub>       | Digital supply voltage                                             | V <sub>(DVSS)</sub> = 0 V                                                       |                                       | 1.8 |     | 3.6  | V    |
| f <sub>REF,DCO</sub>   | Timer_D input reference clock frequency                            | PMMCOREVx = 0                                                                   | 1.8 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 12.0 | MHz  |
|                        |                                                                    | PMMCOREVx = 1                                                                   | 2.0 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 16.0 |      |
|                        |                                                                    | PMMCOREVx = 2                                                                   | 2.2 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 20.0 |      |
|                        |                                                                    | PMMCOREVx = 3                                                                   | 2.4 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 25.5 |      |
| I <sub>(64MHz)</sub>   | I <sub>(DVCC)</sub> at 64-MHz Timer_D clock, clock generator only  | f <sub>reference</sub> = 8 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 0, TDHCLKCR = 0  |                                       |     | 253 | 320  | μA   |
| I <sub>(128MHz)</sub>  | I <sub>(DVCC)</sub> at 128-MHz Timer_D clock, clock generator only | f <sub>reference</sub> = 16 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 0, TDHCLKCR = 0 |                                       |     | 285 | 360  | μA   |
| I <sub>(200MHz)</sub>  | I <sub>(DVCC)</sub> at 200-MHz Timer_D clock, clock generator only | f <sub>reference</sub> = 25 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 0, TDHCLKCR = 1 |                                       |     | 280 | 345  | μA   |
| I <sub>(256MHz)</sub>  | I <sub>(DVCC)</sub> at 256-MHz Timer_D clock, clock generator only | f <sub>reference</sub> = 16 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 1, TDHCLKCR = 1 |                                       |     | 265 | 330  | μA   |
| I <sub>(0,16,64)</sub> | I <sub>(DVCC)</sub>                                                | TDHCLKRx = 0, TDHCLKSRx = 16, TDHCLKTRIM = 64                                   | 2.2 V                                 |     | 244 |      | μA   |
|                        |                                                                    |                                                                                 | 3.0 V                                 |     | 295 | 325  |      |
| I <sub>(1,16,64)</sub> | I <sub>(DVCC)</sub>                                                | TDHCLKRx = 1, TDHCLKSRx = 16, TDHCLKTRIM = 64                                   | 2.2 V                                 |     | 282 |      | μA   |
|                        |                                                                    |                                                                                 | 3.0 V                                 |     | 300 | 400  |      |
| I <sub>(2,16,64)</sub> | I <sub>(DVCC)</sub>                                                | TDHCLKRx = 2, TDHCLKSRx = 16, TDHCLKTRIM = 64                                   | 2.2 V                                 |     | 358 |      | μA   |
|                        |                                                                    |                                                                                 | 3.0 V                                 |     | 414 | 470  |      |

(1) The leakage current is defined in the leakage current table with P6.x/Ax parameter.

## 5.45 Timer\_D, Local Clock Generator Frequency

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                               | TEST CONDITIONS                                                                       | MIN | TYP | MAX | UNIT |
|---------------------------------------------------------|---------------------------------------------------------------------------------------|-----|-----|-----|------|
| $f_{\text{HRCG}(0,0,64)}$ HRCG frequency (0, 0, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 39  | 56  | 73  | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 78  | 112 | 146 |      |
| $f_{\text{HRCG}(0,7,64)}$ HRCG frequency (0, 7, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 46  | 66  | 86  | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 92  | 132 | 172 |      |
| $f_{\text{HRCG}(0,15,64)}$ HRCG frequency (0, 15, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 55  | 78  | 101 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 110 | 156 | 202 |      |
| $f_{\text{HRCG}(0,23,64)}$ HRCG frequency (0, 23, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 61  | 87  | 113 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 122 | 174 | 226 |      |
| $f_{\text{HRCG}(0,31,0)}$ HRCG frequency (0, 31, 0)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 36  | 56  | 73  | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 72  | 112 | 146 |      |
| $f_{\text{HRCG}(0,31,64)}$ HRCG frequency (0, 31, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 68  | 98  | 128 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 136 | 196 | 256 |      |
| $f_{\text{HRCG}(0,31,127)}$ HRCG frequency (0, 31, 127) | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 127 | 97  | 138 | 180 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 127 | 196 | 176 | 360 |      |
| $f_{\text{HRCG}(1,0,64)}$ HRCG frequency (1, 0, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 71  | 101 | 131 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 142 | 202 | 262 |      |
| $f_{\text{HRCG}(1,7,64)}$ HRCG frequency (1, 7, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 84  | 120 | 156 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 168 | 240 | 312 |      |
| $f_{\text{HRCG}(1,15,64)}$ HRCG frequency (1, 15, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 97  | 139 | 182 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 196 | 278 | 364 |      |
| $f_{\text{HRCG}(1,23,64)}$ HRCG frequency (1, 23, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 108 | 154 | 200 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 216 | 308 | 400 |      |
| $f_{\text{HRCG}(1,31,0)}$ HRCG frequency (1, 31, 0)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 68  | 97  | 126 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 136 | 194 | 252 |      |
| $f_{\text{HRCG}(1,31,64)}$ HRCG frequency (1, 31, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 123 | 175 | 227 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 246 | 350 | 454 |      |

## Timer\_D, Local Clock Generator Frequency (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                       |                                                            | TEST CONDITIONS                                                                                                        | MIN | TYP | MAX  | UNIT |
|---------------------------------|------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------|-----|-----|------|------|
| $f_{\text{HRCG}(1,31,127)}$     | HRCG frequency (1, 31, 127)                                | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0,<br>TDHCLKRx = 1, TDHCLKSRx = 31,<br>TDHCLKTRIM = 127                            | 169 | 241 | 313  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0,<br>TDHCLKRx = 1, TDHCLKSRx = 31,<br>TDHCLKTRIM = 127                            | 338 | 482 | 616  |      |
| $f_{\text{HRCG}(2,0,64)}$       | HRCG frequency (2, 0, 64)                                  | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 0, TDHCLKTRIM = 64                                 | 126 | 180 | 234  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 1, TDHCLKSRx = 0, TDHCLKTRIM = 64                                 | 252 | 360 | 468  |      |
| $f_{\text{HRCG}(2,7,64)}$       | HRCG frequency (2, 7, 64)                                  | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 7, TDHCLKTRIM = 64                                 | 138 | 208 | 270  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 7, TDHCLKTRIM = 6                                  | 276 | 416 | 540  |      |
| $f_{\text{HRCG}(2,15,64)}$      | HRCG frequency (2, 15, 64)                                 | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 15, TDHCLKTRIM = 64                                | 168 | 240 | 312  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 15, TDHCLKTRIM = 64                                | 336 | 480 | 624  |      |
| $f_{\text{HRCG}(2,23,64)}$      | HRCG frequency (2, 23, 64)                                 | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 23, TDHCLKTRIM = 64                                | 189 | 270 | 351  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 23, TDHCLKTRIM = 64                                | 378 | 540 | 702  |      |
| $f_{\text{HRCG}(2,31,0)}$       | HRCG frequency (2, 31, 0)                                  | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 0                                 | 119 | 170 | 221  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 0                                 | 238 | 340 | 442  |      |
| $f_{\text{HRCG}(2,31,64)}$      | HRCG frequency (2, 31, 64)                                 | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 64                                | 212 | 303 | 394  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 64                                | 424 | 606 | 788  |      |
| $f_{\text{HRCG}(2,31,127)}$     | HRCG frequency (2, 31, 127)                                | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31,<br>TDHCLKTRIM = 127                            | 290 | 413 | 537  | MHz  |
|                                 |                                                            | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31,<br>TDHCLKTRIM = 127                            | 580 | 826 | 1074 |      |
| $S_{\text{HRCG},0,\text{SR}}$   | TDHCLKSRx step size in range 0                             | $S_{\text{HRCGSR}} = f_{\text{HRCGSR}(\text{HRCGSR}+1)} - f_{\text{HRCG}(\text{HRCGSR})}$                              | 120 | 185 | 225  | kHz  |
| $S_{\text{HRCG},1,\text{SR}}$   | TDHCLKSRx step size in range 1                             | $S_{\text{HRCGSR}} = f_{\text{HRCGSR}(\text{HRCGSR}+1)} - f_{\text{HRCG}(\text{HRCGSR})}$                              | 220 | 325 | 395  | kHz  |
| $S_{\text{HRCG},2,\text{SR}}$   | TDHCLKSRx step size in range 2                             | $S_{\text{HRCGSR}} = f_{\text{HRCGSR}(\text{HRCGSR}+1)} - f_{\text{HRCG}(\text{HRCGSR})}$                              | 400 | 555 | 700  | kHz  |
| $S_{\text{HRCG},0,\text{TRIM}}$ | $0 \geq \text{TDHCLKTRIMx} < 16$ ,<br>step size in range 0 | $S_{\text{HRCGSR}} = f_{\text{HRCGSR}(\text{HRCGTRIM}+1)} - f_{\text{HRCG}(\text{HRCGTRIM})}$ ,<br>TDHCLKSRx = X, Y, Z | 55  | 85  | 120  | kHz  |
|                                 | $15 < \text{TDHCLKTRIMx} < 49$ ,<br>step size in range 1   |                                                                                                                        | 40  | 85  | 130  |      |
|                                 | $48 < \text{TDHCLKTRIMx} < 64$ ,<br>step size in range 2   |                                                                                                                        | 40  | 85  | 120  |      |
| $S_{\text{HRCG},1,\text{TRIM}}$ | $0 \geq \text{TDHCLKTRIMx} < 16$ ,<br>step size in range 0 | $S_{\text{HRCGSR}} = f_{\text{HRCGSR}(\text{HRCGTRIM}+1)} - f_{\text{HRCG}(\text{HRCGTRIM})}$ ,<br>TDHCLKSRx = X, Y, Z | 90  | 160 | 230  | kHz  |
|                                 | $15 < \text{TDHCLKTRIMx} < 49$ ,<br>step size in range 1   |                                                                                                                        | 80  | 160 | 230  |      |
|                                 | $48 < \text{TDHCLKTRIMx} < 64$ ,<br>step size in range 2   |                                                                                                                        | 80  | 160 | 230  |      |

## Timer\_D, Local Clock Generator Frequency (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                  |                                                | TEST CONDITIONS                                                                                               | MIN | TYP | MAX   | UNIT |
|--------------------------------------------|------------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----|-----|-------|------|
| S <sub>HRCG,2,TRIM</sub>                   | 0 >= TDHCLKTRIMx < 16,<br>step size in range 0 | S <sub>HRCGSR</sub> = f <sub>HRCGSR</sub> (HRCGTRIM+1) – f <sub>HRCG</sub> (HRCGTRIM),<br>TDHCLKSRx = X, Y, Z | 150 | 230 | 360   | kHz  |
|                                            | 15 < TDHCLKTRIMx < 49,<br>step size in range 1 |                                                                                                               | 130 | 230 | 350   |      |
|                                            | 48 < TDHCLKTRIMx < 32,<br>step size in range 2 |                                                                                                               | 100 | 230 | 340   |      |
| df <sub>HRCG</sub> /dT                     | HRCG frequency<br>temperature drift            | f <sub>HRCG</sub> = 8 MHz, TDHREGEN = 0                                                                       |     |     | ±0.17 | %/°C |
|                                            |                                                | f <sub>HRCG</sub> = 16 MHz, TDHREGEN = 0                                                                      |     |     | ±0.16 |      |
|                                            |                                                | f <sub>HRCG</sub> = 25 MHz, TDHREGEN = 0                                                                      |     |     | ±0.16 |      |
|                                            |                                                | f <sub>HRCG</sub> = 8, 16, or 25 MHz, TDHREGEN = 1                                                            |     | 0   |       |      |
| df <sub>HRCG</sub> /<br>dV <sub>DVCC</sub> | HRCG frequency voltage drift                   | f <sub>HRCG</sub> = 8, 16, or 25 MHz, TDHREGEN = 0                                                            | 0   |     | 5     | %/V  |
|                                            |                                                | f <sub>HRCG</sub> = 8, 16, or 25 MHz, TDHREGEN = 1                                                            |     | 0   |       |      |
| t <sub>SETTLE</sub>                        | Settling time                                  | TDHEN = 0 → 1, TDHFW = 0                                                                                      | 3   | 5   | 9     | μs   |
|                                            | Settling time, fast wake-up                    | TDHEN = 0 → 1, TDHFW = 1                                                                                      |     |     | 1.5   |      |

## 5.46 Timer\_D, Trimmed Clock Frequencies

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                           |                                                                   | TEST CONDITIONS                                   | MIN   | TYP | MAX   | UNIT |
|-------------------------------------|-------------------------------------------------------------------|---------------------------------------------------|-------|-----|-------|------|
| Frequency tolerance during trimming |                                                                   |                                                   | –0.5% |     | +0.5% |      |
| f <sub>TRIM(64MHz)</sub>            | TDHMx = 0, TDHREGEN = 0, TDHCLKCR = 0,<br>TDHxCTL1 = TDHxCTL1_64  | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 1.8 V | 63    | 64  | 65    | MHz  |
| f <sub>TRIM(128MHz)</sub>           | TDHMx = 0, TDHREGEN = 0, TDHCLKCR = 1,<br>TDHxCTL1 = TDHxCTL1_128 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.0 V | 126   | 128 | 130   | MHz  |
| f <sub>TRIM(200MHz)</sub>           | TDHMx = 0, TDHREGEN = 0, TDHCLKCR = 1,<br>TDHxCTL1 = TDHxCTL1_200 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.4 V | 197   | 200 | 203   | MHz  |
| f <sub>TRIM(256MHz)</sub>           | TDHMx = 1, TDHREGEN = 0, TDHCLKCR = 1,<br>TDHxCTL1 = TDHxCTL1_256 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.2 V | 250   | 256 | 262   | MHz  |

## 5.47 Timer\_D, Frequency Multiplication Mode

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                       |                                                                                         | TEST CONDITIONS                                   | MIN | TYP | MAX | UNIT |
|---------------------------------|-----------------------------------------------------------------------------------------|---------------------------------------------------|-----|-----|-----|------|
| External frequency tolerance    |                                                                                         |                                                   |     | 0%  |     |      |
| E <sub>(TDHREGEN = 1,64)</sub>  | f <sub>reference</sub> = 8 MHz, TDHMx = 0, TDHREGEN = 1,<br>TDHCLKCR = 0, TDHCLKRx = 0  | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 1.8 V | –1% |     | +1% |      |
| E <sub>(TDHREGEN = 1,128)</sub> | f <sub>reference</sub> = 16 MHz, TDHMx = 0, TDHREGEN = 1,<br>TDHCLKCR = 1, TDHCLKRx = 0 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.0 V | –1% |     | +1% |      |
| E <sub>(TDHREGEN = 1,200)</sub> | f <sub>reference</sub> = 25 MHz, TDHMx = 0, TDHREGEN = 1,<br>TDHCLKCR = 1, TDHCLKRx = 0 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.4 V | –1% |     | +1% |      |
| E <sub>(TDHREGEN = 1,256)</sub> | f <sub>reference</sub> = 16 MHz, TDHMx = 1, TDHREGEN = 1,<br>TDHCLKCR = 1, TDHCLKRx = 0 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.2 V | –1% |     | +1% |      |

## 5.48 Timer\_D, Input Capture and Output Compare Timing

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                                                                                                                               | TEST CONDITIONS                                       | MIN | TYP | MAX | UNIT |
|--------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------|-----|-----|-----|------|
| $t_{TD,cap}$             | Timer_D input capture timing, minimum pulse duration to trigger input capture event                                                           | $f_{MAX} = 262 \text{ MHz}$                           |     | 4   |     | ns   |
| $t_{TD0,cap,matching}$   | Timer0_D input capture timing, matching between input capture channels P1.6 to P1.7 and P2.0                                                  | $f_{MAX} = 262 \text{ MHz}$                           |     | 1   | 2   | LSB  |
|                          | Timer0_D input capture timing, matching between input capture channels. P2.4 to P2.5 and P2.6                                                 | $f_{MAX} = 262 \text{ MHz}$                           |     | 3   | 4   |      |
| $t_{TD1,cap,matching}$   | Timer1_D input capture timing, matching between input capture channels P2.1 to P2.2 and P2.3                                                  | $f_{MAX} = 262 \text{ MHz}$                           |     | 2   | 3   | LSB  |
|                          | Timer1_D input capture timing, matching between input capture channels. P2.7 to P3.0 and P3.1                                                 | $f_{MAX} = 262 \text{ MHz}$                           |     | 2   | 4   |      |
| $t_{TD01,cap,matching}$  | Timer0_D and Timer1_D input capture timing, matching between input capture channels. Timer0_D is the high-resolution clock generator source.  | $f_{MAX} = 262 \text{ MHz}$                           |     | 4   | 8   | LSB  |
| $t_{TD0,comp,matching}$  | Timer0_D output compare timing, matching between output capture compare channels for pins P1.6, P1.7, and P2.0                                | Rising edges, $f_{MAX} = 262 \text{ MHz}$             |     |     | 4   | ns   |
|                          |                                                                                                                                               | Falling edges, $f_{MAX} = 262 \text{ MHz}$            |     |     | 4   |      |
|                          |                                                                                                                                               | Rising and falling edges, $f_{MAX} = 262 \text{ MHz}$ |     |     | 8   |      |
| $t_{TD1,comp,matching}$  | Timer1_D output compare timing, matching between output capture compare channels for pins P2.1, P2.2, and P2.3                                | Rising edges, $f_{MAX} = 262 \text{ MHz}$             |     |     | 4   | ns   |
|                          |                                                                                                                                               | Falling edges, $f_{MAX} = 262 \text{ MHz}$            |     |     | 4   |      |
|                          |                                                                                                                                               | Rising and falling edges, $f_{MAX} = 262 \text{ MHz}$ |     |     | 8   |      |
| $t_{TD01,comp,matching}$ | Timer0_D and Timer1_D output compare timing, matching between output compare channels. Timer0_D is the high-resolution clock generator source | All edges, $f_{MAX} = 262 \text{ MHz}$                |     |     | 8   | LSB  |

## 5.49 Flash Memory

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                               |                                                                                                  | T <sub>J</sub> | MIN             | TYP             | MAX | UNIT   |
|-----------------------------------------|--------------------------------------------------------------------------------------------------|----------------|-----------------|-----------------|-----|--------|
| DV <sub>CC(PGM/ERASE)</sub>             | Program and erase supply voltage                                                                 |                | 1.8             |                 | 3.6 | V      |
| I <sub>PGM</sub>                        | Supply current from DVCC during program                                                          |                |                 | 3               | 5   | mA     |
| I <sub>ERASE</sub>                      | Supply current from DVCC during erase                                                            |                |                 | 2               | 6.5 | mA     |
| I <sub>MERASE</sub> , I <sub>BANK</sub> | Supply current from DVCC during mass erase or bank erase                                         |                |                 | 2               | 6.5 | mA     |
| t <sub>CPT</sub>                        | Cumulative program time <sup>(1)</sup>                                                           |                |                 |                 | 16  | ms     |
|                                         | Program and erase endurance                                                                      |                | 10 <sup>4</sup> | 10 <sup>5</sup> |     | cycles |
| t <sub>Retention</sub>                  | Data retention duration                                                                          | 25°C           | 100             |                 |     | years  |
| t <sub>Word</sub>                       | Word or byte program time <sup>(2)</sup>                                                         |                | 64              |                 | 85  | μs     |
| t <sub>Block, 0</sub>                   | Block program time for first byte or word <sup>(2)</sup>                                         |                | 49              |                 | 65  | μs     |
| t <sub>Block, 1–(N–1)</sub>             | Block program time for each additional byte or word, except for last byte or word <sup>(2)</sup> |                | 37              |                 | 49  | μs     |
| t <sub>Block, N</sub>                   | Block program time for last byte or word <sup>(2)</sup>                                          |                | 55              |                 | 73  | μs     |
| t <sub>Mass Erase</sub>                 | Mass erase time <sup>(2)</sup>                                                                   |                | 23              |                 | 32  | ms     |
| t <sub>Seg Erase</sub>                  | Segment erase time <sup>(2)</sup>                                                                |                | 23              |                 | 32  | ms     |
| f <sub>MCLK,MGR</sub>                   | MCLK frequency in marginal read mode (FCLK4.MGR0 = 1 or FCTL4.MGR1 = 1)                          |                | 0               |                 | 1   | MHz    |

- (1) The cumulative program time must not be exceeded when writing to a 128-byte flash block. This parameter applies to all programming methods: individual word or byte write and block write modes.
- (2) These values are hardwired into the state machine of the flash controller.

## 5.50 JTAG and Spy-Bi-Wire Interface

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                                                                      | V <sub>CC</sub> | MIN   | TYP | MAX | UNIT |
|-----------------------|--------------------------------------------------------------------------------------|-----------------|-------|-----|-----|------|
| f <sub>SBW</sub>      | Spy-Bi-Wire input frequency                                                          | 2.2 V, 3 V      | 0     |     | 20  | MHz  |
| t <sub>SBW,Low</sub>  | Spy-Bi-Wire low clock pulse duration                                                 | 2.2 V, 3 V      | 0.025 |     | 15  | μs   |
| t <sub>SBW,En</sub>   | Spy-Bi-Wire enable time (TEST high to acceptance of first clock edge) <sup>(1)</sup> | 2.2 V, 3 V      |       |     | 1   | μs   |
| t <sub>SBW,Rst</sub>  | Spy-Bi-Wire return to normal operation time                                          |                 | 15    |     | 100 | μs   |
| f <sub>TCK</sub>      | TCK input frequency, 4-wire JTAG <sup>(2)</sup>                                      | 2.2 V           | 0     |     | 5   | MHz  |
|                       |                                                                                      | 3 V             | 0     |     | 10  |      |
| R <sub>internal</sub> | Internal pulldown resistance on TEST                                                 | 2.2 V, 3 V      | 45    | 60  | 80  | kΩ   |

- (1) Tools that access the Spy-Bi-Wire interface must wait for the minimum t<sub>SBW,En</sub> time after pulling the TEST/SBWTCK pin high before applying the first SBWTCK clock edge.
- (2) f<sub>TCK</sub> may be restricted to meet the timing requirements of the module selected.

## 6 Detailed Description

### 6.1 CPU

The MSP430 CPU has a 16-bit RISC architecture that is highly transparent to the application. All operations, other than program-flow instructions, are performed as register operations in conjunction with seven addressing modes for source operand and four addressing modes for destination operand.

The CPU is integrated with 16 registers that provide reduced instruction execution time. The register-to-register operation execution time is one cycle of the CPU clock.

Four of the registers, R0 to R3, are dedicated as program counter, stack pointer, status register, and constant generator, respectively. The remaining registers are general-purpose registers (see [Figure 6-1](#)).

Peripherals are connected to the CPU using data, address, and control buses. Peripherals can be managed with all instructions.

|                          |           |
|--------------------------|-----------|
| Program Counter          | PC/R0     |
| Stack Pointer            | SP/R1     |
| Status Register          | SR/CG1/R2 |
| Constant Generator       | CG2/R3    |
| General-Purpose Register | R4        |
| General-Purpose Register | R5        |
| General-Purpose Register | R6        |
| General-Purpose Register | R7        |
| General-Purpose Register | R8        |
| General-Purpose Register | R9        |
| General-Purpose Register | R10       |
| General-Purpose Register | R11       |
| General-Purpose Register | R12       |
| General-Purpose Register | R13       |
| General-Purpose Register | R14       |
| General-Purpose Register | R15       |

**Figure 6-1. Integrated CPU Registers**

## 6.2 Instruction Set

The instruction set consists of the original 51 instructions with three formats and seven address modes and additional instructions for the expanded address range. Each instruction can operate on word and byte data. [Table 6-1](#) lists examples of the three types of instruction formats; [Table 6-2](#) lists the address modes.

**Table 6-1. Instruction Word Formats**

| FORMAT                            | EXAMPLE   | OPERATION                                 |
|-----------------------------------|-----------|-------------------------------------------|
| Dual operands, source-destination | ADD R4,R5 | $R4 + R5 \rightarrow R5$                  |
| Single operands, destination only | CALL R8   | $PC \rightarrow (TOS), R8 \rightarrow PC$ |
| Relative jump, un/conditional     | JNE       | Jump-on-equal bit = 0                     |

**Table 6-2. Address Mode Descriptions**

| ADDRESS MODE           | S <sup>(1)</sup> | D <sup>(1)</sup> | SYNTAX             | EXAMPLE          | OPERATION                                             |
|------------------------|------------------|------------------|--------------------|------------------|-------------------------------------------------------|
| Register               | +                | +                | MOV Rs,Rd          | MOV R10,R11      | $R10 \rightarrow R11$                                 |
| Indexed                | +                | +                | MOV X(Rn),Y(Rm)    | MOV 2(R5),6(R6)  | $M(2+R5) \rightarrow M(6+R6)$                         |
| Symbolic (PC relative) | +                | +                | MOV EDE,TONI       |                  | $M(EDE) \rightarrow M(TONI)$                          |
| Absolute               | +                | +                | MOV & MEM, & TCDAT |                  | $M(MEM) \rightarrow M(TCDAT)$                         |
| Indirect               | +                |                  | MOV @Rn,Y(Rm)      | MOV @R10,Tab(R6) | $M(R10) \rightarrow M(Tab+R6)$                        |
| Indirect autoincrement | +                |                  | MOV @Rn+,Rm        | MOV @R10+,R11    | $M(R10) \rightarrow R11$<br>$R10 + 2 \rightarrow R10$ |
| Immediate              | +                |                  | MOV #X,TONI        | MOV #45,TONI     | $\#45 \rightarrow M(TONI)$                            |

(1) S = source, D = destination

## 6.3 Operating Modes

The MSP430 has one active mode and six software-selectable low-power modes of operation. An interrupt event can wake up the device from any of the five low-power modes, service the request, and restore back to the low-power mode on return from the interrupt program.

Software can configure the following operating modes:

- Active mode (AM)
  - All clocks are active
- Low-power mode 0 (LPM0)
  - CPU is disabled
  - ACLK and SMCLK remain active
  - MCLK is disabled
  - FLL loop control remains active
- Low-power mode 1 (LPM1)
  - CPU is disabled
  - FLL loop control is disabled
  - ACLK and SMCLK remain active
  - MCLK is disabled
- Low-power mode 2 (LPM2)
  - CPU is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DC generator of the DCO remains enabled
  - ACLK remains active
- Low-power mode 3 (LPM3)
  - CPU is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DC generator of the DCO is disabled
  - ACLK remains active
- Low-power mode 4 (LPM4)
  - CPU is disabled
  - ACLK is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DC generator of the DCO is disabled
  - Crystal oscillator is stopped
  - Complete data retention
- Low-power mode 5 (LPM4.5)
  - Internal regulator disabled
  - No data retention
  - Wake-up input from  $\overline{\text{RST}}$ /NMI, P1, and P2

## 6.4 Interrupt Vector Addresses

The interrupt vectors and the power-up start address are in the address range 0FFFFh to 0FF80h (see [Table 6-3](#)). The vector contains the 16-bit address of the appropriate interrupt-handler instruction sequence.

**Table 6-3. Interrupt Sources, Flags, and Vectors**

| INTERRUPT SOURCE                                                                                                    | INTERRUPT FLAG                                                                                                      | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY    |
|---------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------|------------------|--------------|-------------|
| <b>System Reset</b><br>Power up<br>External reset<br>Watchdog time-out, key violation<br>Flash memory key violation | WDTIFG, KEYV (SYSRSTIV) <sup>(1) (2)</sup>                                                                          | Reset            | 0FFFEh       | 63, highest |
| <b>System NMI</b><br>PMM<br>Vacant memory access<br>JTAG mailbox                                                    | SVMLIFG, SVMHIFG, DLYLIFG, DLYHIFG, VLRIFG, VLRHIFG, VMAIFG, JMBNIFG, JMBOUTIFG (SYSSNIV) <sup>(1)</sup>            | (Non)maskable    | 0FFFCh       | 62          |
| <b>User NMI</b><br>NMI<br>Oscillator fault<br>Flash memory access violation                                         | NMIIFG, OFIFG, ACCVIFG (SYSUNIV) <sup>(1) (2)</sup>                                                                 | (Non)maskable    | 0FFFAh       | 61          |
| Comp_B                                                                                                              | CBIIFG, CBIFG (CBIV) <sup>(1) (3)</sup>                                                                             | Maskable         | 0FFF8h       | 60          |
| TEC0                                                                                                                | TEC0FLTIFG, TEC0EXCLRIFG, TEC0AXCLRIFG <sup>(1) (3)</sup>                                                           | Maskable         | 0FFF6h       | 59          |
| TD0                                                                                                                 | TD0CCR0 CCIFG0 <sup>(3)</sup>                                                                                       | Maskable         | 0FFF4h       | 58          |
| <b>TD0</b>                                                                                                          | TD0CCR1 CCIFG1, ... TD0CCR2 CCIFG2, TD0IFG, TD0HFLIFG, TD0HFHIFG, TD0HLKIFG, TD0HUNLKIFG (TD0IV) <sup>(1) (3)</sup> | Maskable         | 0FFF2h       | 57          |
| Watchdog Timer_A interval timer mode                                                                                | WDTIFG                                                                                                              | Maskable         | 0FFF0h       | 56          |
| USCI_A0 receive or transmit                                                                                         | UCA0RXIFG, UCA0TXIFG (UCA0IV) <sup>(1) (3)</sup>                                                                    | Maskable         | 0FFEEh       | 55          |
| USCI_B0 receive or transmit                                                                                         | UCB0RXIFG, UCB0TXIFG, I <sup>2</sup> C Status Interrupt Flags (UCB0IV) <sup>(1) (3)</sup>                           | Maskable         | 0FFECCh      | 54          |
| ADC10_A (MSP430F51x2 only)                                                                                          | ADC10IFG0, ADC10INIFG, ADC10LOIFG, ADC10HIIFG, ADC10TOVIFG, ADC10OVIFG (ADC10IV) <sup>(1) (3)</sup>                 | Maskable         | 0FFEAh       | 53          |
| TA0                                                                                                                 | TA0CCR0 CCIFG0 <sup>(3)</sup>                                                                                       | Maskable         | 0FFE8h       | 52          |
| TA0                                                                                                                 | TA0CCR1 CCIFG1 ... TA0CCR2 CCIFG2, TA0IFG (TA0IV) <sup>(1) (3)</sup>                                                | Maskable         | 0FFE6h       | 51          |
| DMA                                                                                                                 | DMA0IFG, DMA1IFG, DMA2IFG (DMAIV) <sup>(1) (3)</sup>                                                                | Maskable         | 0FFE4h       | 50          |
| TEC1                                                                                                                | TEC1FLTIFG, TEC1EXCLRIFG, TEC1AXCLRIFG <sup>(1) (3)</sup>                                                           | Maskable         | 0FFE2h       | 49          |
| TD1                                                                                                                 | TD1CCR0 CCIFG0 <sup>(3)</sup>                                                                                       | Maskable         | 0FFE0h       | 48          |
| TD1                                                                                                                 | TD1CCR1 CCIFG1 ... TD1CCR2 CCIFG2, TD1IFG, TD1HFLIFG, TD1HFHIFG, TD1HLKIFG, TD1HUNLKIFG (TD1IV) <sup>(1) (3)</sup>  | Maskable         | 0FFDEh       | 47          |
| I/O port P1                                                                                                         | P1IFG.0 to P1IFG.7 (P1IV) <sup>(1) (3)</sup>                                                                        | Maskable         | 0FFDCh       | 46          |
| I/O port P2                                                                                                         | P2IFG.0 to P2IFG.7 (P2IV) <sup>(1) (3)</sup>                                                                        | Maskable         | 0FFDAh       | 45          |
| Reserved                                                                                                            | Reserved <sup>(4)</sup>                                                                                             |                  | 0FFD8h       | 44          |
|                                                                                                                     |                                                                                                                     |                  | ⋮            | ⋮           |
|                                                                                                                     |                                                                                                                     |                  | 0FF80h       | 0, lowest   |

(1) Multiple source flags

(2) A reset is generated if the CPU tries to fetch instructions from within peripheral space or vacant memory space.

(Non)maskable: the individual interrupt enable bit can disable an interrupt event, but the general interrupt enable bit cannot disable it.

(3) Interrupt flags are in the module.

(4) Reserved interrupt vectors at addresses are not used in this device and can be used for regular program code if necessary. To maintain compatibility with other devices, TI recommends reserving these locations.

## 6.5 Memory Organization

Table 6-4 summarizes the memory map of all devices.

**Table 6-4. Memory Organization**

|                                                       |               | MSP430F5132,<br>MSP430F5131        | MSP430F5152,<br>MSP430F5151        | MSP430F5172,<br>MSP430F5171        |
|-------------------------------------------------------|---------------|------------------------------------|------------------------------------|------------------------------------|
| Memory<br>Main: interrupt vector<br>Main: code memory | Size          | 8KB                                | 16KB                               | 32KB                               |
|                                                       | Flash         | 00FFFFh–00FF80h<br>00FFFFh–00E000h | 00FFFFh–00FF80h<br>00FFFFh–00C000h | 00FFFFh–00FF80h<br>00FFFFh–008000h |
| RAM                                                   | Size          | 1KB                                | 2KB                                | 2KB                                |
|                                                       | Sector 0      | 001FFFh–001C00h                    | 0023FFh–001C00h                    | 0023FFh–001C00h                    |
| Information memory<br>(Flash)                         | Size          | 512 Byte                           | 512 Byte                           | 512 Byte                           |
|                                                       | Info A        | 128B<br>0019FFh–001980h            | 128B<br>0019FFh–001980h            | 128B<br>0019FFh–001980h            |
|                                                       | Info B        | 128B<br>00197Fh–001900h            | 128B<br>00197Fh–001900h            | 128B<br>00197Fh–001900h            |
|                                                       | Info C        | 128B<br>0018FFh–001880h            | 128B<br>0018FFh–001880h            | 128B<br>0018FFh–001880h            |
|                                                       | Info D        | 128B<br>00187Fh–001800h            | 128B<br>00187Fh–001800h            | 128B<br>00187Fh–001800h            |
| Bootloader (BSL)<br>memory                            | Size          | 2K                                 | 2KB                                | 2KB                                |
|                                                       | BSL 3         | 512B<br>0017FFh–001600h            | 512B<br>0017FFh–001600h            | 512B<br>0017FFh–001600h            |
|                                                       | BSL 2         | 512B<br>0015FFh–001400h            | 512B<br>0015FFh–001400h            | 512B<br>0015FFh–001400h            |
|                                                       | BSL 1         | 512B<br>0013FFh–001200h            | 512B<br>0013FFh–001200h            | 512B<br>0013FFh–001200h            |
|                                                       | BSL 0         | 512B<br>0011FFh–001000h            | 512B<br>0011FFh–001000h            | 512B<br>0011FFh–001000h            |
| Peripherals                                           | Size<br>Flash | 4KB<br>000FFFh–000000h             | 4KB<br>000FFFh–000000h             | 4KB<br>000FFFh–000000h             |

## 6.6 Bootloader (BSL)

The BSL lets users program the flash memory or RAM using a UART serial interface. Access to the device memory by the BSL is protected by user-defined password. A bootloader security key is provided to disable the BSL completely or to disable the erasure of the flash if an invalid password is supplied. For complete description of the features of the BSL and its implementation, see [MSP430 Programming With the Bootloader \(BSL\)](#). Table 6-5 lists the pins required for BSL access.

**Table 6-5. BSL Functions**

| BSL FUNCTION                                      | DESCRIPTION            |                         |                          |
|---------------------------------------------------|------------------------|-------------------------|--------------------------|
|                                                   | 40-PIN QFN RSB PACKAGE | 38-PIN TSSOP DA PACKAGE | 40-PIN DSBGA YFF PACKAGE |
| $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$ | Entry sequence signal  | Entry sequence signal   | Entry sequence signal    |
| TEST/SBWTK                                        | Entry sequence signal  | Entry sequence signal   | Entry sequence signal    |
| Data transmit                                     | P3.7 - 36              | P3.5 - 37               | P3.7 - B4                |
| Data receive                                      | P3.6 - 35              | P3.6 - 38               | P3.6 - A4                |
| VCC                                               | Power supply           | Power supply            | Power supply             |
| VSS                                               | Ground supply          | Ground supply           | Ground supply            |

## 6.7 Flash Memory

The flash memory can be programmed through the JTAG port, Spy-Bi-Wire (SBW), the BSL, or in system by the CPU. The CPU can perform single-byte, single-word, and long-word writes to the flash memory. Features of the flash memory include:

- Flash memory has n segments of main memory and four segments of information memory (A to D) of 128 bytes each. Each segment in main memory is 512 bytes in size.
- Segments 0 to n may be erased in one step, or each segment may be individually erased.
- Segments A to D can be erased individually, or as a group with segments 0 to n. Segments A to D are also called *information memory*.
- Segment A can be locked separately.

## 6.8 RAM

The RAM is made up of n sectors. Each sector can be completely powered down to save leakage; however, all data is lost. Features of the RAM include:

- RAM has n sectors. The size of a sector can be found in [Section 6.5](#).
- Each sector 0 to n can be completely disabled; however, data retention is lost.
- Each sector 0 to n automatically enters low-power retention mode when possible.

## 6.9 Peripherals

Peripherals are connected to the CPU through data, address, and control buses. The peripherals can be managed using all instructions. For complete module descriptions, see the [MSP430x5xx and MSP430x6xx Family User's Guide](#).

### 6.9.1 Digital I/O

Up to three 8-bit I/O ports are implemented. Port PJ contains seven individual I/O pins, common to all devices.

- All individual I/O bits are independently programmable.
- Any combination of input, output, and interrupt conditions is possible.
- Programmable pullup or pulldown on all ports.
- Programmable drive strength on all ports.
- All 8 bits of ports P1 and P2 support edge-selectable interrupt input.
- Read and write access to port-control registers is supported by all instructions.
- Ports can be accessed byte-wise. P1 and P2 can also be accessed word-wise (PA).
- The input and output voltage levels of the pins supplied by  $DV_{IO}$  (see [Table 4-1](#)) are defined by the voltage supplied by  $DV_{IO}$  (up to 5 V).

## 6.9.2 Port Mapping Controller

The port mapping controller allows the flexible and reconfigurable mapping of digital functions to Port P1, Port P2, and Port P3 (see [Table 6-6](#)).

**Table 6-6. Port Mapping Mnemonics and Functions**

| VALUE                    | PxMAPy MNEMONIC | INPUT PIN FUNCTION                                                                                                         | OUTPUT PIN FUNCTION          |
|--------------------------|-----------------|----------------------------------------------------------------------------------------------------------------------------|------------------------------|
| 0                        | PM_NONE         | None                                                                                                                       | DVSS                         |
| 1                        | PM_UCA0CLK      | USCI_A0 clock input/output (direction controlled by USCI)                                                                  |                              |
|                          | PM_UCB0STE      | USCI_B0 SPI slave transmit enable (direction controlled by USCI)                                                           |                              |
| 2                        | PM_UCA0TXD      | USCI_A0 UART TXD (Direction controlled by USCI – output)                                                                   |                              |
|                          | PM_UCA0SIMO     | USCI_A0 SPI slave in master out (direction controlled by USCI)                                                             |                              |
| 3                        | PM_UCB0SOMI     | USCI_B0 SPI slave out master in (direction controlled by USCI)                                                             |                              |
|                          | PM_UCB0SCL      | USCI_B0 I <sup>2</sup> C clock (open drain and direction controlled by USCI)                                               |                              |
| 4                        | PM_UCA0RXD      | USCI_A0 UART RXD (Direction controlled by USCI – input)                                                                    |                              |
|                          | PM_UCA0SOMI     | USCI_A0 SPI slave out master in (direction controlled by USCI)                                                             |                              |
| 5                        | PM_UCB0SIMO     | USCI_B0 SPI slave in master out (direction controlled by USCI)                                                             |                              |
|                          | PM_UCB0SDA      | USCI_B0 I <sup>2</sup> C data (open drain and direction controlled by USCI)                                                |                              |
| 6                        | PM_UCB0CLK      | USCI_B0 clock input/output (direction controlled by USCI)                                                                  |                              |
|                          | PM_UCA0STE      | USCI_A0 SPI slave transmit enable (direction controlled by USCI)                                                           |                              |
| 7                        | PM_TD0.0        | TD0 input capture channel 0                                                                                                | TD0 output compare channel 0 |
| 8                        | PM_TD0.1        | TD0 input capture channel 1                                                                                                | TD0 output compare channel 1 |
| 9                        | PM_TD0.2        | TD0 input capture channel 2                                                                                                | TD0 output compare channel 2 |
| 10                       | PM_TD1.0        | TD1 input capture channel 0                                                                                                | TD1 output compare channel 0 |
| 11                       | PM_TD1.1        | TD1 input capture channel 1                                                                                                | TD1 output compare channel 1 |
| 12                       | PM_TD1.2        | TD1 input capture channel 2                                                                                                | TD1 output compare channel 2 |
| 13                       | PM_CLR1TD0.0    | TD0 external clear input                                                                                                   | TD0 output compare channel 0 |
|                          | PM_FLT1_2TD0.0  | TD0 fault input channel 2                                                                                                  |                              |
| 14                       | PM_FLT1_0TD0.1  | TD0 fault input channel 0                                                                                                  | TD0 output compare channel 1 |
| 15                       | PM_FLT1_1TD0.2  | TD0 fault input channel 1                                                                                                  | TD0 output compare channel 2 |
| 16                       | PM_CLR2TD1.0    | TD1 external clear input (controlled by module input enable)                                                               | TD1 output compare channel 0 |
|                          | PM_FLT2_1TD1.0  | TD1 fault input channel 1 (controlled by module input enable)                                                              |                              |
| 17                       | PM_FLT2_2TD1.1  | TD1 fault input channel 2                                                                                                  | TD1 output compare channel 1 |
| 18                       | PM_FLT2_0TD1.2  | TD1 fault input channel 0                                                                                                  | TD1 output compare channel 2 |
| 19                       | PM_TD0.0SMCLK   | TD0 input capture channel 0                                                                                                | SMCLK output                 |
| 20                       | PM_TA0CLKCBOUT  | TA0 input clock                                                                                                            | Comparator_B output          |
| 21                       | PM_TD0CLKMCLK   | TD0 input clock                                                                                                            | MCLK output                  |
| 22                       | PM_TA0_0        | TA0 input capture channel 0                                                                                                | TA0 output compare channel 0 |
| 23                       | PM_TA0_1        | TA0 input capture channel 1                                                                                                | TA0 output compare channel 1 |
| 24                       | PM_TA0_2        | TA0 input capture channel 2                                                                                                | TA0 output compare channel 2 |
| 25                       | PM_DMAE0SMCLK   | DMAE0 input                                                                                                                | SMCLK output                 |
| 26                       | PM_DMAE1MCLK    | DMAE1 input                                                                                                                | MCLK output                  |
| 27                       | PM_DMAE2SVM     | DMAE2 input                                                                                                                | SVM output                   |
| 28                       | PM_TD0OUTH      | TD0 3-state input                                                                                                          | ADC10CLK                     |
| 29                       | PM_TD1OUTH      | TD1 3-state input                                                                                                          | ACLK                         |
| 30                       | Reserved        | None                                                                                                                       | DVSS                         |
| 31 (0FFh) <sup>(1)</sup> | PM_ANALOG       | Disables the output driver and the input Schmitt-trigger to prevent parasitic cross currents when applying analog signals. |                              |

(1) The value of the PM\_ANALOG mnemonic is set to 0FFh. The port mapping registers are only 5 bits wide, and the upper bits are ignored, which results in a read out value of 31.

Table 6-7 lists the default assignments for all pins that support port mapping.

**Table 6-7. Default Mapping**

| PIN                                      | PxMAPy MNEMONIC                | INPUT PIN FUNCTION                                                                                                                  | OUTPUT PIN FUNCTION                                                             |
|------------------------------------------|--------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------|
| P1.0/PM_UCA0CLK/<br>PM_UCB0STE/A0/CB0    | PM_UCA0CLK<br>PM_UCB0STE       | USCI_A0 clock input/output<br>(direction controlled by USCI)                                                                        | USCI_B0 SPI slave transmit enable<br>(direction controlled by USCI)             |
| P1.1/PM_UCA0TXD/<br>PM_UCA0SIMO/A1/CB1   | PM_UCA0TXD<br>PM_UCA0SIMO      | USCI_A0 UART TXD (Direction<br>controlled by USCI – output)                                                                         | USCI_A0 SPI slave in master out<br>(direction controlled by USCI)               |
| P1.2/PM_UCA0RXD/<br>PM_UCA0SOMI/A2/CB2   | PM_UCA0RXD<br>PM_UCA0SOMI      | USCI_A0 UART RXD (Direction<br>controlled by USCI – input)                                                                          | USCI_A0 SPI slave out master in<br>(direction controlled by USCI)               |
| P1.3/PM_UCB0CLK/<br>PM_UCA0STE/A3/CB3    | PM_UCB0CLK<br>PM_UCA0STE       | USCI_B0 clock input/output<br>(direction controlled by USCI)                                                                        | USCI_A0 SPI slave transmit enable<br>(direction controlled by USCI)             |
| P1.4/PM_UCB0SIMO/<br>PM_UCB0SDA/A4/CB4   | PM_UCB0SIMO<br>PM_UCB0SDA      | USCI_B0 SPI slave in master out<br>(direction controlled by USCI)                                                                   | USCI_B0 I <sup>2</sup> C data (open drain and<br>direction controlled by USCI)  |
| P1.5/PM_UCB0SOMI/<br>PM_UCB0SCL/A5/CB5   | PM_UCB0SOMI<br>PM_UCB0SCL      | USCI_B0 SPI slave out master in<br>(direction controlled by USCI)                                                                   | USCI_B0 I <sup>2</sup> C clock (open drain and<br>direction controlled by USCI) |
| P1.6/PM_TD0.0                            | PM_TD0.0                       | TD0 input capture channel 0                                                                                                         | TD0 output compare channel 0                                                    |
| P1.7/PM_TD0.1                            | PM_TD0.1                       | TD0 input capture channel 1                                                                                                         | TD0 output compare channel 1                                                    |
| P2.0/PM_TD0.2                            | PM_TD0.2                       | TD0 input capture channel 2                                                                                                         | TD0 output compare channel 2                                                    |
| P2.1/PM_TD1.0                            | PM_TD1.0                       | TD1 input capture channel 0                                                                                                         | TD1 output compare channel 0                                                    |
| P2.2/PM_TD1.1                            | PM_TD1.1                       | TD1 input capture channel 1                                                                                                         | TD1 output compare channel 1                                                    |
| P2.3/PM_TD1.2                            | PM_TD1.2                       | TD1 input capture channel 2                                                                                                         | TD1 output compare channel 2                                                    |
| P2.4/PM_TEC0CLR/<br>PM_TEC0FLT2/PM_TD0.0 | PM_CLR1TD0.0<br>PM_FLT1_2TD0.0 | TD0 external clear input (controlled<br>by module input enable)<br>TD0 fault input channel 2<br>(controlled by module input enable) | TD0 output compare channel 0                                                    |
| P2.5/PM_TEC0FLT0/PM_TD0.1                | PM_FLT1_0TD0.1                 | TD0 fault input channel 0                                                                                                           | TD0 output compare channel 1                                                    |
| P2.6/PM_TEC0FLT1/PM_TD0.2                | PM_FLT1_1TD0.2                 | TD0 fault input channel 1                                                                                                           | TD0 output compare channel 2                                                    |
| P2.7/PM_TEC1CLR/<br>PM_TEC1FLT1/PM_TD1.0 | PM_CLR2TD1.0<br>PM_FLT2_1TD1.0 | TD1 external clear input (controlled<br>by module input enable)<br>TD1 fault input channel 1<br>(controlled by module input enable) | TD1 output compare channel 0                                                    |
| P3.0/PM_TEC1FLT2/<br>PM_TD1.1            | PM_FLT2_2TD1.1                 | TD1 fault input channel 2                                                                                                           | TD1 output compare channel 1                                                    |
| P3.1/PM_TEC1FLT0/<br>PM_TD1.2            | PM_FLT2_0TD1.2                 | TD1 fault input channel 0                                                                                                           | TD1 output compare channel 2                                                    |
| P3.2/PM_TD0.0/<br>PM_SMCLK/CB14          | PM_TD0.0SMCLK                  | TD0 input capture channel 0                                                                                                         | SMCLK output                                                                    |
| P3.3/PM_TA0CLK/<br>PM_CBOUT/CB13         | PM_TA0CLKCBOUT                 | TA0 input clock                                                                                                                     | Comparator_B output                                                             |
| P3.4/PM_TD0CLK/<br>PM_MCLK               | PM_TD0CLKMCLK                  | TD0 input clock                                                                                                                     | MCLK output                                                                     |
| P3.5/PM_TA0.2/<br>VEREF+/CB12            | PM_TA3_2                       | TA0 input capture channel 0                                                                                                         | TA0 output compare channel 0                                                    |
| P3.6/PM_TA0.1/A7<br>VEREF-/CB11          | PM_TA3_1                       | TA0 input capture channel 1                                                                                                         | TA0 output compare channel 1                                                    |
| P3.7/PM_TA0.0/<br>A6/CB10                | PM_TA3_0                       | TA0 input capture channel 2                                                                                                         | TA0 output compare channel 2                                                    |

### 6.9.3 Oscillator and System Clock

The clock system (Unified Clock System [UCS]) module includes support for a 32-kHz watch crystal oscillator and high-frequency crystal oscillator, an internal very-low-power low-frequency oscillator (VLO), an internal trimmed low-frequency oscillator (REFO), and an integrated internal digitally controlled oscillator (DCO). The UCS module is designed to meet the requirements of both low system cost and low power consumption. The UCS module features digital frequency locked loop (FLL) hardware that, in conjunction with a digital modulator, stabilizes the DCO frequency to a programmable multiple of the watch crystal frequency. The internal DCO provides a fast turnon clock source and stabilizes in less than 5  $\mu$ s. The UCS module provides the following clock signals:

- Auxiliary clock (ACLK), sourced from a 32-kHz watch crystal or high-frequency crystal (XT1), the internal low-frequency oscillator (VLO), the trimmed low-frequency oscillator (REFO), or the internal digitally-controlled oscillator DCO.
- Main clock (MCLK), the system clock used by the CPU. MCLK can be sourced by same sources available to ACLK.
- Sub-Main clock (SMCLK), the subsystem clock used by the peripheral modules. SMCLK can be sourced by same sources available to ACLK.
- ACLK/n, the buffered output of ACLK, ACLK/2, ACLK/4, ACLK/8, ACLK/16, ACLK/32.

### 6.9.4 Power-Management Module (PMM)

The PMM includes an integrated voltage regulator that supplies the core voltage to the device and contains programmable output levels to provide for power optimization. The PMM also includes supply voltage supervisor (SVS) and supply voltage monitoring (SVM) circuitry, and brownout protection. The brownout circuit provides the proper internal reset signal to the device during power on and power off. The SVS and SVM circuitry detects if the supply voltage drops below a user-selectable level and supports both supply voltage supervision (the device is automatically reset) and supply voltage monitoring (the device is not automatically reset). SVS and SVM circuitry is available on the primary supply and core supply.

### 6.9.5 Hardware Multiplier

The multiplication operation is supported by a dedicated peripheral module. The module performs operations with 32-, 24-, 16-, and 8-bit operands. The module supports signed and unsigned multiplication as well as signed and unsigned multiply and accumulate operations.

### 6.9.6 Watchdog Timer (WDT\_A)

The primary function of the watchdog timer (WDT\_A) module is to perform a controlled system restart after a software problem occurs. If the selected time interval expires, a system reset is generated. If the watchdog function is not needed in an application, the module can be configured as an interval timer and can generate interrupts at selected time intervals.

### 6.9.7 System Module (SYS)

The SYS module handles many of the system functions within the device. These include power-on reset and power-up clear handling, NMI source selection and management, reset interrupt vector generators, bootloader entry mechanisms, and configuration management (device descriptors) (see [Table 6-8](#)). It also includes a data exchange mechanism using JTAG that is called a JTAG mailbox and that can be used in the application.

**Table 6-8. System Module Interrupt Vector Registers**

| INTERRUPT VECTOR REGISTER | INTERRUPT EVENT                | WORD ADDRESS | OFFSET     | PRIORITY |
|---------------------------|--------------------------------|--------------|------------|----------|
| SYSRSTIV, System Reset    | No interrupt pending           | 019Eh        | 00h        | Highest  |
|                           | Brownout (BOR)                 |              | 02h        |          |
|                           | RST/NMI (POR)                  |              | 04h        |          |
|                           | PMMSWBOR (BOR)                 |              | 06h        |          |
|                           | LPM5 wake-up (BOR)             |              | 08h        |          |
|                           | Security violation (BOR)       |              | 0Ah        |          |
|                           | SVSL (POR)                     |              | 0Ch        |          |
|                           | SVSH (POR)                     |              | 0Eh        |          |
|                           | SVML_OVP (POR)                 |              | 10h        |          |
|                           | SVMH_OVP (POR)                 |              | 12h        |          |
|                           | PMMSWPOR (POR)                 |              | 14h        |          |
|                           | WDT time-out (PUC)             |              | 16h        |          |
|                           | WDT key violation (PUC)        |              | 18h        |          |
|                           | KEYV flash key violation (PUC) |              | 1Ah        |          |
|                           | Reserved                       |              | 1Ch        |          |
|                           | Peripheral area fetch (PUC)    |              | 1Eh        |          |
|                           | PMM key violation (PUC)        |              | 20h        |          |
|                           | Reserved                       |              | 22h to 3Eh | Lowest   |
| SYSSNIV, System NMI       | No interrupt pending           | 019Ch        | 00h        | Highest  |
|                           | SVMLIFG                        |              | 02h        |          |
|                           | SVMHIFG                        |              | 04h        |          |
|                           | DLYLIFG                        |              | 06h        |          |
|                           | DLYHIFG                        |              | 08h        |          |
|                           | VMAIFG                         |              | 0Ah        |          |
|                           | JMBINIFG                       |              | 0Ch        |          |
|                           | JMBOUTIFG                      |              | 0Eh        |          |
|                           | VLRIFG                         |              | 10h        |          |
|                           | VLRHIFG                        |              | 12h        |          |
|                           | Reserved                       |              | 14h to 1Eh | Lowest   |
| SYSUNIV, User NMI         | No interrupt pending           | 019Ah        | 00h        | Highest  |
|                           | NMIIFG                         |              | 02h        |          |
|                           | OFIFG                          |              | 04h        |          |
|                           | ACCVIFG                        |              | 06h        |          |
|                           | Reserved                       |              | 08h to 1Eh | Lowest   |

### 6.9.8 DMA Controller

The DMA controller allows movement of data from one memory address to another without CPU intervention. For example, the DMA controller can be used to move data from the ADC10\_A conversion memory to RAM. Using the DMA controller can increase the throughput of peripheral modules. The DMA controller reduces system power consumption by allowing the CPU to remain in sleep mode, without having to wake to move data to or from a peripheral. [Table 6-9](#) lists the triggers that can be assigned to start a DMA transfer.

**Table 6-9. DMA Trigger Assignments<sup>(1)</sup>**

| TRIGGER | CHANNEL       |               |               |
|---------|---------------|---------------|---------------|
|         | 0             | 1             | 2             |
| 0       | DMAREQ        | DMAREQ        | DMAREQ        |
| 1       | TA0CCR0 CCIFG | TA0CCR0 CCIFG | TA0CCR0 CCIFG |
| 2       | TA0CCR2 CCIFG | TA0CCR2 CCIFG | TA0CCR2 CCIFG |
| 3       | TD0CCR0 CCIFG | TD0CCR0 CCIFG | TD0CCR0 CCIFG |
| 4       | TD0CCR2 CCIFG | TD0CCR2 CCIFG | TD0CCR2 CCIFG |
| 5       | TD1CCR0 CCIFG | TD1CCR0 CCIFG | TD1CCR0 CCIFG |
| 6       | TD1CCR2 CCIFG | TD1CCR2 CCIFG | TD1CCR2 CCIFG |
| 7       | Reserved      | Reserved      | Reserved      |
| 8       | Reserved      | Reserved      | Reserved      |
| 9       | Reserved      | Reserved      | Reserved      |
| 10      | Reserved      | Reserved      | Reserved      |
| 11      | Reserved      | Reserved      | Reserved      |
| 12      | Reserved      | Reserved      | Reserved      |
| 13      | Reserved      | Reserved      | Reserved      |
| 14      | Reserved      | Reserved      | Reserved      |
| 15      | Reserved      | Reserved      | Reserved      |
| 16      | UCA0RXIFG     | UCA0RXIFG     | UCA0RXIFG     |
| 17      | UCA0TXIFG     | UCA0TXIFG     | UCA0TXIFG     |
| 18      | UCB0RXIFG     | UCB0RXIFG     | UCB0RXIFG     |
| 19      | UCB0TXIFG     | UCB0TXIFG     | UCB0TXIFG     |
| 20      | Reserved      | Reserved      | Reserved      |
| 21      | Reserved      | Reserved      | Reserved      |
| 22      | Reserved      | Reserved      | Reserved      |
| 23      | Reserved      | Reserved      | Reserved      |
| 24      | ADC10IFG0     | ADC10IFG0     | ADC10IFG0     |
| 25      | Reserved      | Reserved      | Reserved      |
| 26      | Reserved      | Reserved      | Reserved      |
| 27      | Reserved      | Reserved      | Reserved      |
| 28      | Reserved      | Reserved      | Reserved      |
| 29      | MPY ready     | MPY ready     | MPY ready     |
| 30      | DMA2IFG       | DMA0IFG       | DMA1IFG       |
| 31      | DMAE0         | DMAE0         | DMAE0         |

(1) Reserved DMA triggers may be used by other devices in the family. Reserved DMA triggers do not cause any DMA trigger event when selected.

## 6.9.9 Universal Serial Communication Interface (USCI)

The USCI modules are used for serial data communication. The USCI module supports synchronous communication protocols such as SPI (3- or 4-pin) and I<sup>2</sup>C, and asynchronous communication protocols such as UART, enhanced UART with automatic baudrate detection, and IrDA. Each USCI module contains two modules, A and B.

The USCI\_Ax module provides support for SPI (3- or 4-pin), UART, enhanced UART, or IrDA.

The USCI\_Bx module provides support for SPI (3- or 4-pin) or I<sup>2</sup>C.

### 6.9.10 TA0

TA0 is a 16-bit timer/counter with three capture/compare registers. TA0 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-10](#)). TA0 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-10. TA0 Signal Connections**

| INPUT PIN NUMBER       |                         |                          | DEVICE<br>INPUT<br>SIGNAL | MODULE<br>INPUT<br>SIGNAL | MODULE<br>BLOCK | MODULE<br>OUTPUT<br>SIGNAL | DEVICE<br>OUTPUT<br>SIGNAL | OUTPUT PIN NUMBER                                            |                                                              |                                                              |
|------------------------|-------------------------|--------------------------|---------------------------|---------------------------|-----------------|----------------------------|----------------------------|--------------------------------------------------------------|--------------------------------------------------------------|--------------------------------------------------------------|
| RSB<br>(40-PIN<br>QFN) | DA<br>(38-PIN<br>TSSOP) | YFF<br>(40-PIN<br>DSBGA) |                           |                           |                 |                            |                            | RSB<br>(40-PIN<br>QFN)                                       | DA<br>(38-PIN<br>TSSOP)                                      | YFF<br>(40-PIN<br>DSBGA)                                     |
| P3.3 - 30              | P3.3 - 34               | P3.3 - G6                | TA0CLK                    | TACLK                     | Timer           | NA                         | NA                         | –                                                            | –                                                            | –                                                            |
| ACLK<br>(internal)     | ACLK                    | ACLK                     | ACLK                      | ACLK                      |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| SMCLK<br>(internal)    | SMCLK                   | SMCLK                    | SMCLK                     | SMCLK                     |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| P3.3 - 30              | P3.3 - 34               | P3.3 - G6                | TA0CLK                    | <u>TACLK</u>              |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| P3.7 - 36              | –                       | P3.7 - G4                | TA0.0                     | CCI0A                     | CCR0            | TA0                        | TA0.0                      | P3.7 - 36                                                    | –                                                            | P3.7 - G4                                                    |
| –                      | –                       | –                        | CBOU                      | CCI0B                     |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| –                      | –                       | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| –                      | –                       | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| P3.6 - 35              | –                       | P3.6 - G3                | TA0.1                     | CCI1A                     | CCR1            | TA1                        | TA0.1                      | P3.6 - 35                                                    | P3.6 - 38                                                    | P3.6 - G3                                                    |
| –                      | –                       | –                        | ACLK                      | CCI1B                     |                 |                            |                            | ADC10_A <sup>(1)</sup><br>(internal)<br>ADC10SHS<br>x = 001b | ADC10_A <sup>(1)</sup><br>(internal)<br>ADC10SHS<br>x = 001b | ADC10_A <sup>(1)</sup><br>(internal)<br>ADC10SHS<br>x = 001b |
| –                      | –                       | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| –                      | –                       | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| P3.5 - 34              | P3.5 - 37               | P3.5 - F3                | TA0.2                     | CCI2A                     | CCR2            | TA2                        | TA0.2                      | P3.5 - 34                                                    | P3.5 - 37                                                    | P3.5 - F3                                                    |
| –                      | –                       | –                        | V <sub>SS</sub>           | CCI2B                     |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| –                      | –                       | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                                                            | –                                                            | –                                                            |
| –                      | –                       | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                                                            | –                                                            | –                                                            |

(1) The ADC10\_A trigger is available on MSP430F51x2 devices.

## 6.9.11 TD0

TD0 is a 16-bit timer/counter with three capture/compare registers supporting up to 256-MHz (4-ns) resolution. TD0 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-11](#)). TD0 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers. External fault inputs as well as a external timer counter clear is supported along with interrupt flags from the TEC0 module.

**Table 6-11. TD0 Signal Connections**

| INPUT PIN NUMBER         |                          |                          | DEVICE<br>INPUT<br>SIGNAL | MODULE<br>INPUT<br>SIGNAL | MODULE<br>BLOCK | MODULE<br>OUTPUT<br>SIGNAL | DEVICE<br>OUTPUT<br>SIGNAL | OUTPUT PIN NUMBER                                            |                                                              |                                                              |
|--------------------------|--------------------------|--------------------------|---------------------------|---------------------------|-----------------|----------------------------|----------------------------|--------------------------------------------------------------|--------------------------------------------------------------|--------------------------------------------------------------|
| RSB<br>(40-PIN<br>QFN)   | DA<br>(38-PIN<br>TSSOP)  | YFF<br>(40-PIN<br>DSBGA) |                           |                           |                 |                            |                            | RSB<br>(40-PIN<br>QFN)                                       | DA<br>(38-PIN<br>TSSOP)                                      | YFF<br>(40-PIN<br>DSBGA)                                     |
| P3.4 - 31                | —                        | P3.4 - G5                | TD0CLK                    | TDCLK                     | Timer           | NA                         | NA                         | —                                                            | —                                                            | —                                                            |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK                      | ACLK                      |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| SMCLK<br>(internal)      | SMCLK<br>(internal)      | SMCLK<br>(internal)      | SMCLK                     | SMCLK                     |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P3.4 - 31                | —                        | P3.4 - G5                | TD0CLK                    | TDCLK                     |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| —                        | —                        | —                        | —                         | CLK0                      |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.4 - 19                | P2.4 - 23                | P2.4 - B4                | TEC0CLR                   | TECXCLR                   |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P1.6 - 11 <sup>(1)</sup> | P1.6 - 15 <sup>(1)</sup> | P1.6 - A1 <sup>(1)</sup> | TD0.0                     | CCI0A                     | CCR0            | TD0                        | TD0                        | P1.6 - 11 <sup>(1)</sup>                                     | P1.6 - 15 <sup>(1)</sup>                                     | P1.6 - A1 <sup>(1)</sup>                                     |
| P3.2 - 29                | P3.2 - 33                | P3.2 - F5                | TD0.0                     | CCI0B                     |                 |                            |                            | P2.4 - 19                                                    | P2.4 - 23                                                    | P2.4 - B4                                                    |
| —                        | —                        | —                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 010b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 010b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 010b <sup>(2)</sup> |
| —                        | —                        | —                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.5 - 20                | P2.5 - 24                | P2.5 - A6                | TEC0FLT0                  | TECXFLT0                  |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P1.7 - 12 <sup>(1)</sup> | P1.7 - 16 <sup>(1)</sup> | P1.7 - B2 <sup>(1)</sup> | TD0.1                     | CCI1A                     | CCR1            | TD1                        | TD1                        | P1.7 - 12 <sup>(1)</sup>                                     | P1.7 - 16 <sup>(1)</sup>                                     | P1.7 - B2 <sup>(1)</sup>                                     |
| CBOU<br>(internal)       | CBOU<br>(internal)       | CBOU<br>(internal)       | TD0.1                     | CCI1B                     |                 |                            |                            | PJ.6 - 28                                                    | PJ.6 - 32                                                    | PJ.6 - E5                                                    |
| —                        | —                        | —                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | P2.5 - 20                                                    | P2.5 - 24                                                    | P2.5 - A6                                                    |
| —                        | —                        | —                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 011b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 011b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 011b <sup>(2)</sup> |
| P2.6 - 21                | P2.6 - 20                | P2.6 - B5                | TEC0FLT1                  | TECXFLT1                  |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.0 - 13 <sup>(1)</sup> | P2.0 - 17 <sup>(1)</sup> | P2.0 - B3 <sup>(1)</sup> | TD0.2                     | CCI2A                     | CCR2            | TD2                        | TD2                        | P2.0 - 13 <sup>(1)</sup>                                     | P2.0 - 17 <sup>(1)</sup>                                     | P2.0 - B3 <sup>(1)</sup>                                     |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | TD0.2                     | CCI2B                     |                 |                            |                            | P2.6 - 21                                                    | P2.6 - 25                                                    | P2.6 - B5                                                    |
| —                        | —                        | —                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| —                        | —                        | —                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.4 - 19                | P2.4 - 23                | P2.4 - B4                | TEC0FLT2                  | TECXFLT2                  |                 |                            |                            | —                                                            | —                                                            | —                                                            |

(1) Pins P1.6 for TD0.0, P1.7 for TD0.1, and P2.0 for TD0.2 are optimized for matching.

(2) The ADC10\_A trigger is available on MSP430F51x2 devices.

## 6.9.12 TD1

TD1 is a 16-bit timer/counter with three capture/compare registers supporting up to 256-MHz (4-ns) resolution. TD1 can support multiple capture/compares, PWM outputs, and interval timing (see [Table 6-12](#)). TD1 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers. External fault inputs as well as a external timer counter clear is supported along with interrupt flags from the TEC0 module.

**Table 6-12. TD1 Signal Connections**

| INPUT PIN NUMBER         |                          |                          | DEVICE<br>INPUT<br>SIGNAL | MODULE<br>INPUT<br>SIGNAL | MODULE<br>BLOCK | MODULE<br>OUTPUT<br>SIGNAL | DEVICE<br>OUTPUT<br>SIGNAL | OUTPUT PIN NUMBER        |                          |                          |
|--------------------------|--------------------------|--------------------------|---------------------------|---------------------------|-----------------|----------------------------|----------------------------|--------------------------|--------------------------|--------------------------|
| RSB<br>(40-PIN<br>QFN)   | DA<br>(38-PIN<br>TSSOP)  | YFF<br>(40-PIN<br>DSBGA) |                           |                           |                 |                            |                            | RSB<br>(40-PIN<br>QFN)   | DA<br>(38-PIN<br>TSSOP)  | YFF<br>(40-PIN<br>DSBGA) |
| PJ.6 - 28                | PJ.6 - 32                | PJ.6 - E5                | TD1CLK                    | TDCLK                     | Timer           | NA                         | NA                         | –                        | –                        | –                        |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK                      | ACLK                      |                 |                            |                            | –                        | –                        | –                        |
| SMCLK(inte<br>rnal)      | SMCLK                    | SMCLK                    | SMCLK                     | SMCLK                     |                 |                            |                            | –                        | –                        | –                        |
| PJ.6 - 28                | PJ.6 - 32                | PJ.6 - E5                | TD1CLK                    | TDCLK                     |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | from TD0<br>(internal)    | CLK0                      |                 |                            |                            | –                        | –                        | –                        |
| P2.7 - 22                | P2.7 - 26                | P2.7 - C5                | TEC1CLR                   | TECxCLR                   | CCR0            | TD0                        | TD0                        | –                        | –                        | –                        |
| P2.1 - 14 <sup>(1)</sup> | P2.1 - 18 <sup>(1)</sup> | P2.1 - A2                | TD1.0                     | CCI0A                     |                 |                            |                            | P2.1 - 14 <sup>(1)</sup> | P2.1 - 18 <sup>(1)</sup> | P2.1 - A2 <sup>(1)</sup> |
| –                        | –                        | –                        | TD1.0                     | CCI0B                     |                 |                            |                            | P2.7 - 22                | P2.7 - 26                | P2.7 - C5                |
| –                        | –                        | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                        | –                        | –                        |
| P3.1 - 24                | P3.1 - 28                | P3.1 - C6                | TEC1FLT0                  | TECXFLT0                  | CCR1            | TD1                        | TD1                        | –                        | –                        | –                        |
| P2.2 - 15 <sup>(1)</sup> | P2.2 - 19 <sup>(1)</sup> | P2.2 - A3                | TD1.1                     | CCI1A                     |                 |                            |                            | P2.2 - 15 <sup>(1)</sup> | P2.2 - 19 <sup>(1)</sup> | P2.2 - A3 <sup>(1)</sup> |
| CBOUT<br>(internal)      | CBOUT<br>(internal)      | CBOUT<br>(internal)      | TD1.1                     | CCI1B                     |                 |                            |                            | P3.0 - 23                | P3.0 - 27                | P3.0 - B6                |
| –                        | –                        | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                        | –                        | –                        |
| P2.7 - 22                | P2.7 - 26                | P2.7 - C5                | TEC1FLT1                  | TECXFLT1                  | CCR2            | TD2                        | TD2                        | –                        | –                        | –                        |
| P2.3 - 16 <sup>(1)</sup> | P2.3 - 20 <sup>(1)</sup> | P2.3 - C4                | TD1.2                     | CCI2A                     |                 |                            |                            | P2.3 - 16 <sup>(1)</sup> | P2.3 - 20 <sup>(1)</sup> | P2.3 - C4 <sup>(1)</sup> |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | TD1.2                     | CCI2B                     |                 |                            |                            | P3.1 - 24                | P3.1 - 28                | P3.1 - C6                |
| –                        | –                        | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                        | –                        | –                        |
| P3.0 - 23                | P3.0 - 27                | P3.0 - B6                | TEC1FLT2                  | TECXFLT2                  |                 |                            |                            | –                        | –                        | –                        |

(1) Pins P2.1 for TD1.0, P2.2 for TD1.1, and P2.3 for TD1.2 are optimized for matching.

### 6.9.13 *Comparator\_B*

The primary function of the Comparator\_B module is to support precision slope analog-to-digital conversions, battery voltage supervision, and monitoring of external analog signals.

### 6.9.14 *ADC10\_A (MSP430F51x2 Only)*

The ADC10\_A module supports fast 10-bit analog-to-digital conversions. The module implements a 10-bit SAR core, sample select control, reference generator, and a conversion result buffer. A window comparator with lower and upper limits allows CPU-independent result monitoring with three window comparator interrupt flags.

### 6.9.15 *CRC16*

The CRC16 module produces a signature based on a sequence of entered data values and can be used for data checking purposes. The CRC16 module signature is based on the CRC-CCITT standard.

### 6.9.16 *Reference (REF) Module Voltage Reference*

The REF is responsible for generation of all critical reference voltages that can be used by the various analog peripherals in the device.

### 6.9.17 *Embedded Emulation Module (EEM) (S Version)*

The EEM supports real-time in-system debugging. The S version of the EEM has the following features:

- Three hardware triggers or breakpoints on memory access
- One hardware trigger or breakpoint on CPU register write access
- Up to four hardware triggers can be combined to form complex triggers or breakpoints
- One cycle counter
- Clock control on module level

### 6.9.18 Peripheral File Map

Table 6-13 lists the base address and offset range for the registers of all peripherals.

**Table 6-13. Peripherals**

| MODULE NAME                                    | BASE ADDRESS | OFFSET ADDRESS RANGE |
|------------------------------------------------|--------------|----------------------|
| Special Functions (see Table 6-14)             | 0100h        | 000h–01Fh            |
| PMM (see Table 6-15)                           | 0120h        | 000h–010h            |
| Flash Control (see Table 6-16)                 | 0140h        | 000h–00Fh            |
| CRC16 (see Table 6-17)                         | 0150h        | 000h–007h            |
| RAM Control (see Table 6-18)                   | 0158h        | 000h–001h            |
| Watchdog (see Table 6-19)                      | 015Ch        | 000h–001h            |
| UCS (see Table 6-20)                           | 0160h        | 000h–01Fh            |
| SYS (see Table 6-21)                           | 0180h        | 000h–01Fh            |
| Shared Reference (see Table 6-22)              | 01B0h        | 000h–001h            |
| Port Mapping Control (see Table 6-23)          | 01C0h        | 000h–007h            |
| Port Mapping Port P1 (see Table 6-24)          | 01C8h        | 000h–007h            |
| Port Mapping Port P2 (see Table 6-25)          | 01D0h        | 000h–007h            |
| Port Mapping Port P3 (see Table 6-26)          | 01D8h        | 000h–007h            |
| Port P1, P2 (see Table 6-27)                   | 0200h        | 000h–01Fh            |
| Port P3 (see Table 6-28)                       | 0220h        | 000h–01Fh            |
| Port PJ (see Table 6-29)                       | 0320h        | 000h–01Fh            |
| TA0 (see Table 6-30)                           | 03C0h        | 000h–03Fh            |
| 32-Bit Hardware Multiplier (see Table 6-31)    | 04C0h        | 000h–02Fh            |
| DMA General Control (see Table 6-32)           | 0500h        | 000h–00Fh            |
| DMA Channel 0 (see Table 6-33)                 | 0500h        | 010h–00Ah            |
| DMA Channel 1 (see Table 6-34)                 | 0500h        | 020h–00Ah            |
| DMA Channel 2 (see Table 6-35)                 | 0500h        | 030h–00Ah            |
| USCI_A0 (see Table 6-36)                       | 05C0h        | 000h–01Fh            |
| USCI_B0 (see Table 6-36)                       | 05E0h        | 000h–01Fh            |
| ADC10_A (see Table 6-38)<br>(MSP430F51x2 only) | 0740h        | 000h–01Fh            |
| Comparator_B (see Table 6-39)                  | 08C0h        | 000h–00Fh            |
| TD0 (see Table 6-40)                           | 0B00h        | 000h–03Fh            |
| TEC0 (see Table 6-42)                          | 0C00h        | 000h–007h            |
| TD1 (see Table 6-41)                           | 0B40h        | 000h–03Fh            |
| TEC1 (see Table 6-43)                          | 0C20h        | 000h–007h            |

**Table 6-14. Special Function Registers (Base Address: 0100h)**

| REGISTER DESCRIPTION  | REGISTER | OFFSET |
|-----------------------|----------|--------|
| SFR interrupt enable  | SFRIE1   | 00h    |
| SFR interrupt flag    | SFRIFG1  | 02h    |
| SFR reset pin control | SFRRPCR  | 04h    |

**Table 6-15. PMM Registers (Base Address: 0120h)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| PMM control 0            | PMMCTL0  | 00h    |
| PMM control 1            | PMMCTL1  | 02h    |
| SVS high-side control    | SVSMHCTL | 04h    |
| SVS low-side control     | SVSMLCTL | 06h    |
| PMM interrupt flags      | PMMIFG   | 0Ch    |
| PMM interrupt enable     | PMMIE    | 0Eh    |
| PMM power mode 5 control | PM5CTL0  | 10h    |

**Table 6-16. Flash Control Registers (Base Address: 0140h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Flash control 1      | FCTL1    | 00h    |
| Flash control 3      | FCTL3    | 04h    |
| Flash control 4      | FCTL4    | 06h    |

**Table 6-17. CRC16 Registers (Base Address: 0150h)**

| REGISTER DESCRIPTION | REGISTER   | OFFSET |
|----------------------|------------|--------|
| CRC data input       | CRC16DI    | 00h    |
| CRC result           | CRC16INRES | 04h    |

**Table 6-18. RAM Control Registers (Base Address: 0158h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| RAM control 0        | RCCTL0   | 00h    |

**Table 6-19. Watchdog Registers (Base Address: 015Ch)**

| REGISTER DESCRIPTION   | REGISTER | OFFSET |
|------------------------|----------|--------|
| Watchdog timer control | WDTCTL   | 00h    |

**Table 6-20. UCS Registers (Base Address: 0160h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| UCS control 0        | UCSCTL0  | 00h    |
| UCS control 1        | UCSCTL1  | 02h    |
| UCS control 2        | UCSCTL2  | 04h    |
| UCS control 3        | UCSCTL3  | 06h    |
| UCS control 4        | UCSCTL4  | 08h    |
| UCS control 5        | UCSCTL5  | 0Ah    |
| UCS control 6        | UCSCTL6  | 0Ch    |
| UCS control 7        | UCSCTL7  | 0Eh    |
| UCS control 8        | UCSCTL8  | 10h    |

**Table 6-21. SYS Registers (Base Address: 0180h)**

| REGISTER DESCRIPTION          | REGISTER  | OFFSET |
|-------------------------------|-----------|--------|
| System control                | SYSCTL    | 00h    |
| Bootloader configuration area | SYSBSLC   | 02h    |
| JTAG mailbox control          | SYSJMBC   | 06h    |
| JTAG mailbox input 0          | SYSJMBI0  | 08h    |
| JTAG mailbox input 1          | SYSJMBI1  | 0Ah    |
| JTAG mailbox output 0         | SYSJMBO0  | 0Ch    |
| JTAG mailbox output 1         | SYSJMBO1  | 0Eh    |
| Bus error vector generator    | SYSBERRIV | 18h    |
| User NMI vector generator     | SYSUNIV   | 1Ah    |
| System NMI vector generator   | SYSSNIV   | 1Ch    |
| Reset vector generator        | SYSRSTIV  | 1Eh    |

**Table 6-22. Shared Reference Registers (Base Address: 01B0h)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| Shared reference control | REFCTL   | 00h    |

**Table 6-23. Port Mapping Control (Base Address: 01C0h)**

| REGISTER DESCRIPTION  | REGISTER | OFFSET |
|-----------------------|----------|--------|
| Port mapping password | PMAPPWD  | 00h    |
| Port mapping control  | PMAPCTL  | 02h    |

**Table 6-24. Port Mapping for Port P1 (Base Address: 01C8h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Port P1.0 mapping    | P1MAP0   | 00h    |
| Port P1.1 mapping    | P1MAP1   | 01h    |
| Port P1.2 mapping    | P1MAP2   | 02h    |
| Port P1.3 mapping    | P1MAP3   | 03h    |
| Port P1.4 mapping    | P1MAP4   | 04h    |
| Port P1.5 mapping    | P1MAP5   | 05h    |
| Port P1.6 mapping    | P1MAP6   | 06h    |
| Port P1.7 mapping    | P1MAP7   | 07h    |

**Table 6-25. Port Mapping for Port P2 (Base Address: 01D0h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Port P2.0 mapping    | P2MAP0   | 00h    |
| Port P2.1 mapping    | P2MAP2   | 01h    |
| Port P2.2 mapping    | P2MAP2   | 02h    |
| Port P2.3 mapping    | P2MAP3   | 03h    |
| Port P2.4 mapping    | P2MAP4   | 04h    |
| Port P2.5 mapping    | P2MAP5   | 05h    |
| Port P2.6 mapping    | P2MAP6   | 06h    |
| Port P2.7 mapping    | P2MAP7   | 07h    |

**Table 6-26. Port Mapping for Port P3 (Base Address: 01D8h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Port P3.0 mapping    | P3MAP0   | 00h    |
| Port P3.1 mapping    | P3MAP1   | 01h    |
| Port P3.2 mapping    | P3MAP2   | 02h    |
| Port P3.3 mapping    | P3MAP3   | 03h    |
| Port P3.4 mapping    | P3MAP4   | 04h    |
| Port P3.5 mapping    | P3MAP5   | 05h    |
| Port P3.6 mapping    | P3MAP6   | 06h    |
| Port P3.7 mapping    | P3MAP7   | 07h    |

**Table 6-27. Port Registers Port P1, P2 (Base Addresses: 0200h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| Port P1 input                 | P1IN     | 00h    |
| Port P1 output                | P1OUT    | 02h    |
| Port P1 direction             | P1DIR    | 04h    |
| Port P1 resistor enable       | P1REN    | 06h    |
| Port P1 drive strength        | P1DS     | 08h    |
| Port P1 selection             | P1SEL    | 0Ah    |
| Port P1 interrupt vector word | P1IV     | 0Eh    |
| Port P1 interrupt edge select | P1IES    | 18h    |
| Port P1 interrupt enable      | P1IE     | 1Ah    |
| Port P1 interrupt flag        | P1IFG    | 1Ch    |
| Port P2 input                 | P2IN     | 01h    |
| Port P2 output                | P2OUT    | 03h    |
| Port P2 direction             | P2DIR    | 05h    |
| Port P2 resistor enable       | P2REN    | 07h    |
| Port P2 drive strength        | P2DS     | 09h    |
| Port P2 selection             | P2SEL    | 0Bh    |
| Port P2 interrupt vector word | P2IV     | 1Eh    |
| Port P2 interrupt edge select | P2IES    | 19h    |
| Port P2 interrupt enable      | P2IE     | 1Bh    |
| Port P2 interrupt flag        | P2IFG    | 1Dh    |

**Table 6-28. Port Registers P3 (Base Addresses: 0220h)**

| REGISTER DESCRIPTION    | REGISTER | OFFSET |
|-------------------------|----------|--------|
| Port P3 input           | P3IN     | 00h    |
| Port P3 output          | P3OUT    | 02h    |
| Port P3 direction       | P3DIR    | 04h    |
| Port P3 resistor enable | P3REN    | 06h    |
| Port P3 drive strength  | P3DS     | 08h    |
| Port P3 selection       | P3SEL    | 0Ah    |

**Table 6-29. Port Registers PJ (Base Addresses: 0320h)**

| REGISTER DESCRIPTION    | REGISTER | OFFSET |
|-------------------------|----------|--------|
| Port PJ input           | PJIN     | 00h    |
| Port PJ output          | PJOUT    | 02h    |
| Port PJ direction       | PJDIR    | 04h    |
| Port PJ resistor enable | PJREN    | 06h    |
| Port PJ drive strength  | PJDS     | 08h    |
| Port PJ selection       | PJSEL    | 0Ah    |

**Table 6-30. TA0 Registers (Base Address: 03C0h)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| TA0 control               | TA0CTL   | 00h    |
| Capture/compare control 0 | TA0CCTL0 | 02h    |
| Capture/compare control 1 | TA0CCTL1 | 04h    |
| Capture/compare control 2 | TA0CCTL2 | 06h    |
| TA0 counter               | TA0R     | 10h    |
| Capture/compare 0         | TA0CCR0  | 12h    |
| Capture/compare 1         | TA0CCR1  | 14h    |
| Capture/compare 2         | TA0CCR2  | 16h    |
| TA0 expansion 0           | TA0EX0   | 20h    |
| TA0 interrupt vector      | TA0IV    | 2Eh    |

**Table 6-31. 32-Bit Hardware Multiplier Registers (Base Address: 04C0h)**

| REGISTER DESCRIPTION                                    | REGISTER  | OFFSET |
|---------------------------------------------------------|-----------|--------|
| 16-bit operand 1 – multiply                             | MPY       | 00h    |
| 16-bit operand 1 – signed multiply                      | MPYS      | 02h    |
| 16-bit operand 1 – multiply accumulate                  | MAC       | 04h    |
| 16-bit operand 1 – signed multiply accumulate           | MACS      | 06h    |
| 16-bit operand 2                                        | OP2       | 08h    |
| 16 × 16 result low word                                 | RESLO     | 0Ah    |
| 16 × 16 result high word                                | RESHI     | 0Ch    |
| 16 × 16 sum extension register                          | SUMEXT    | 0Eh    |
| 32-bit operand 1 – multiply low word                    | MPY32L    | 10h    |
| 32-bit operand 1 – multiply high word                   | MPY32H    | 12h    |
| 32-bit operand 1 – signed multiply low word             | MPYS32L   | 14h    |
| 32-bit operand 1 – signed multiply high word            | MPYS32H   | 16h    |
| 32-bit operand 1 – multiply accumulate low word         | MAC32L    | 18h    |
| 32-bit operand 1 – multiply accumulate high word        | MAC32H    | 1Ah    |
| 32-bit operand 1 – signed multiply accumulate low word  | MACS32L   | 1Ch    |
| 32-bit operand 1 – signed multiply accumulate high word | MACS32H   | 1Eh    |
| 32-bit operand 2 – low word                             | OP2L      | 20h    |
| 32-bit operand 2 – high word                            | OP2H      | 22h    |
| 32 × 32 result 0 – least significant word               | RES0      | 24h    |
| 32 × 32 result 1                                        | RES1      | 26h    |
| 32 × 32 result 2                                        | RES2      | 28h    |
| 32 × 32 result 3 – most significant word                | RES3      | 2Ah    |
| MPY32 control 0                                         | MPY32CTL0 | 2Ch    |

**Table 6-32. DMA General Control (Base Address: 0500h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| DMA module control 0 | DMACTL0  | 00h    |
| DMA module control 1 | DMACTL1  | 02h    |
| DMA module control 2 | DMACTL2  | 04h    |
| DMA module control 3 | DMACTL3  | 06h    |
| DMA module control 4 | DMACTL4  | 08h    |
| DMA interrupt vector | DMAIV    | 0Eh    |

**Table 6-33. DMA Channel 0 (Base Address: 0510h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|----------------------------------------|----------|--------|
| DMA channel 0 control                  | DMA0CTL  | 00h    |
| DMA channel 0 source address low       | DMA0SAL  | 02h    |
| DMA channel 0 source address high      | DMA0SAH  | 04h    |
| DMA channel 0 destination address low  | DMA0DAL  | 06h    |
| DMA channel 0 destination address high | DMA0DAH  | 08h    |
| DMA channel 0 transfer size            | DMA0SZ   | 0Ah    |

**Table 6-34. DMA Channel 1 (Base Address: 0520h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|----------------------------------------|----------|--------|
| DMA channel 1 control                  | DMA1CTL  | 00h    |
| DMA channel 1 source address low       | DMA1SAL  | 02h    |
| DMA channel 1 source address high      | DMA1SAH  | 04h    |
| DMA channel 1 destination address low  | DMA1DAL  | 06h    |
| DMA channel 1 destination address high | DMA1DAH  | 08h    |
| DMA channel 1 transfer size            | DMA1SZ   | 0Ah    |

**Table 6-35. DMA Channel 2 (Base Address: 0530h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|----------------------------------------|----------|--------|
| DMA channel 2 control                  | DMA2CTL  | 00h    |
| DMA channel 2 source address low       | DMA2SAL  | 02h    |
| DMA channel 2 source address high      | DMA2SAH  | 04h    |
| DMA channel 2 destination address low  | DMA2DAL  | 06h    |
| DMA channel 2 destination address high | DMA2DAH  | 08h    |
| DMA channel 2 transfer size            | DMA2SZ   | 0Ah    |

**Table 6-36. USCI0\_A Registers (Base Address: 05C0h)**

| REGISTER DESCRIPTION       | REGISTER   | OFFSET |
|----------------------------|------------|--------|
| USCI control 0             | UCA0CTL0   | 01h    |
| USCI control 1             | UCA0CTL1   | 00h    |
| USCI baud rate 0           | UCA0BR0    | 06h    |
| USCI baud rate 1           | UCA0BR1    | 07h    |
| USCI modulation control    | UCA0MCTL   | 08h    |
| USCI status                | UCA0STAT   | 0Ah    |
| USCI receive buffer        | UCA0RXBUF  | 0Ch    |
| USCI transmit buffer       | UCA0TXBUF  | 0Eh    |
| USCI LIN control           | UCA0ABCTL  | 10h    |
| USCI IrDA transmit control | UCA0IRTCTL | 12h    |
| USCI IrDA receive control  | UCA0IRRCTL | 13h    |
| USCI interrupt enable      | UCA0IE     | 1Ch    |
| USCI interrupt flags       | UCA0IFG    | 1Dh    |
| USCI interrupt vector word | UCA0IV     | 1Eh    |

**Table 6-37. USCI0\_B Registers (Base Address: 05E0h)**

| REGISTER DESCRIPTION             | REGISTER  | OFFSET |
|----------------------------------|-----------|--------|
| USCI synchronous control 0       | UCB0CTL0  | 00h    |
| USCI synchronous control 1       | UCB0CTL1  | 01h    |
| USCI synchronous bit rate 0      | UCB0BR0   | 06h    |
| USCI synchronous bit rate 1      | UCB0BR1   | 07h    |
| USCI synchronous status          | UCB0STAT  | 0Ah    |
| USCI synchronous receive buffer  | UCB0RXBUF | 0Ch    |
| USCI synchronous transmit buffer | UCB0TXBUF | 0Eh    |
| USCI I2C own address             | UCB0I2COA | 10h    |
| USCI I2C slave address           | UCB0I2CSA | 12h    |
| USCI interrupt enable            | UCB0IE    | 1Ch    |
| USCI interrupt flags             | UCB0IFG   | 1Dh    |
| USCI interrupt vector word       | UCB0IV    | 1Eh    |

**Table 6-38. ADC10\_A Registers (MSP430F51x2 Devices Only) (Base Address: 0740h)**

| REGISTER DESCRIPTION                     | REGISTER   | OFFSET |
|------------------------------------------|------------|--------|
| ADC10_A control 0                        | ADC10CTL0  | 00h    |
| ADC10_A control 1                        | ADC10CTL1  | 02h    |
| ADC10_A control 2                        | ADC10CTL2  | 04h    |
| ADC10_A window comparator low threshold  | ADC10LO    | 06h    |
| ADC10_A window comparator high threshold | ADC10HI    | 08h    |
| ADC10_A memory control register 0        | ADC10MCTL0 | 0Ah    |
| ADC10_A conversion memory register       | ADC10MEM0  | 12h    |
| ADC10_A interrupt enable                 | ADC10IE    | 1Ah    |
| ADC10_A interrupt flags                  | ADC10IGH   | 1Ch    |
| ADC10_A interrupt vector word            | ADC10IV    | 1Eh    |

**Table 6-39. Comparator\_B Registers (Base Address: 08C0h)**

| REGISTER DESCRIPTION               | REGISTER | OFFSET |
|------------------------------------|----------|--------|
| Comparator_B control 0             | CBCTL0   | 00h    |
| Comparator_B control 1             | CBCTL1   | 02h    |
| Comparator_B control 2             | CBCTL2   | 04h    |
| Comparator_B control 3             | CBCTL3   | 06h    |
| Comparator_B interrupt             | CBINT    | 0Ch    |
| Comparator_B interrupt vector word | CBIV     | 0Eh    |

**Table 6-40. TD0 Registers (Base Address: 0B00h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| TD0 control 0                 | TD0CTL0  | 00h    |
| TD0 control 1                 | TD0CTL1  | 02h    |
| TD0 control 2                 | TD0CTL2  | 04h    |
| TD0 counter                   | TD0R     | 06h    |
| Capture/compare control 0     | TD0CCTL0 | 08h    |
| Capture/compare 0             | TD0CCR0  | 0Ah    |
| Capture/compare latch 0       | TD0CL0   | 0Ch    |
| Capture/compare control 1     | TD0CCTL1 | 0Eh    |
| Capture/compare 1             | TD0CCR1  | 10h    |
| Capture/compare latch 1       | TD0CL1   | 12h    |
| Capture/compare control 2     | TD0CCTL2 | 14h    |
| Capture/compare 2             | TD0CCR2  | 16h    |
| Capture/compare latch 2       | TD0CL2   | 18h    |
| TD0 high-resolution control 0 | TD0HCTL0 | 38h    |
| TD0 high-resolution control 1 | TD0HCTL1 | 3Ah    |
| TD0 high-resolution interrupt | TD0HINT  | 3Ch    |
| TD0 interrupt vector          | TD0IV    | 3Eh    |

**Table 6-41. TD1 Registers (Base Address: 0B40h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| TD1 control 0                 | TD1CTL0  | 00h    |
| TD1 control 1                 | TD1CTL1  | 02h    |
| TD1 control 2                 | TD1CTL2  | 04h    |
| TD1 counter                   | TD1R     | 06h    |
| Capture/compare control 0     | TD1CCTL0 | 08h    |
| Capture/compare 0             | TD1CCR0  | 0Ah    |
| Capture/compare latch 0       | TD1CL0   | 0Ch    |
| Capture/compare control 1     | TD1CCTL1 | 0Eh    |
| Capture/compare 1             | TD1CCR1  | 10h    |
| Capture/compare latch 1       | TD1CL1   | 12h    |
| Capture/compare control 2     | TD1CCTL2 | 14h    |
| Capture/compare 2             | TD1CCR2  | 16h    |
| Capture/compare latch 2       | TD1CL2   | 18h    |
| TD1 high-resolution control 0 | TD1HCTL0 | 38h    |
| TD1 high-resolution control 1 | TD1HCTL1 | 3Ah    |
| TD1 high-resolution interrupt | TD1HINT  | 3Ch    |
| TD1 interrupt vector          | TD1IV    | 3Eh    |

**Table 6-42. TEC0 Registers (Base Address: 0C00h)**

| REGISTER DESCRIPTION                            | REGISTER | OFFSET |
|-------------------------------------------------|----------|--------|
| Timer event control 0 external control 0        | TEC0CTL0 | 00h    |
| Timer event control 0 external control          | TEC0CTL1 | 02h    |
| Timer event control 0 external control          | TEC0CTL2 | 04h    |
| Timer event control 0 status                    | TEC0STA  | 06h    |
| Timer event control 0 external interrupt        | TEC0XINT | 08h    |
| Timer event control 0 external interrupt vector | TEC0IV   | 0Ah    |

**Table 6-43. TEC1 Registers (Base Address: 0C20h)**

| REGISTER DESCRIPTION                            | REGISTER | OFFSET |
|-------------------------------------------------|----------|--------|
| Timer event control 1 external control 0        | TEC1CTL0 | 00h    |
| Timer event control 1 external control          | TEC1CTL1 | 02h    |
| Timer event control 1 external control          | TEC1CTL2 | 04h    |
| Timer event control 1 status                    | TEC1STA  | 06h    |
| Timer event control 1 external interrupt        | TEC1XINT | 08h    |
| Timer event control 1 external interrupt vector | TEC1IV   | 0Ah    |

## 6.10 Input/Output Diagrams

### 6.10.1 Port P1 (P1.0 to P1.5) Input/Output With Schmitt Trigger

Figure 6-2 shows the port diagram. Table 6-44 summarizes the selection of the pin function.

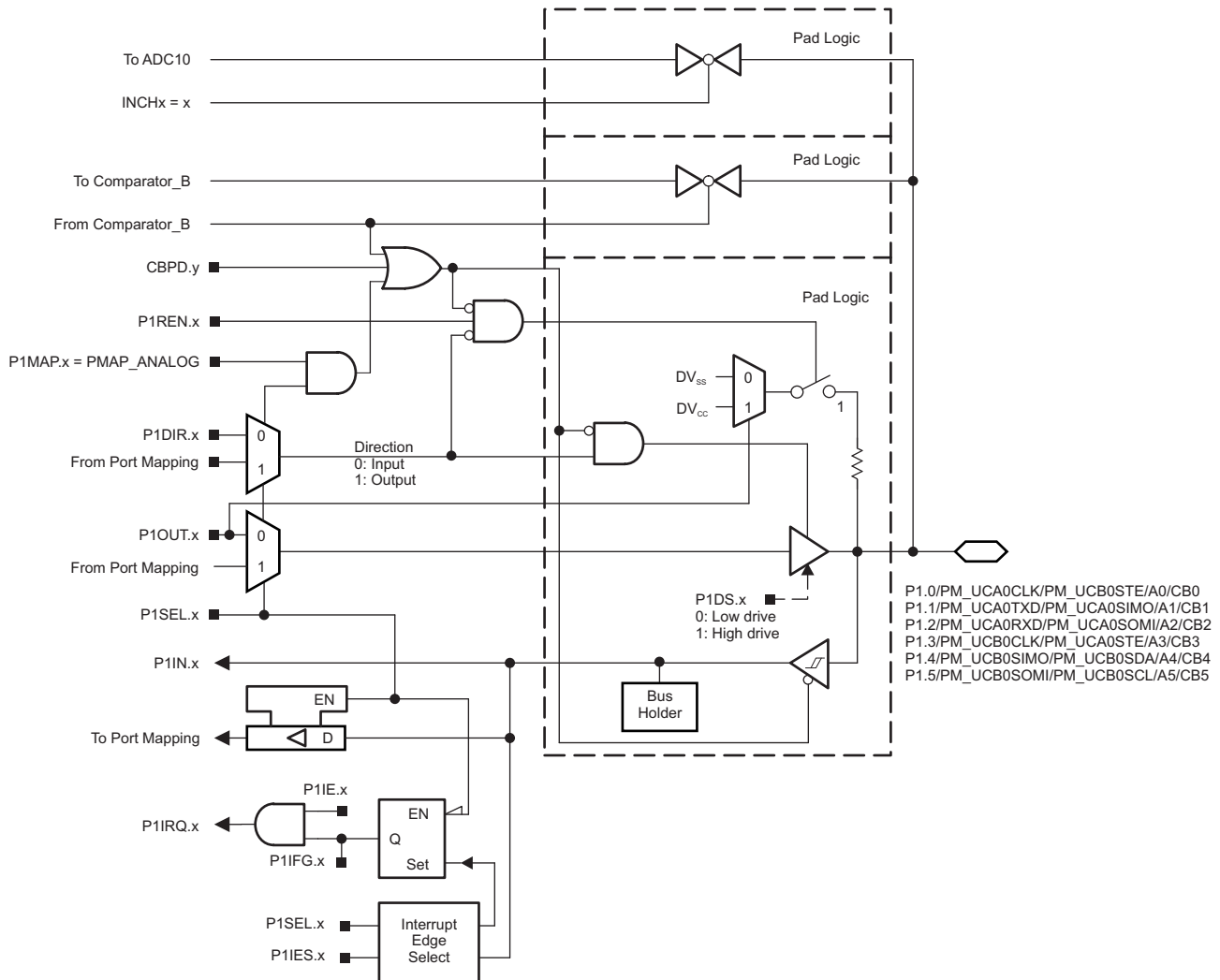


Figure 6-2. Port P1 (P1.0 to P1.5) Diagram

**Table 6-44. Port P1 (P1.0 to P1.5) Pin Functions**

| PIN NAME (P1.x)                      | x | FUNCTION                                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |                 |           |
|--------------------------------------|---|-------------------------------------------|----------------------------------------|---------|-----------------|-----------|
|                                      |   |                                           | P1DIR.x                                | P1SEL.x | P1MAP.x         | CBPD.y    |
| P1.0/<br>PM_UCA0CLK/<br>PM_UCB0STE/  | 0 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | UCA0CLK/UCB0STE <sup>(2) (3)</sup>        | 0                                      | 1       | default         | 0         |
| A0/                                  |   | A0 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 0 | X         |
| CB0                                  |   | CB0                                       | X                                      | X       | X               | 1 (y = 0) |
| P1.1/<br>PM_UCA0TXD/<br>PM_UCA0SIMO/ | 1 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCA0TXD/PM_UCA0SIMO <sup>(2)</sup>     | 0                                      | 1       | default         | 0         |
| A1/                                  |   | A1 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 1 | X         |
| CB1                                  |   | CB1                                       | X                                      | X       | X               | 1 (y = 1) |
| P1.2/<br>PM_UCA0RXD/<br>PM_UCA0SOMI/ | 2 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCA0RXD/PM_UCA0SOMI <sup>(2)</sup>     | 0                                      | 1       | default         | 0         |
| A2/                                  |   | A2 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 2 | X         |
| CB2                                  |   | CB2                                       | X                                      | X       | X               | 1 (y = 2) |
| P1.3/<br>PM_UCB0CLK/<br>PM_UCA0STE/  | 3 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | UCB0CLK/UCA0STE <sup>(2)</sup>            | 0                                      | 1       | default         | 0         |
| A3/                                  |   | A3 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 3 | X         |
| CB3                                  |   | CB3                                       | X                                      | X       | X               | 1 (y = 3) |
| P1.4/<br>PM_UCB0SIMO/<br>PM_UCB0SDA/ | 4 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCB0SIMO/PM_UCB0SDA <sup>(2) (5)</sup> | 0                                      | 1       | default         | 0         |
| A4/                                  |   | A4 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 4 | X         |
| CB4                                  |   | CB4                                       | X                                      | X       | X               | 1 (y = 4) |
| P1.5/<br>PM_UCB0SOMI/<br>PM_UCB0SCL/ | 5 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCB0SOMI/PM_UCB0SCL <sup>(2) (5)</sup> | 0                                      | 1       | default         | 0         |
| A5/                                  |   | A5 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 5 | X         |
| CB5                                  |   | CB5                                       | X                                      | X       | X               | 1 (y = 5) |

(1) X = Don't care

(2) The pin direction is controlled by the USCI module.

(3) UCA0CLK function takes precedence over UCB0STE function. If the pin is required as UCA0CLK input or output, USCI\_B0 is forced to 3-wire SPI mode if 4-wire SPI mode is selected.

(4) MSP430F51x2 device only

(5) If the I<sup>2</sup>C functionality is selected, the output drives only the logical 0 to V<sub>SS</sub> level.

## 6.10.2 Port P1 (P1.6 to P1.7) Input/Output With Schmitt Trigger

Figure 6-3 shows the port diagram. Table 6-45 summarizes the selection of the pin function.

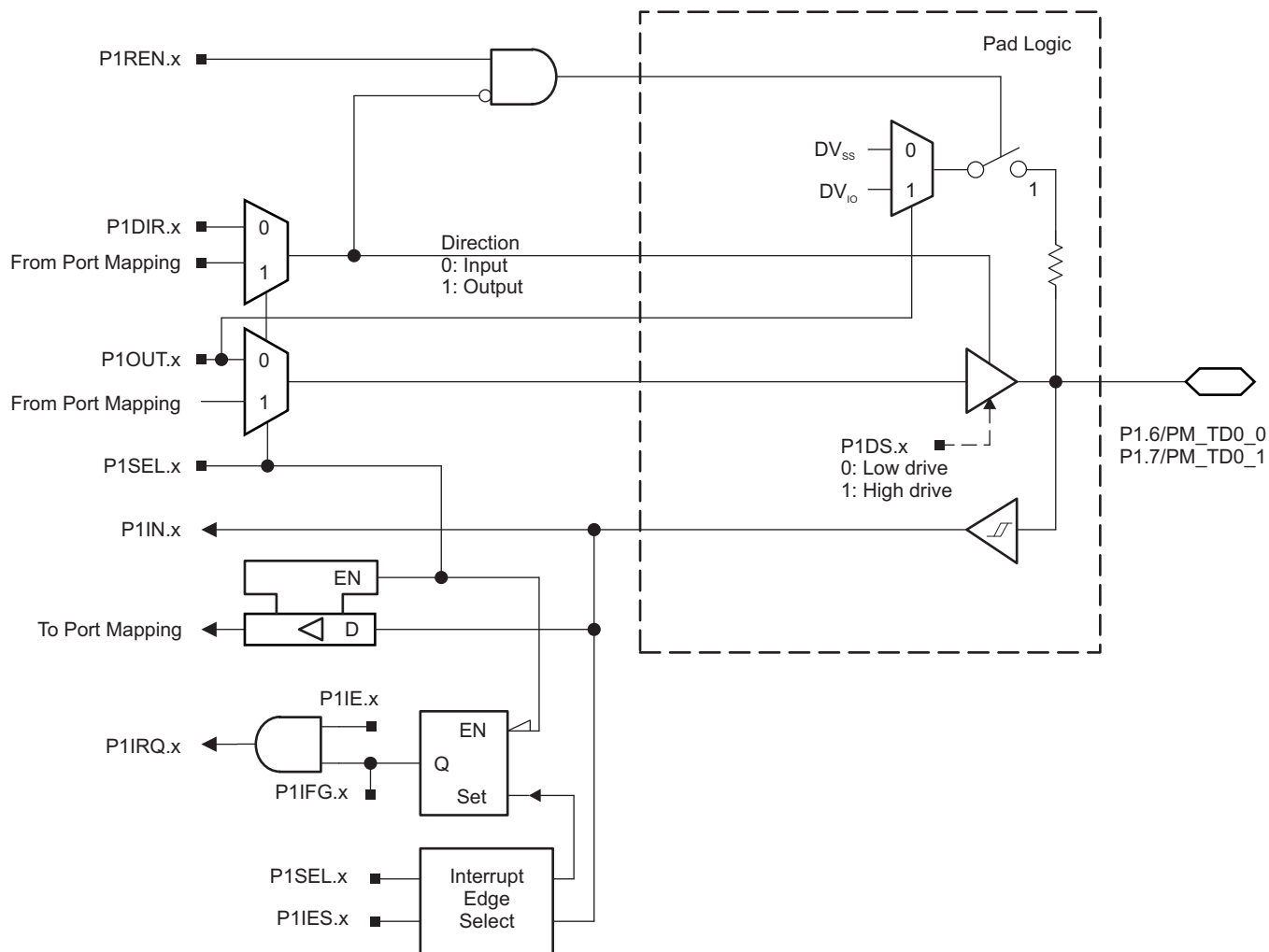


Figure 6-3. Port P1 (P1.6 and P1.7) Diagram

Table 6-45. Port P1 (P1.6 and P1.7) Pin Functions

| PIN NAME (P1.x)   | x | FUNCTION   | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |
|-------------------|---|------------|----------------------------------------|---------|---------|
|                   |   |            | P1DIR.x                                | P1SEL.x | P1MAP.x |
| P1.6/<br>PM_TD0.0 | 6 | P1.x (I/O) | I: 0; O: 1                             | 0       | X       |
|                   |   | TD0.CCI0A  | 0                                      | 1       | default |
|                   |   | TD0.TA0    | 1                                      | 1       | default |
| P1.7/<br>PM_TD0.1 | 7 | P1.x (I/O) | I: 0; O: 1                             | 0       | X       |
|                   |   | TD0.CCI1A  | 0                                      | 1       | default |
|                   |   | TD0.TA1    | 1                                      | 1       | default |

(1) X = Don't care

### 6.10.3 Port P2 (P2.0 to P2.7) Input/Output With Schmitt Trigger

Figure 6-4 shows the port diagram. Table 6-46 summarizes the selection of the pin function.

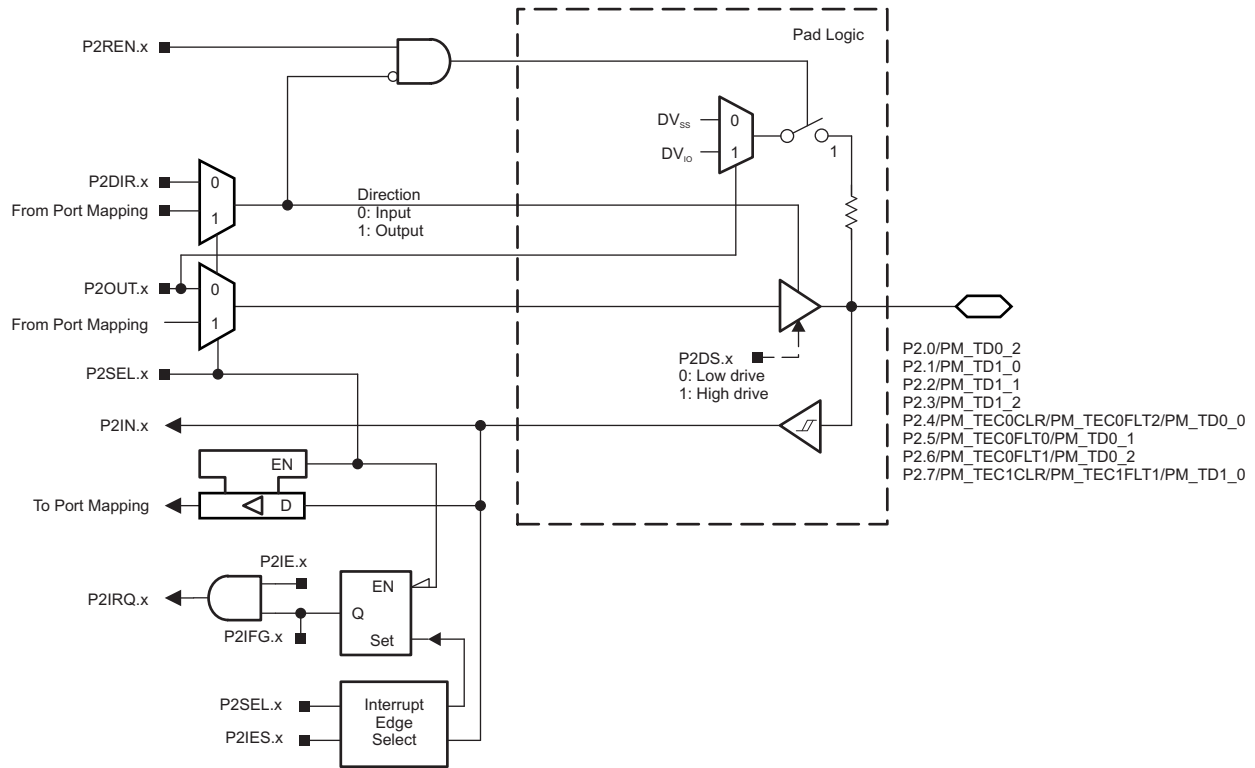


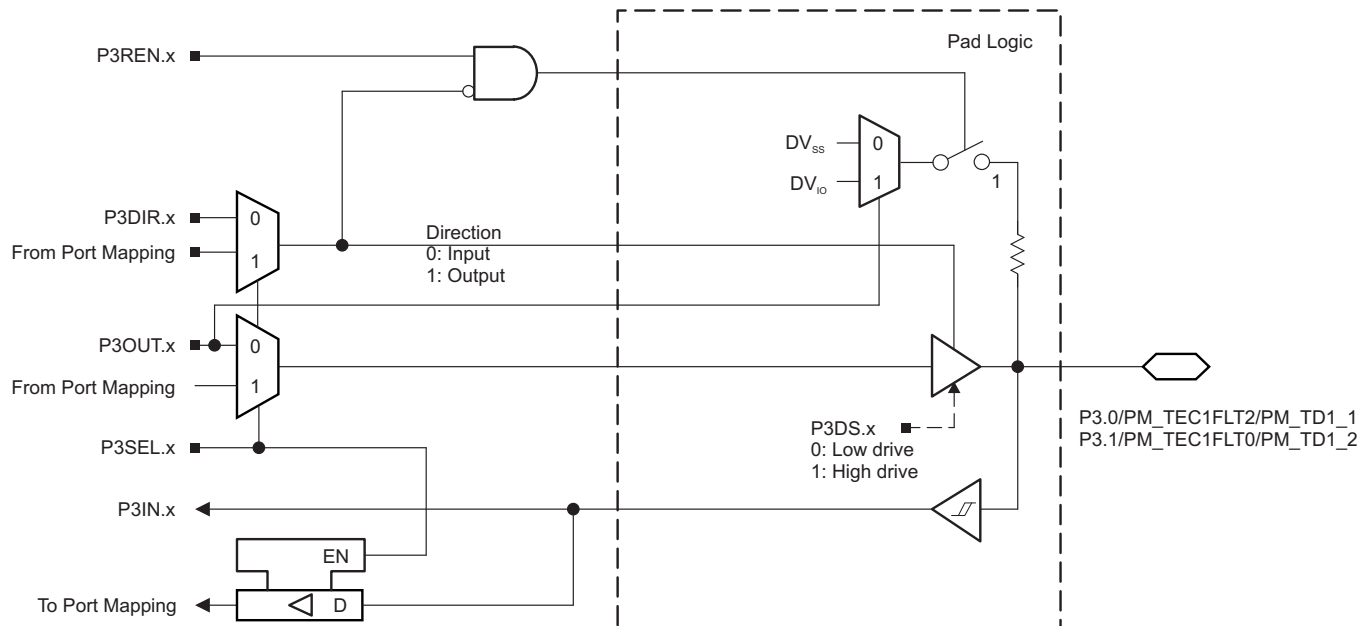
Figure 6-4. Port P2 (P2.0 to P2.7) Diagram

**Table 6-46. Port P2 (P2.0 to P2.7) Pin Functions**

| PIN NAME (P2.x)                                  | x | FUNCTION                                                       | CONTROL BITS OR SIGNALS |         |         |
|--------------------------------------------------|---|----------------------------------------------------------------|-------------------------|---------|---------|
|                                                  |   |                                                                | P2DIR.x                 | P2SEL.x | P2MAP.x |
| P2.0/<br>PM_TD0.2                                | 0 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD0.CCI2A                                                      | 0                       | 1       | default |
|                                                  |   | TD0.TA2                                                        | 1                       | 1       | default |
| P2.1/<br>PM_TD1.0                                | 1 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD1.CCI0A                                                      | 0                       | 1       | default |
|                                                  |   | TD1.TA0                                                        | 1                       | 1       | default |
| P2.2/<br>PM_TD1.1                                | 2 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD1.CCI1A                                                      | 0                       | 1       | default |
|                                                  |   | TD1.TA1                                                        | 1                       | 1       | default |
| P2.3/<br>PM_TD1.2                                | 3 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | 0       |
|                                                  |   | TD1.CCI2A                                                      | 0                       | 1       | default |
|                                                  |   | TD1.TA2                                                        | 1                       | 1       | default |
| P2.4/<br>PM_TEC0CLR/<br>PM_TEC0FLT2/<br>PM_TD0.0 | 4 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD0.TECEXTCLR, controlled by enable signals in the TEC0 module | 0                       | 1       | default |
|                                                  |   | TD0.TECXFLT2, controlled by enable signals in the TEC0 module  | 0                       | 1       | default |
|                                                  |   | TD0.TA0                                                        | 1                       | 1       | default |
| P2.5/<br>PM_TEC0FLT0/<br>PM_TD0.1                | 5 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | x       |
|                                                  |   | TD0.TECXFLT0, controlled by enable signals in the TEC0 module  | 0                       | 1       | default |
|                                                  |   | TD0.TA1                                                        | 1                       | 1       | default |
| P2.6/<br>PM_TEC0FLT1/<br>PM_TD0.2                | 6 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD0.TECXFLT1, controlled by enable signals in the TEC0 module  | 0                       | 1       | default |
|                                                  |   | TD0.TA2                                                        | 1                       | 1       | default |
| P2.7/<br>PM_TEC1CLR/<br>PM_TEC1FLT1/<br>PM_TD1.0 | 7 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD1.TECEXTCLR, controlled by enable signals in the TEC1 module | 0                       | 1       | default |
|                                                  |   | TD1.TECXFLT1, controlled by enable signals in the TEC1 module  | 0                       | 1       | default |
|                                                  |   | TD1.TA0                                                        | 1                       | 1       | default |

#### 6.10.4 Port P3 (P3.0 and P3.1) Input/Output With Schmitt Trigger

Figure 6-5 shows the port diagram. Table 6-47 summarizes the selection of the pin function.



### Figure 6-5. Port P3 (P3.0 and P3.1) Diagram

### Table 6-47. Port P3 (P3.0 and P3.1) Pin Functions

| PIN NAME (P3.x) | x | FUNCTION                                                      | CONTROL BITS OR SIGNALS |         |         |
|-----------------|---|---------------------------------------------------------------|-------------------------|---------|---------|
|                 |   |                                                               | P3DIR.x                 | P3SEL.x | P3MAP.x |
| P3.0/           | 0 | P3.x (I/O)                                                    | I: 0; O: 1              | 0       | X       |
| PM_TEC1FLT2/    |   | TD1.TECXFLT2, controlled by enable signals in the TEC1 module | 0                       | 1       | default |
| PM_TD1.1        |   | TD1.TA1                                                       | 1                       | 1       | default |
| P3.1/           | 1 | P3.x (I/O)                                                    | I: 0; O: 1              | 0       | X       |
| PM_TEC1FLT0/    |   | TD1.TECXFLT0, controlled by enable signals in the TEC1 module | 0                       | 1       | default |
| PM_TD1.2        |   | TD1.TA2                                                       | 1                       | 1       | default |

### 6.10.5 Port P3 (P3.2 and P3.3) Input/Output With Schmitt Trigger

Figure 6-6 shows the port diagram. Table 6-48 summarizes the selection of the pin function.

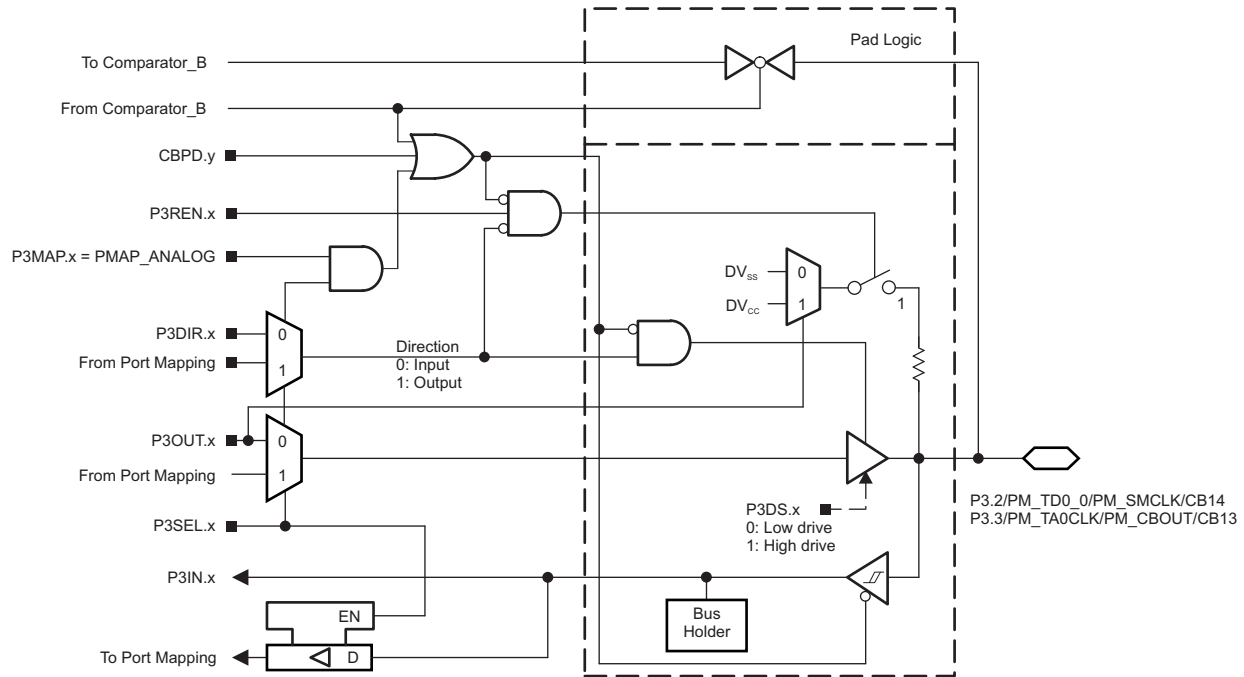


Figure 6-6. Port P3 (P3.2 and P3.3) Diagram

Table 6-48. Port P3 (P3.2 and P3.3) Pin Functions

| PIN NAME (P3.x)                          | x | FUNCTION     | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |            |
|------------------------------------------|---|--------------|----------------------------------------|---------|---------|------------|
|                                          |   |              | P3DIR.x                                | P3SEL.x | P3MAP.x | CBPD.y     |
| P3.2/<br>PM_TD0.0/<br>PM_SMCLK/<br>CB14  | 2 | P3.x (I/O)   | I: 0; O: 1                             | 0       | X       | 0          |
|                                          |   | TD0.CCI0A    | 0                                      | 1       | default | 0          |
|                                          |   | SMCLK output | 1                                      | 1       | default | 0          |
|                                          |   | CB14         | X                                      | X       | X       | 1 (y = 14) |
| P3.3/<br>PM_TA0CLK/<br>PM_CBOUT/<br>CB13 | 3 | P3.x (I/O)   | I: 0; O: 1                             | 0       | X       | 0          |
|                                          |   | TA0.TA0CLK   | 0                                      | 1       | default | 0          |
|                                          |   | CBOUT        | 1                                      | 1       | default | 0          |
|                                          |   | CB13         | X                                      | X       | X       | 1 (y = 13) |

(1) X = Don't care

### 6.10.6 Port P3 (P3.4) Input/Output With Schmitt Trigger

Figure 6-7 shows the port diagram. Table 6-49 summarizes the selection of the pin function.

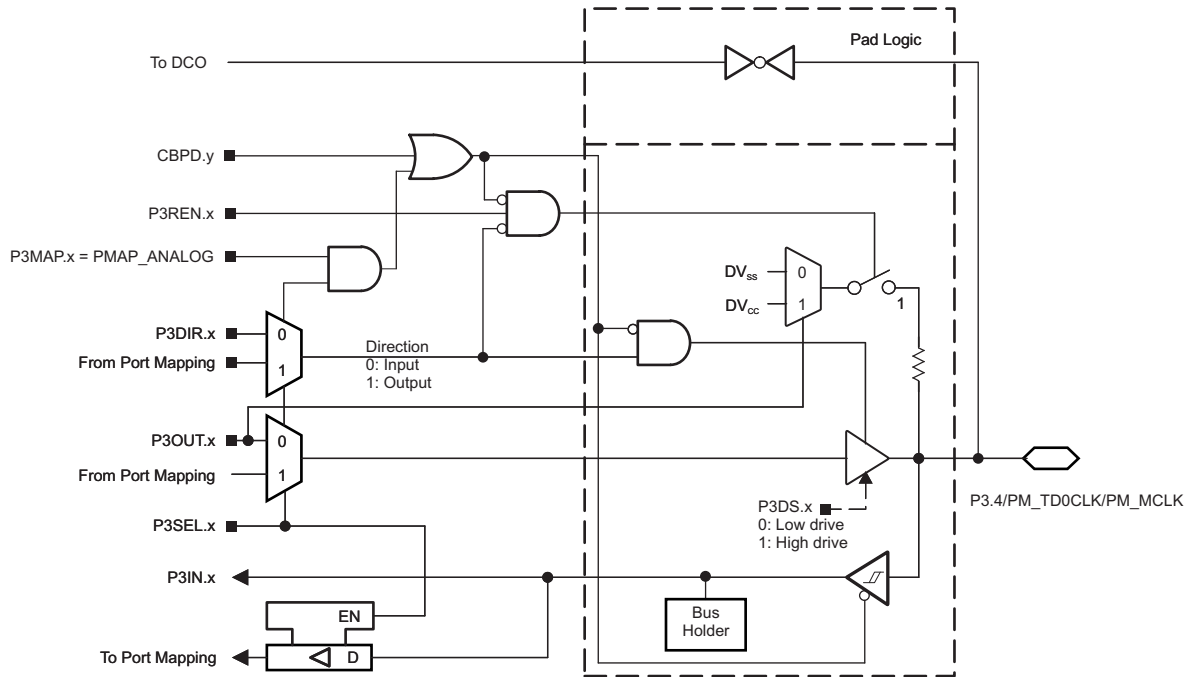


Figure 6-7. Port P3 (P3.4) Diagram

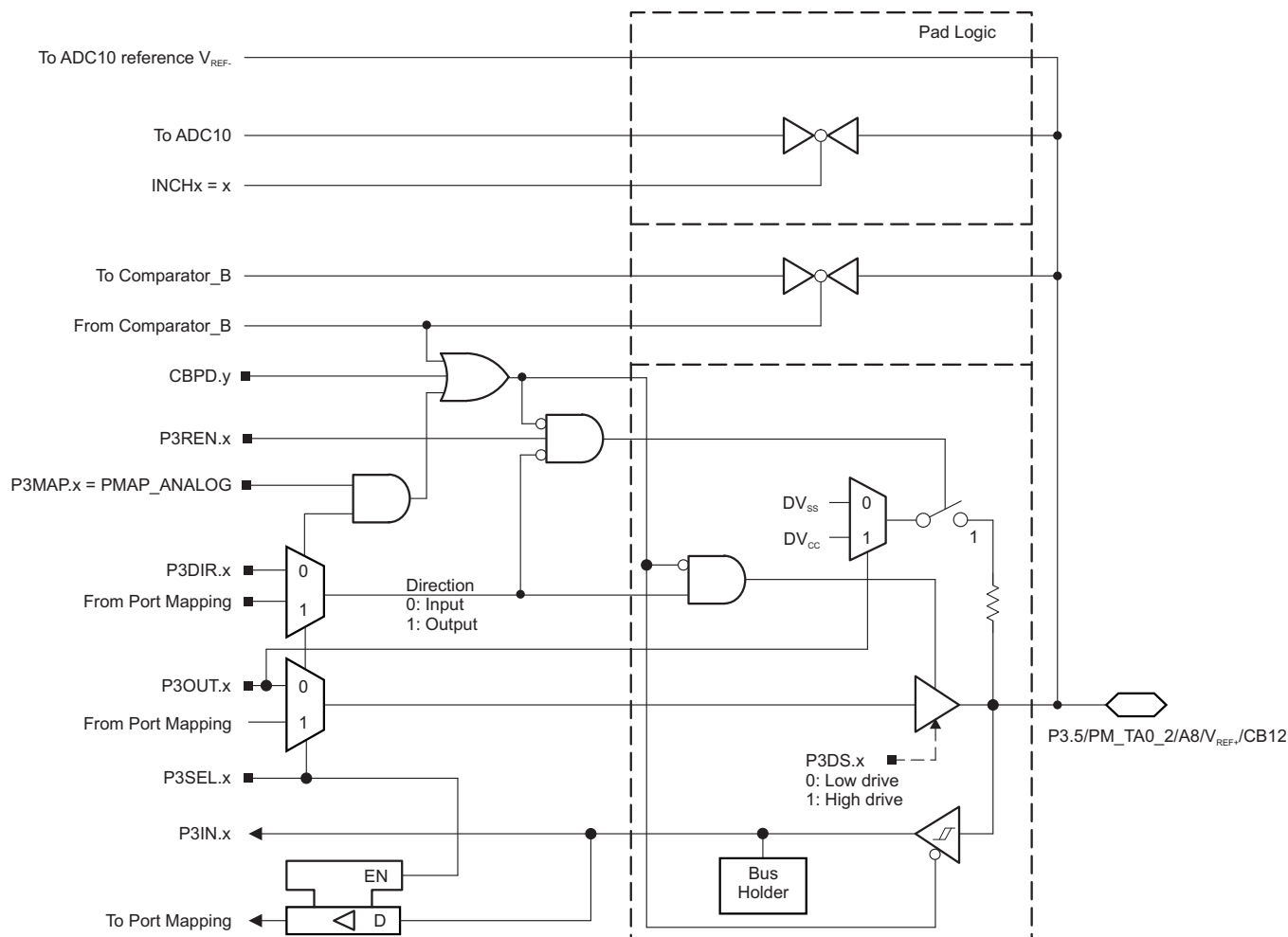
Table 6-49. Port P3 (P3.4) Pin Functions

| PIN NAME (P3.x) | x | FUNCTION        | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |   |
|-----------------|---|-----------------|----------------------------------------|---------|---------|---|
|                 |   |                 | P3DIR.x                                | P3SEL.x | P3MAP.x |   |
| P3.4/           | 4 | P3.x (I/O)      | I: 0; O: 1                             | 0       | X       | 0 |
| PM_TD0CLK/      |   | TD0 clock input | 0                                      | 1       | default | 0 |
| PM_MCLK         |   | MCLK output     | 1                                      | 1       | default | 0 |

(1) X = Don't care

### 6.10.7 Port P3 (P3.5) Input/Output With Schmitt Trigger

Figure 6-8 shows the port diagram. Table 6-50 summarizes the selection of the pin function.



### Figure 6-8. Port P3 (P3.5) Diagram

### Table 6-50. Port P3 (P3.5) Pin Functions

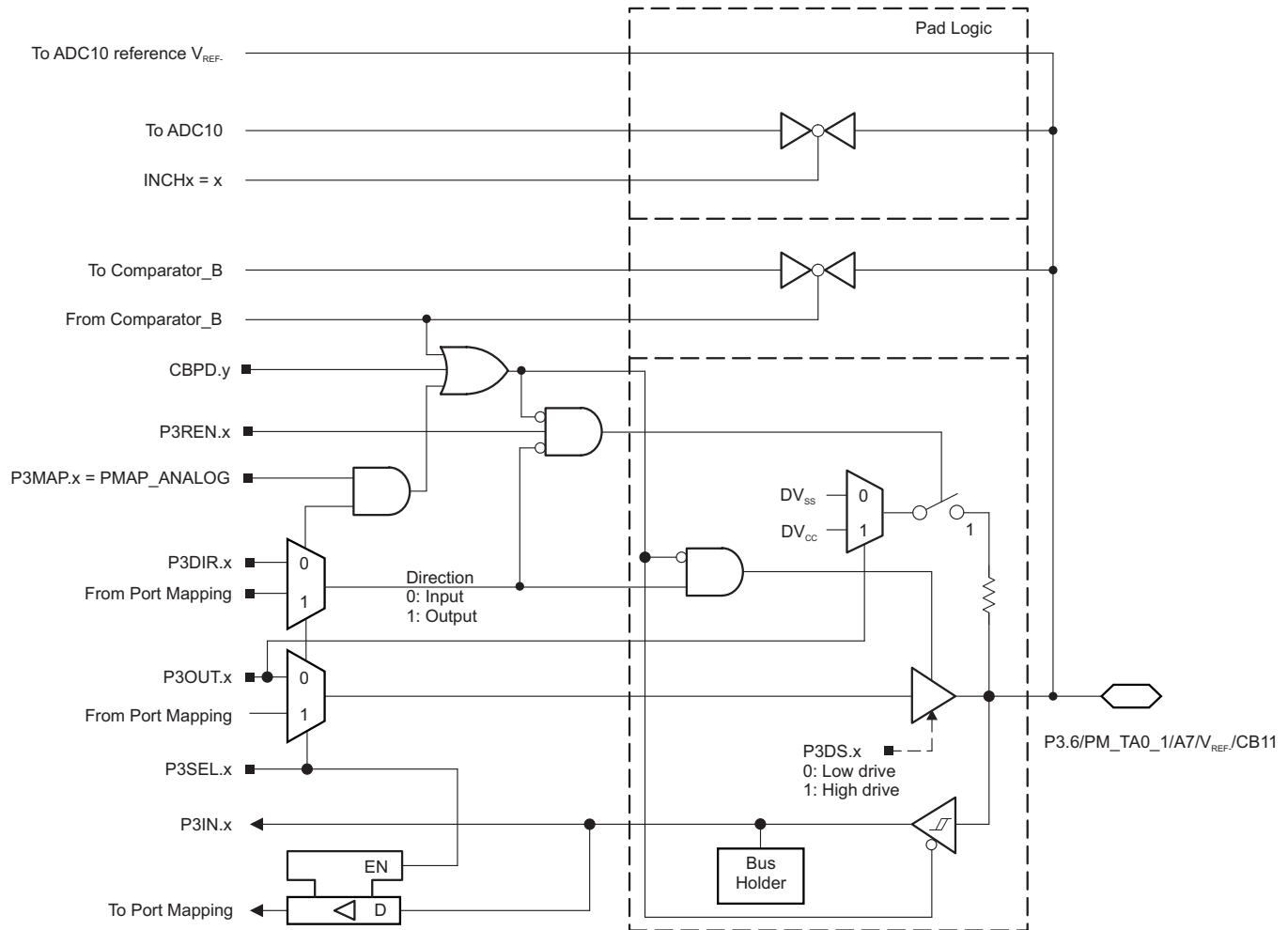
| PIN NAME (P3.x)    | x | FUNCTION              | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |            |
|--------------------|---|-----------------------|----------------------------------------|---------|---------|------------|
|                    |   |                       | P3DIR.x                                | P3SEL.x | P3MAP.x | CBPD.y     |
| P3.5/<br>PM_TA0.2/ | 5 | P3.x (I/O)            | I: 0; O: 1                             | 0       | X       | 0          |
|                    |   | TA0.CCI2A             | 0                                      | 1       | default | 0          |
|                    |   | TA0.TA2               | 1                                      | 1       | default | 0          |
| VEREF+/<br>A8/     |   | VEREF+ <sup>(2)</sup> | X                                      | 1       | 31      | X          |
|                    |   | A8 <sup>(2)</sup>     | X                                      | 1       | INCHx=8 | X          |
| CB12               |   | CB12                  | X                                      | X       | X       | 1 (y = 12) |

(1)  $X = \text{Don't care}$

(2) MSP430F51x2 devices only.

### 6.10.8 Port P3 (P3.6) Input/Output With Schmitt Trigger

Figure 6-9 shows the port diagram. Table 6-51 summarizes the selection of the pin function.



**Figure 6-9. Port P3 (P3.6) Diagram**

**Table 6-51. Port P3 (P3.6) Pin Functions**

| PIN NAME (P3.x) | x | FUNCTION                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |                 |            |
|-----------------|---|---------------------------|----------------------------------------|---------|-----------------|------------|
|                 |   |                           | P3DIR.x                                | P3SEL.x | P3MAP.x         | CBPD.y     |
| P3.6/           | 6 | P3.x (I/O) <sup>(2)</sup> | I: 0; O: 1                             | 0       | X               | 0          |
| PM_TA0.1/       |   | TA0.CCR0                  | 0                                      | 1       | default         | 0          |
|                 |   | TA0.TA1                   | 1                                      | 1       | default         | 0          |
| VEREF-/         |   | VEREF- <sup>(3)</sup>     | X                                      | 1       | 31              | X          |
| A7/             |   | A7 <sup>(3)</sup>         | X                                      | 1       | 31<br>INCHx = 7 | X          |
| CB11            |   | CB11                      | X                                      | X       | 0               | 1 (y = 11) |

- (1) X = Don't care  
(2) Default condition.  
(3) MSP430F51x2 devices only.

### 6.10.9 Port P3 (P3.7) Input/Output With Schmitt Trigger

Figure 6-10 shows the port diagram. Table 6-52 summarizes the selection of the pin function.

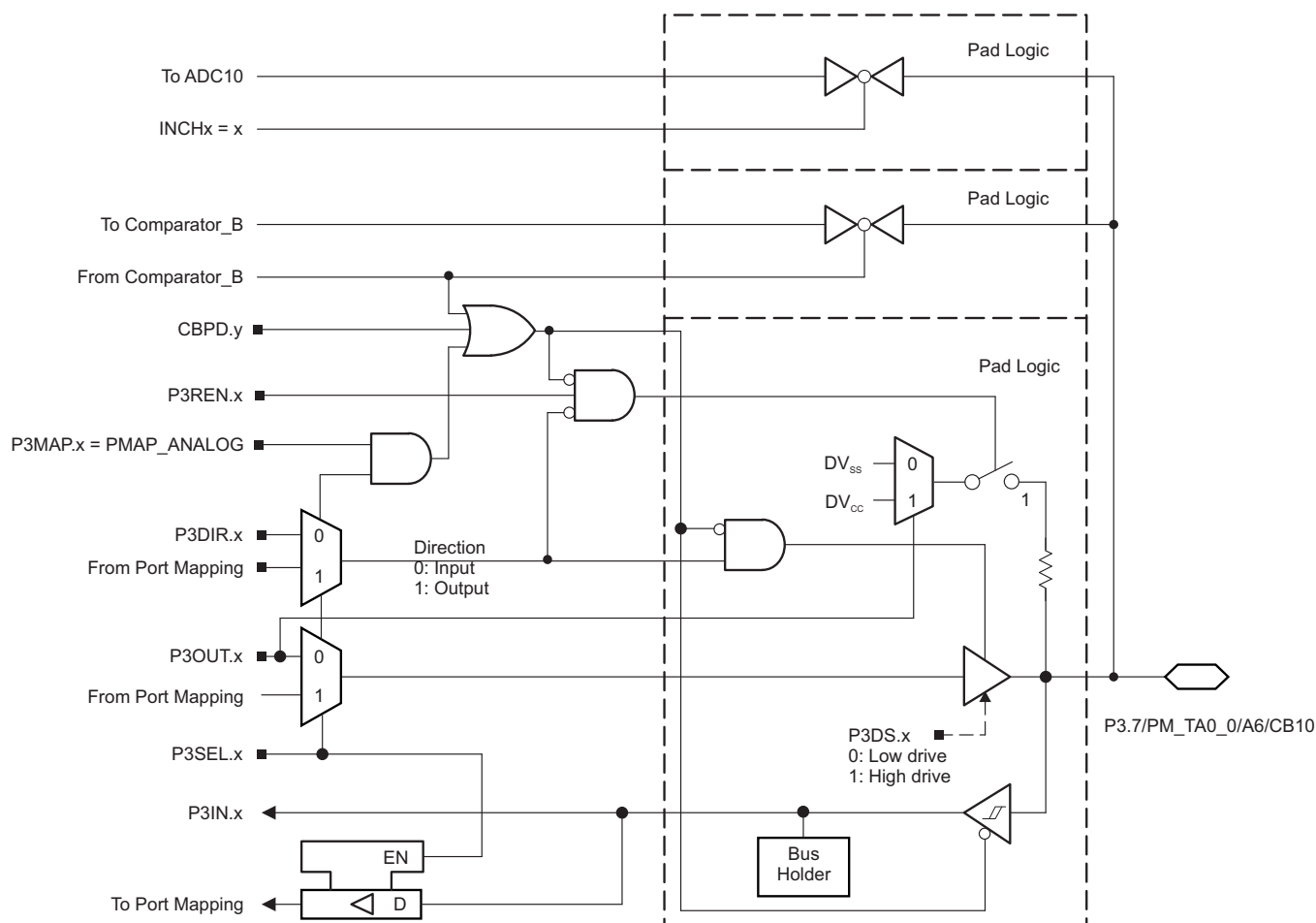


Figure 6-10. Port P3 (P3.7) Diagram

Table 6-52. Port P3 (P3.7) Pin Functions

| PIN NAME (P3.x) | x | FUNCTION                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |                            |            |
|-----------------|---|---------------------------|----------------------------------------|---------|----------------------------|------------|
|                 |   |                           | P3DIR.x                                | P3SEL.2 | P3MAP.x                    | CBPD.y     |
| P3.7/           | 7 | P3.x (I/O) <sup>(1)</sup> | I: 0; O: 1                             | 0       | X                          | 0          |
| PM_TA0.0/       |   | TA0.CCR0                  | 0                                      | 1       | default                    | 0          |
|                 |   | TA0.TA0                   | 1                                      | 1       | default                    | 0          |
| A6/             |   | A6 <sup>(2)</sup>         | X                                      | 1       | <sup>31</sup><br>INCHx = 6 | X          |
| CB10            |   | CB10                      | X                                      | X       | 0                          | 1 (y = 10) |

(1) X = Don't care

(2) MSP430F51x2 devices only.

### 6.10.10 Port J (PJ.0) JTAG Pin TDO, Input/Output With Schmitt Trigger or Output

Figure 6-11 shows the port diagram. Table 6-53 summarizes the selection of the pin function.

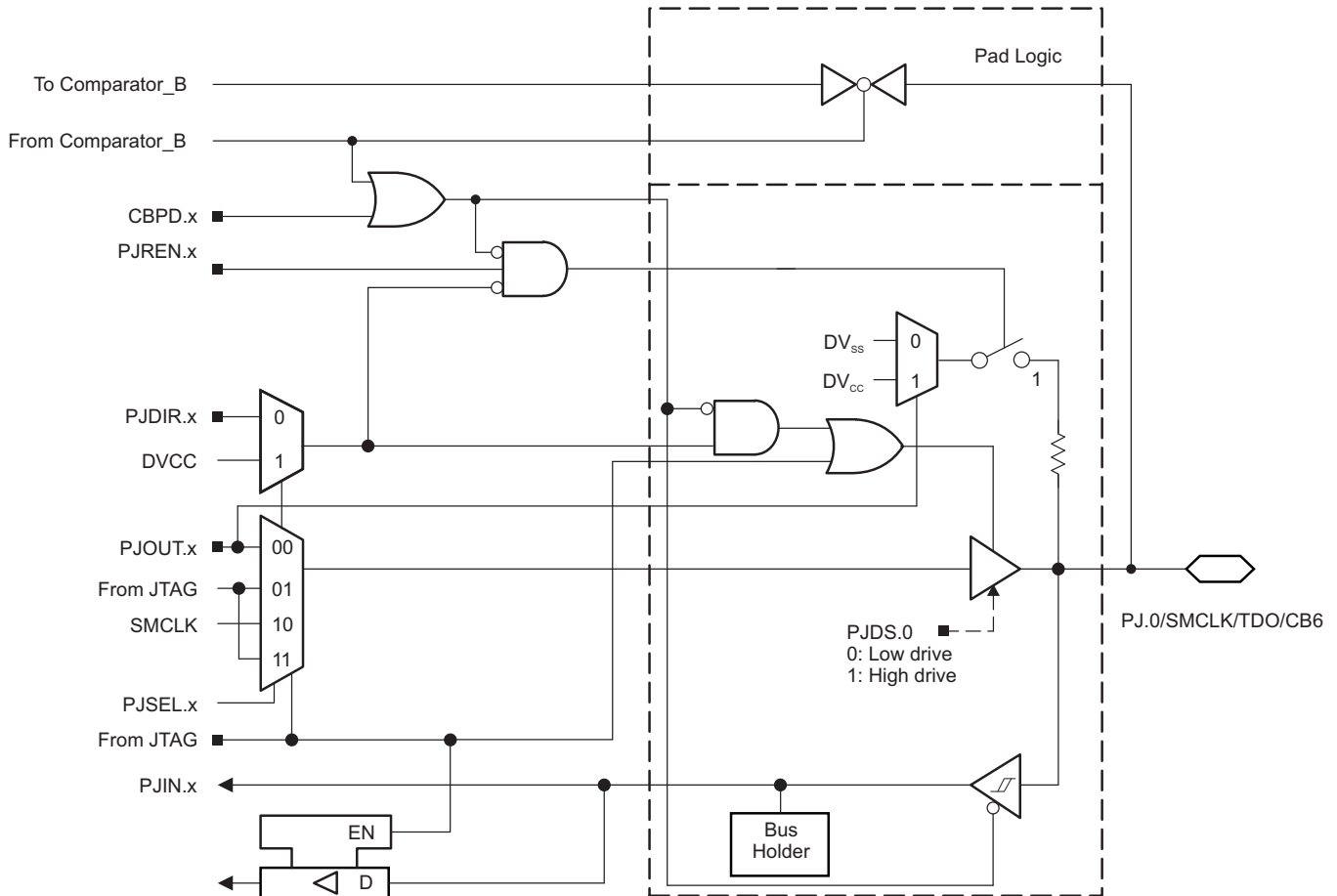


Figure 6-11. Port PJ (PJ.0) Diagram

### 6.10.11 Port J (PJ.1 to PJ.3) JTAG Pins TMS, TCK, TDI/TCLK, Input/Output With Schmitt Trigger or Output

Figure 6-12 shows the port diagram. Table 6-53 summarizes the selection of the pin function.

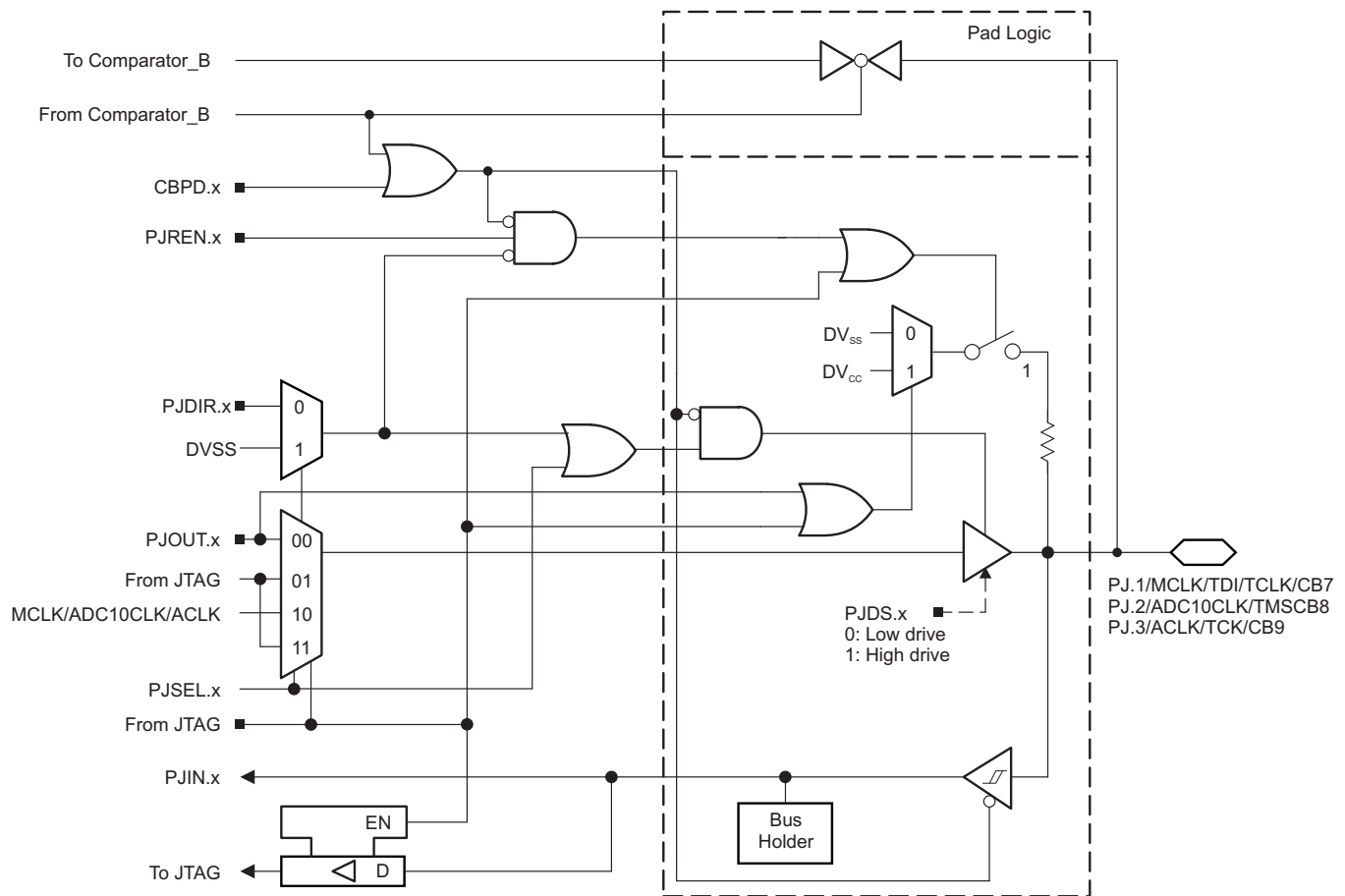


Figure 6-12. Port PJ (PJ.1 to PJ.3) Diagram

**Table 6-53. Port PJ (PJ.0 to PJ.3) Pin Functions**

| PIN NAME (PJ.x)                    | x | FUNCTION                       | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |           |           |
|------------------------------------|---|--------------------------------|----------------------------------------|---------|-----------|-----------|
|                                    |   |                                | PJDIR.x                                | PJSEL.x | JTAG MODE | CBPD.y    |
| PJ.0/<br>SMCLK/<br>TDO/<br>CB6     | 0 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | SMCLK                          | 1                                      | 1       | 0         | 0         |
|                                    |   | TDO <sup>(3)</sup>             | X                                      | X       | 1         | X         |
|                                    |   | CB6                            | X                                      | X       | 0         | 1 (y = 6) |
| PJ.1/<br>MCLK/<br>TDI/TCLK/<br>CB7 | 1 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | MCLK                           | 1                                      | 1       | 0         | 0         |
|                                    |   | TDI/TCLK <sup>(3) (4)</sup>    | X                                      | X       | 1         | X         |
|                                    |   | CB7                            | 0                                      | X       | 0         | 1 (y = 7) |
| PJ.2/<br>ADC10CLK/<br>TMS/<br>CB8  | 2 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | ADC10CLK (See <sup>(5)</sup> ) | 1                                      | 1       | 0         | 0         |
|                                    |   | TMS <sup>(3) (4)</sup>         | X                                      | X       | 1         | X         |
|                                    |   | CB8                            | X                                      | X       | 0         | 1 (y = 8) |
| PJ.3/<br>ACLK/<br>TCK/<br>CB9      | 3 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | ACLK                           | 1                                      | 1       | 0         | 0         |
|                                    |   | TCK <sup>(3) (4)</sup>         | X                                      | X       | 1         | X         |
|                                    |   | CB9                            | X                                      | X       | 0         | 1 (y = 9) |

(1) X = Don't care

(2) Default condition

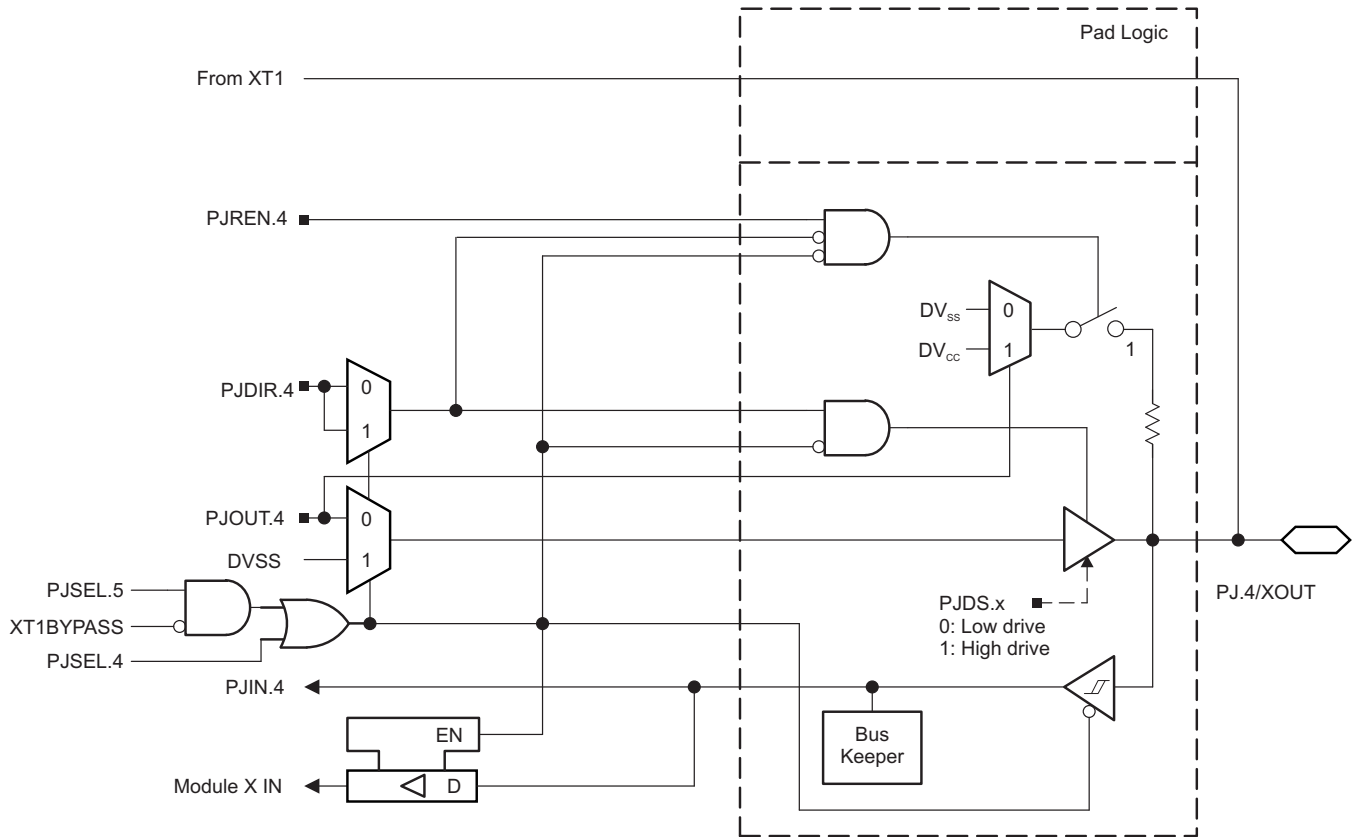
(3) The pin direction is controlled by the JTAG module.

(4) In JTAG mode, pullups are activated automatically on TMS, TCK, and TDI/TCLK. PJREN.x are don't care.

(5) MSP430F51x2 device only.

### 6.10.12 Port J (PJ.4) Input/Output With Schmitt Trigger

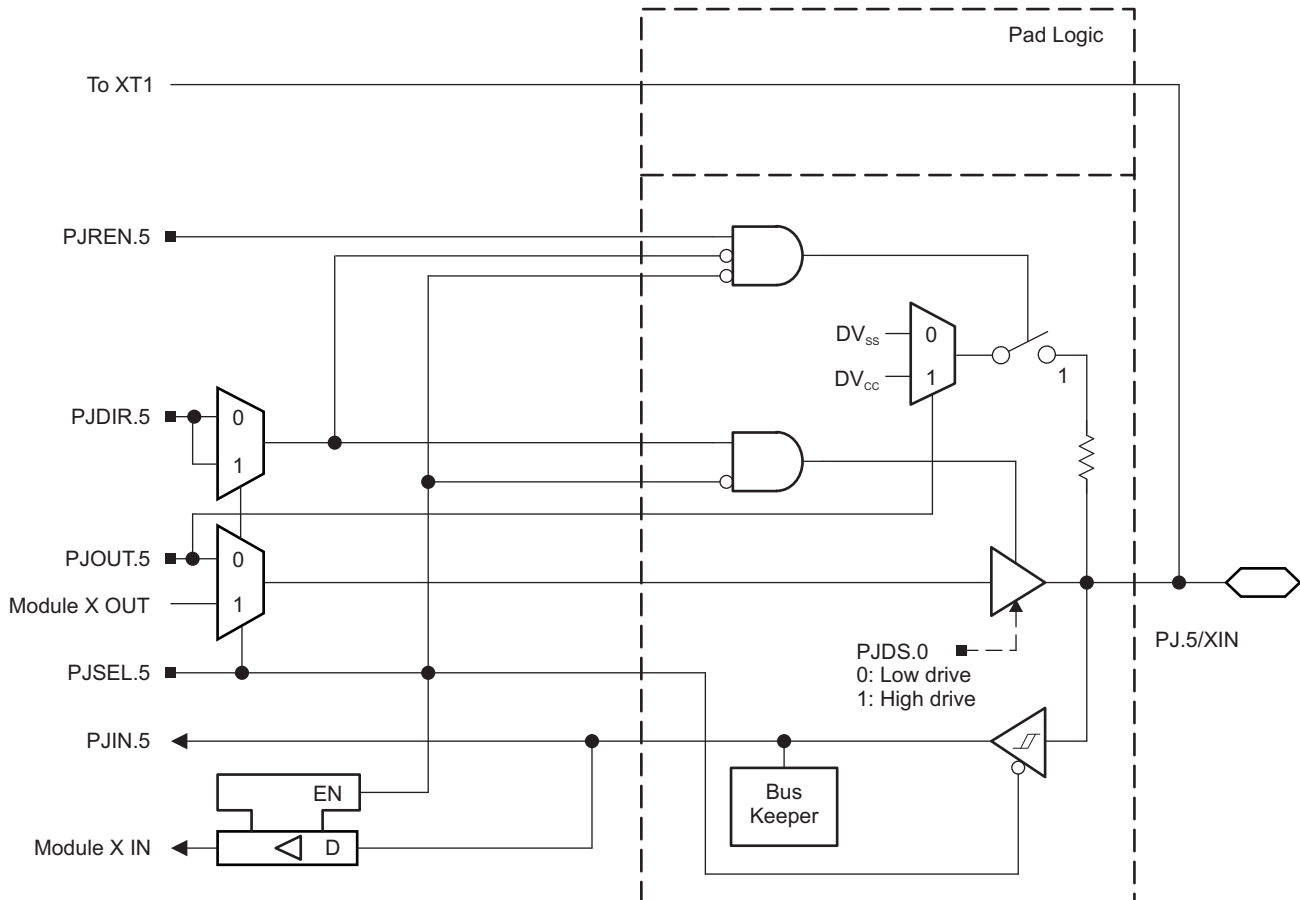
Figure 6-13 shows the port diagram. Table 6-54 summarizes the selection of the pin function.



### Figure 6-13. Port PJ (PJ.4) Diagram

### 6.10.13 Port J (PJ.5) Input/Output With Schmitt Trigger

Figure 6-14 shows the port diagram. Table 6-54 summarizes the selection of the pin function.



### Figure 6-14. Port PJ (PJ.5) Diagram

### Table 6-54. Port PJ (PJ.4 and PJ.5) Pin Functions

| PIN NAME (PJ.x) | x | FUNCTION                         | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |           |
|-----------------|---|----------------------------------|----------------------------------------|---------|---------|-----------|
|                 |   |                                  | PJDIR.x                                | PJSEL.4 | PJSEL.5 | XT1BYPASS |
| PJ.4/<br>XOUT   | 4 | PJ.4 (I/O)                       | I: 0; O: 1                             | 0       | 0       | X         |
|                 |   | XOUT crystal mode <sup>(2)</sup> |                                        |         | 1       | 1         |
| PJ.5/<br>XIN    | 5 | PJ.5 (I/O) <sup>(2)</sup>        | I: 0; O: 1                             | X       | 0       | x         |
|                 |   | XIN crystal mode <sup>(3)</sup>  | X                                      | X       | 1       | 0         |
|                 |   | XIN bypass mode <sup>(3)</sup>   | X                                      | X       | 1       | 1         |

(1)  $X = \text{Don't care}$

(2) Setting PJSEL.5 causes the general-purpose I/O to be disabled in crystal mode. When using bypass mode, PJ.4 can be used as general-purpose I/O.

(3) Setting PJSEL.5 causes the general-purpose I/O to be disabled. Pending the setting of XT1BYPASS, PJ.5 is configured for crystal mode or bypass mode.

#### 6.10.14 Port J (PJ.6) Input/Output With Schmitt Trigger

Figure 6-15 shows the port diagram. Table 6-55 summarizes the selection of the pin function.

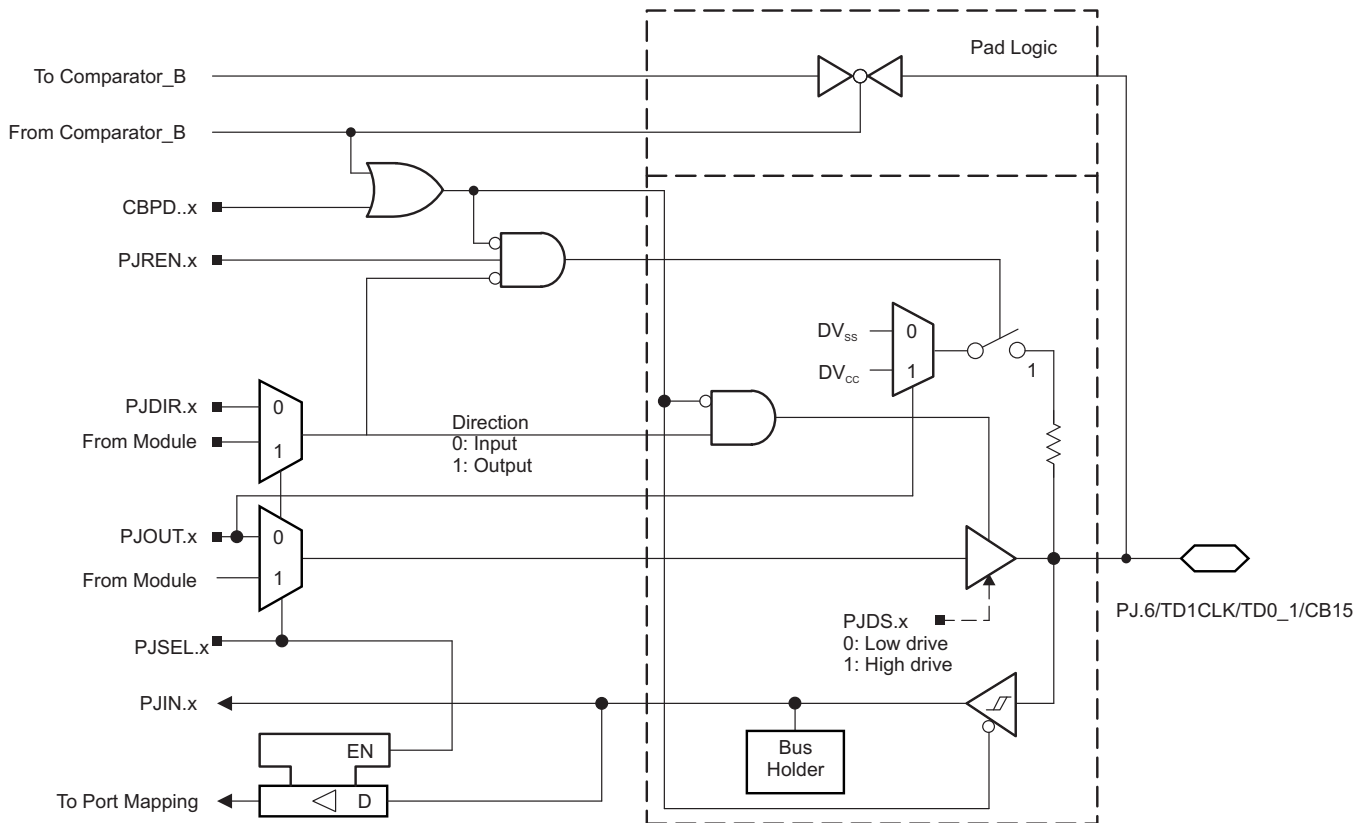


Figure 6-15. Port PJ (PJ.6) Diagram

Table 6-55. Port PJ (PJ.6) Pin Functions

| PIN NAME (PJ.x) | x | FUNCTION        | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |            |
|-----------------|---|-----------------|----------------------------------------|---------|------------|
|                 |   |                 | PJDIR.x                                | PJSEL.x | CBPD.y     |
| PJ.6/           | 6 | PJ.x (I/O)      | I: 0; O: 1                             | 0       | 0          |
| TD1CLK/         |   | TD1 clock input | 0                                      | 1       | 0          |
| TD0.1/          |   | TD0.TA1         | 1                                      | 1       | 0          |
| CB15            |   | CB15            | X                                      | X       | 1 (y = 15) |

(1) X = Don't care

## 6.11 Device Descriptors

Table 6-56 and Table 6-57 list the complete contents of the device descriptor tag-length-value (TLV) structure for the MSP430F51x2 and MSP430F51x1 devices, respectively.

**Table 6-56. MSP430F51x2 Device Descriptor Table<sup>(1)</sup>**

| DESCRIPTION          |                                                | ADDRESS | SIZE<br>(bytes) | VALUE    |          |          |          |          |          |
|----------------------|------------------------------------------------|---------|-----------------|----------|----------|----------|----------|----------|----------|
|                      |                                                |         |                 | F5172    |          | F5152    |          | F5132    |          |
|                      |                                                |         |                 | RSB, YFF | DA       | RSB      | DA       | RSB      | DA       |
| Info Block           | Info length                                    | 0x1A00  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | CRC length                                     | 0x1A01  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | CRC value                                      | 0x1A02  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Device ID                                      | 0x1A04  | 1               | 0x30     | 0x30     | 0x2C     | 0x2C     | 0x28     | 0x28     |
|                      | Device ID                                      | 0x1A05  | 1               | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     |
|                      | Hardware revision                              | 0x1A06  | 1               | 0x30     | 030      | 0x30     | 0x30     | 0x30     | 0x30     |
|                      | Firmware revision                              | 0x1A07  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
| Die Record           | Die record tag                                 | 0x1A08  | 1               | 0x08     | 08       | 0x08     | 08       | 0x08     | 08       |
|                      | Die record length                              | 0x1A09  | 1               | 0x0A     | 0A       | 0x0A     | 0A       | 0x0A     | 0A       |
|                      | Lot/wafer ID                                   | 0x1A0A  | 4               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Die X position                                 | 0x1A0Eh | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Die Y position                                 | 0x1A10  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Test results                                   | 0x1A12  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
| ADC10 Calibration    | ADC10 calibration tag                          | 0x1A14  | 1               | 0x13     | 0x13     | 0x13     | 0x13     | 0x13     | 0x13     |
|                      | ADC10 calibration length                       | 0x1A15  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
|                      | ADC gain factor                                | 0x1A16  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC offset                                     | 0x1A18  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 30°C | 0x1A1A  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 85°C | 0x1A1C  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 30°C | 0x1A1Eh | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 85°C | 0x1A20  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 30°C | 0x1A22  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 85°C | 0x1A24  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
| REF User Calibration | REF tag                                        | 0x1A26  | 1               | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     |
|                      | REF length                                     | 0x1A27  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | REF 1.5-V reference                            | 0x1A28  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.0-V reference                            | 0x1A2A  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.5-V reference                            | 0x1A2C  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
| Timer_D0 Calibration | Timer_D tag                                    | 0x1A2E  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A2F  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A30  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A32  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A34  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A36  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
| Timer_D1 Calibration | Timer_D tag                                    | 0x1A38  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A39  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A3A  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A3C  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A3E  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A40  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |

(1) NA = Not applicable

**Table 6-56. MSP430F51x2 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION              |                              | ADDRESS | SIZE<br>(bytes) | VALUE    |        |         |        |         |        |
|--------------------------|------------------------------|---------|-----------------|----------|--------|---------|--------|---------|--------|
|                          |                              |         |                 | F5172    |        | F5152   |        | F5132   |        |
|                          |                              |         |                 | RSB, YFF | DA     | RSB     | DA     | RSB     | DA     |
| Peripheral<br>Descriptor | Peripheral descriptor tag    | 0x1A42  | 1               | 0x02     | 0x02   | 0x02    | 0x02   | 0x02    | 0x02   |
|                          | Peripheral descriptor length | 0x1A43  | 1               | 0x53     | 0x53   | 0x53    | 0x53   | 0x53    | 0x53   |
|                          | BSL memory                   | 0x1A44  | 2               | 0x8A08   | 0x8A08 | 0x8A08  | 0x8A08 | 0x8A08  | 0x8A08 |
|                          | Information memory           | 0x1A46  | 2               | 0x860C   | 0x860C | 0x860C  | 0x860C | 0x860C  | 0x860C |
|                          | RAM                          | 0x1A48  | 2               | 0x2A0E   | 0x2A0E | 0x2A0E  | 0x2A0E | 0x280E  | 0x280E |
|                          | Main memory                  | 0x1A4A  | 2               | 0x9240   | 0x9240 | 0x9060  | 0x9060 | 0x8E70  | 0x8E70 |
|                          | Delimiter                    | 0x1A4C  | 1               | 0x00     | 0x00   | 0x00    | 0x00   | 0x00    | 0x00   |
|                          | Peripheral count             | 0x1A4D  | 1               | 0x1C     | 0x1C   | 0x1B    | 0x1B   | 0x1B    | 0x1B   |
|                          | MSP430CPUXV2                 | 0x1A4E  | 2               | 0x2300   | 0x2300 | 0x2300  | 0x2300 | 0x2300  | 0x2300 |
|                          | SBW                          | 0x1A50  | 2               | 0x0F00   | 0x0F00 | 0x0F00  | 0x0F00 | 0x0F00  | 0x0F00 |
|                          | EEM-S                        | 0x1A52  | 2               | 0x0300   | 0x0300 | 0x0300  | 0x0300 | 0x0300  | 0x0300 |
|                          | TI BSL                       | 0x1A54  | 2               | 0xFC00   | 0xFC00 | 0xFC00  | 0xFC00 | 0xFC00  | 0xFC00 |
|                          | SFR                          | 0x1A56  | 2               | 0x4110   | 0x4110 | 0x4110  | 0x4110 | 0x4110  | 0x4110 |
|                          | PMM                          | 0x1A58  | 2               | 0x3002   | 0x3002 | 0x3002  | 0x3002 | 0x3002  | 0x3002 |
|                          | FCTL                         | 0x1A5A  | 2               | 0x3802   | 0x3802 | 0x3802  | 0x3802 | 0x3802  | 0x3802 |
|                          | CRC16                        | 0x1A5C  | 2               | 0x3C01   | 0x3C01 | 0x3C01  | 0x3C01 | 0x3C01  | 0x3C01 |
|                          | CRC16_RB                     | 0x1A5E  | 2               | 0x3D00   | 0x3D00 | 0x3D00  | 0x3D00 | 0x3D00  | 0x3D00 |
|                          | RAMCTL                       | 0x1A60  | 2               | 0x4400   | 0x4400 | 0x4400  | 0x4400 | 0x4400  | 0x4400 |
|                          | WDT_A                        | 0x1A62  | 2               | 0x4000   | 0x4000 | 0x4000  | 0x4000 | 0x4000  | 0x4000 |
|                          | UCS                          | 0x1A64  | 2               | 0x4801   | 0x4801 | 0x4801  | 0x4801 | 0x4801  | 0x4801 |
|                          | SYS                          | 0x1A66  | 2               | 0x4202   | 0x4202 | 0x4202  | 0x4202 | 0x4202  | 0x4202 |
|                          | Shared REF                   | 0x1A68  | 2               | 0xA003   | 0xA003 | 0xA003  | 0xA003 | 0xA003  | 0xA003 |
|                          | Port Mapping                 | 0x1A6A  | 2               | 0x1001   | 0x1001 | 0x1001  | 0x1001 | 0x1001  | 0x1001 |
|                          | Port 1/2                     | 0x1A6C  | 2               | 0x5104   | 0x5104 | 0x5104  | 0x5104 | 0x5104  | 0x5104 |
|                          | Port 3/4                     | 0x1A6E  | 2               | 0x5202   | 0x5202 | 0x5202  | 0x5202 | 0x5202  | 0x5202 |
|                          | Port J                       | 0x1A70  | 2               | 0x5F10   | 0x5F10 | 0x5F10  | 0x5F10 | 0x5F10  | 0x5F10 |
|                          | TA0                          | 0x1A72  | 2               | 0x610A   | 0x610A | 0x610A  | 0x610A | 0x610A  | 0x610A |
|                          | MPY32                        | 0x1A74  | 2               | 0x8510   | 0x8510 | 0x8510  | 0x8510 | 0x8510  | 0x8510 |
|                          | DMA with 3 channels          | 0x1A76  | 2               | 0x4704   | 0x4704 | 0x4704  | 0x4704 | 0x4704  | 0x4704 |
|                          | USCI_A0/B0                   | 0x1A78  | 2               | 0x900C   | 0x900C | 0x900C  | 0x900C | 0x900C  | 0x900C |
|                          | ADC10_A                      | 0x1A7A  | 2               | 0xD318   | 0xD318 | 0xD318  | 0xD318 | 0xD318  | 0xD318 |
|                          | COMP_B                       | 0x1A7C  | 2               | 0xA818   | 0xA818 | 0x1A919 | 0xA818 | 0x1A919 | 0xA818 |
|                          | TIMER_D0                     | 0x1A7E  | 2               | 0xD624   | 0xD624 | 0xD624  | 0xD624 | 0xD624  | 0xD624 |
|                          | TIMER_D1                     | 0x1A80  | 2               | 0x6D04   | 0x6D04 | 0x6D04  | 0x6D04 | 0x6D04  | 0x6D04 |
|                          | TEC_0                        | 0x1A82  | 2               | 0x700C   | 0x700C | 0x700C  | 0x700C | 0x700C  | 0x700C |
|                          | TEC_1                        | 0x1A84  | 2               | 0x7002   | 0x7002 | 0x7002  | 0x7002 | 0x7002  | 0x7002 |

**Table 6-56. MSP430F51x2 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION |               | ADDRESS         | SIZE<br>(bytes) | VALUE    |      |       |      |       |      |
|-------------|---------------|-----------------|-----------------|----------|------|-------|------|-------|------|
|             |               |                 |                 | F5172    |      | F5152 |      | F5132 |      |
|             |               |                 |                 | RSB, YFF | DA   | RSB   | DA   | RSB   | DA   |
| Interrupts  | COMP_B        | 0x1A86          | 1               | 0xA8     | 0xA8 | 0xA8  | 0xA8 | 0xA8  | 0xA8 |
|             | TEC_0         | 0x1A87          | 1               | 0x6D     | 0x6D | 0x6D  | 0x6D | 0x6D  | 0x6D |
|             | TIMER_D0      | 0x1A88          | 1               | 0x62     | 0x62 | 0x62  | 0x62 | 0x62  | 0x62 |
|             | TIMER_D0      | 0x1A89          | 1               | 0x63     | 0x63 | 0x63  | 0x63 | 0x63  | 0x63 |
|             | WDTIFG        | 0x1A8A          | 1               | 0x40     | 0x40 | 0x40  | 0x40 | 0x40  | 0x40 |
|             | USCI_A0       | 0x1A8B          | 1               | 0x90     | 0x90 | 0x90  | 0x90 | 0x90  | 0x90 |
|             | USCI_B0       | 0x1A8C          | 1               | 0x91     | 0x91 | 0x91  | 0x91 | 0x91  | 0x91 |
|             | ADC10_A       | 0x1A8D          | 1               | 0xD0     | 0xD0 | 0xD0  | 0xD0 | 0xD0  | 0xD0 |
|             | TA0.CCIFG0    | 0x1A8E          | 1               | 0x60     | 0x60 | 0x60  | 0x60 | 0x60  | 0x60 |
|             | TA0.CCIFG1..4 | 0x1A8F          | 1               | 0x61     | 0x61 | 0x61  | 0x61 | 0x61  | 0x61 |
|             | DMA           | 0x1A90          | 1               | 0x46     | 0x46 | 0x46  | 0x46 | 0x46  | 0x46 |
|             | TEC_1         | 0x1A91          | 1               | 0x6E     | 0x6E | 0x6E  | 0x6E | 0x6E  | 0x6E |
|             | TIMER_D1      | 0x1A92          | 1               | 0x64     | 0x64 | 0x64  | 0x64 | 0x64  | 0x64 |
|             | TIMER_D1      | 0x1A93          | 1               | 0x65     | 0x65 | 0x65  | 0x65 | 0x65  | 0x65 |
|             | Port P1       | 0x1A94          | 1               | 0x50     | 0x50 | 0x50  | 0x50 | 0x50  | 0x50 |
|             | Port P2       | 0x1A95          | 1               | 0x51     | 0x51 | 0x51  | 0x51 | 0x51  | 0x51 |
|             | Delimiter     | 0x1A96          | 1               | 0x00     | 0x00 | 0x00  | 0x00 | 0x00  | 0x00 |
| Empty       | Unused memory | 0x1A97 - 0x1AB9 |                 | 0xFF     | 0xFF | 0xFF  | 0xFF | 0xFF  | 0xFF |

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup>**

| DESCRIPTION |                   | ADDRESS | SIZE<br>(bytes) | VALUE    |          |          |          |          |          |
|-------------|-------------------|---------|-----------------|----------|----------|----------|----------|----------|----------|
|             |                   |         |                 | F5171    |          | F5151    |          | F5131    |          |
|             |                   |         |                 | RSB      | DA       | RSB      | DA       | RSB      | DA       |
| Info Block  | Info length       | 0x1A00  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|             | CRC length        | 0x1A01  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|             | CRC value         | 0x1A02  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|             | Device ID         | 0x1A04  | 1               | 0x2E     | 0x2E     | 0x2A     | 0x2A     | 0x26     | 0x26     |
|             | Device ID         | 0x1A05  | 1               | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     |
|             | Hardware revision | 0x1A06  | 1               | 0x30     | 0x30     | 0x30     | 0x30     | 0x30     | 0x30     |
|             | Firmware revision | 0x1A07  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
| Die Record  | Die record tag    | 0x1A08  | 1               | 0x08     | 08       | 0x08     | 08       | 0x08     | 08       |
|             | Die record length | 0x1A09  | 1               | 0x0A     | 0A       | 0x0A     | 0A       | 0x0A     | 0A       |
|             | Lot/wafer ID      | 0x1A0A  | 4               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|             | Die X position    | 0x1A0Eh | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|             | Die Y position    | 0x1A10  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|             | Test results      | 0x1A12  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |

(1) NA = Not applicable

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION          |                                                | ADDRESS | SIZE<br>(bytes) | VALUE    |          |          |          |          |          |
|----------------------|------------------------------------------------|---------|-----------------|----------|----------|----------|----------|----------|----------|
|                      |                                                |         |                 | F5171    |          | F5151    |          | F5131    |          |
|                      |                                                |         |                 | RSB      | DA       | RSB      | DA       | RSB      | DA       |
| ADC10 Calibration    | ADC10 calibration tag                          | 0x1A14  | 1               | 0x05     | 0x05     | 0x05     | 0x05     | 0x05     | 0x05     |
|                      | ADC10 calibration length                       | 0x1A15  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
|                      | ADC gain factor                                | 0x1A16  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC offset                                     | 0x1A18  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 30°C | 0x1A1A  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 85°C | 0x1A1C  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 30°C | 0x1A1Eh | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 85°C | 0x1A20  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 30°C | 0x1A22  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 85°C | 0x1A24  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
| REF User Calibration | REF tag                                        | 0x1A26  | 1               | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     |
|                      | REF length                                     | 0x1A27  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | REF 1.5-V reference                            | 0x1A28  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.0-V reference                            | 0x1A2A  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.5-V reference                            | 0x1A2C  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
| Timer_D0 Calibration | Timer_D tag                                    | 0x1A2E  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A2F  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A30  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A32  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A34  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A36  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
| Timer_D1 Calibration | Timer_D tag                                    | 0x1A38  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A39  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A3A  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A3C  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A3E  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A40  | 2               | Per unit | Per unit | Per unit | Per unit | Per unit | Per unit |

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION              |                              | ADDRESS | SIZE<br>(bytes) | VALUE  |        |        |        |        |        |
|--------------------------|------------------------------|---------|-----------------|--------|--------|--------|--------|--------|--------|
|                          |                              |         |                 | F5171  |        | F5151  |        | F5131  |        |
|                          |                              |         |                 | RSB    | DA     | RSB    | DA     | RSB    | DA     |
| Peripheral<br>Descriptor | Peripheral descriptor tag    | 0x1A42  | 1               | 0x02   | 0x02   | 0x02   | 0x02   | 0x02   | 0x02   |
|                          | Peripheral descriptor length | 0x1A43  | 1               | 0x51   | 0x51   | 0x51   | 0x51   | 0x51   | 0x51   |
|                          | BSL memory                   | 0x1A44  | 2               | 0x8A08 | 0x8A08 | 0x8A08 | 0x8A08 | 0x8A08 | 0x8A08 |
|                          | Information memory           | 0x1A46  | 2               | 0x860C | 0x860C | 0x860C | 0x860C | 0x860C | 0x860C |
|                          | RAM                          | 0x1A48  | 2               | 0x2A0E | 0x2A0E | 0x2A0E | 0x2A0E | 0x280E | 0x280E |
|                          | Main memory                  | 0x1A4A  | 2               | 0x9240 | 0x9240 | 0x9060 | 0x9060 | 0x8E70 | 0x8E70 |
|                          | Delimiter                    | 0x1A4C  | 1               | 0x00   | 0x00   | 0x00   | 0x00   | 0x00   | 0x00   |
|                          | Peripheral count             | 0x1A4D  | 1               | 0x1B   | 0x1B   | 0x1B   | 0x1B   | 0x1B   | 0x1B   |
|                          | MSP430CPUXV2                 | 0x1A4E  | 2               | 0x2300 | 0x2300 | 0x2300 | 0x2300 | 0x2300 | 0x2300 |
|                          | SBW                          | 0x1A50  | 2               | 0x0F00 | 0x0F00 | 0x0F00 | 0x0F00 | 0x0F00 | 0x0F00 |
|                          | EEM-S                        | 0x1A52  | 2               | 0x0300 | 0x0300 | 0x0300 | 0x0300 | 0x0300 | 0x0300 |
|                          | TI BSL                       | 0x1A54  | 2               | 0xFC00 | 0xFC00 | 0xFC00 | 0xFC00 | 0xFC00 | 0xFC00 |
|                          | SFR                          | 0x1A56  | 2               | 0x4110 | 0x4110 | 0x4110 | 0x4110 | 0x4110 | 0x4110 |
|                          | PMM                          | 0x1A58  | 2               | 0x3002 | 0x3002 | 0x3002 | 0x3002 | 0x3002 | 0x3002 |
|                          | FCTL                         | 0x1A5A  | 2               | 0x3802 | 0x3802 | 0x3802 | 0x3802 | 0x3802 | 0x3802 |
|                          | CRC16                        | 0x1A5C  | 2               | 0x3C01 | 0x3C01 | 0x3C01 | 0x3C01 | 0x3C01 | 0x3C01 |
|                          | CRC16_RB                     | 0x1A5E  | 2               | 0x3D00 | 0x3D00 | 0x3D00 | 0x3D00 | 0x3D00 | 0x3D00 |
|                          | RAMCTL                       | 0x1A60  | 2               | 0x4400 | 0x4400 | 0x4400 | 0x4400 | 0x4400 | 0x4400 |
|                          | WDT_A                        | 0x1A62  | 2               | 0x4000 | 0x4000 | 0x4000 | 0x4000 | 0x4000 | 0x4000 |
|                          | UCS                          | 0x1A64  | 2               | 0x4801 | 0x4801 | 0x4801 | 0x4801 | 0x4801 | 0x4801 |
|                          | SYS                          | 0x1A66  | 2               | 0x4202 | 0x4202 | 0x4202 | 0x4202 | 0x4202 | 0x4202 |
|                          | Shared REF                   | 0x1A68  | 2               | 0xA003 | 0xA003 | 0xA003 | 0xA003 | 0xA003 | 0xA003 |
|                          | Port Mapping                 | 0x1A6A  | 2               | 0x1001 | 0x1001 | 0x1001 | 0x1001 | 0x1001 | 0x1001 |
|                          | Port 1/2                     | 0x1A6C  | 2               | 0x5104 | 0x5104 | 0x5104 | 0x5104 | 0x5104 | 0x5104 |
|                          | Port 3/4                     | 0x1A6E  | 2               | 0x5202 | 0x5202 | 0x5202 | 0x5202 | 0x5202 | 0x5202 |
|                          | Port J                       | 0x1A70  | 2               | 0x5F10 | 0x5F10 | 0x5F10 | 0x5F10 | 0x5F10 | 0x5F10 |
|                          | TA0                          | 0x1A72  | 2               | 0x610A | 0x610A | 0x610A | 0x610A | 0x610A | 0x610A |
|                          | MPY32                        | 0x1A74  | 2               | 0x8510 | 0x8510 | 0x8510 | 0x8510 | 0x8510 | 0x8510 |
|                          | DMA with 3 channels          | 0x1A76  | 2               | 0x4704 | 0x4704 | 0x4704 | 0x4704 | 0x4704 | 0x4704 |
|                          | USCI_A0/B0                   | 0x1A78  | 2               | 0x900C | 0x900C | 0x900C | 0x900C | 0x900C | 0x900C |
|                          | COMP_B                       | 0x1A7A  | 2               | 0xA830 | 0xA830 | 0xA830 | 0xA830 | 0xA830 | 0xA830 |
|                          | TIMER_D0                     | 0x1A7C  | 2               | 0xD624 | 0xD624 | 0xD624 | 0xD624 | 0xD624 | 0xD624 |
|                          | TIMER_D1                     | 0x1A7E  | 2               | 0x6D04 | 0x6D04 | 0x6D04 | 0x6D04 | 0x6D04 | 0x6D04 |
|                          | TEC_0                        | 0x1A80  | 2               | 0x700C | 0x700C | 0x700C | 0x700C | 0x700C | 0x700C |
|                          | TEC_1                        | 0x1A82  | 2               | 0x7002 | 0x7002 | 0x7002 | 0x7002 | 0x7002 | 0x7002 |

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION |               | ADDRESS           | SIZE<br>(bytes) | VALUE |      |       |      |       |      |
|-------------|---------------|-------------------|-----------------|-------|------|-------|------|-------|------|
|             |               |                   |                 | F5171 |      | F5151 |      | F5131 |      |
|             |               |                   |                 | RSB   | DA   | RSB   | DA   | RSB   | DA   |
| Interrupts  | COMP_B        | 0x1A83            | 1               | 0xA8  | 0xA8 | 0xA8  | 0xA8 | 0xA8  | 0xA8 |
|             | TEC_0         | 0x1A84            | 1               | 0x6D  | 0x6D | 0x6D  | 0x6D | 0x6D  | 0x6D |
|             | TIMER_D0      | 0x1A85            | 1               | 0x62  | 0x62 | 0x62  | 0x62 | 0x62  | 0x62 |
|             | TIMER_D0      | 0x1A86            | 1               | 0x63  | 0x63 | 0x63  | 0x63 | 0x63  | 0x63 |
|             | WDTIFG        | 0x1A87            | 1               | 0x40  | 0x40 | 0x40  | 0x40 | 0x40  | 0x40 |
|             | USCI_A0       | 0x1A88            | 1               | 0x90  | 0x90 | 0x90  | 0x90 | 0x90  | 0x90 |
|             | USCI_B0       | 0x1A89            | 1               | 0x91  | 0x91 | 0x91  | 0x91 | 0x91  | 0x91 |
|             | ADC10_A       | 0x1A8A            | 1               | 0xD0  | 0xD0 | 0xD0  | 0xD0 | 0xD0  | 0xD0 |
|             | TA0.CCIFG0    | 0x1A8B            | 1               | 0x60  | 0x60 | 0x60  | 0x60 | 0x60  | 0x60 |
|             | TA0.CCIFG1..4 | 0x1A8C            | 1               | 0x61  | 0x61 | 0x61  | 0x61 | 0x61  | 0x61 |
|             | DMA           | 0x1A8D            | 1               | 0x46  | 0x46 | 0x46  | 0x46 | 0x46  | 0x46 |
|             | TEC_1         | 0x1A8E            | 1               | 0x6E  | 0x6E | 0x6E  | 0x6E | 0x6E  | 0x6E |
|             | TIMER_D1      | 0x1A8F            | 1               | 0x64  | 0x64 | 0x64  | 0x64 | 0x64  | 0x64 |
|             | TIMER_D1      | 0x1A90            | 1               | 0x65  | 0x65 | 0x65  | 0x65 | 0x65  | 0x65 |
|             | Port P1       | 0x1A91            | 1               | 0x50  | 0x50 | 0x50  | 0x50 | 0x50  | 0x50 |
|             | Port P2       | 0x1A92            | 1               | 0x51  | 0x51 | 0x51  | 0x51 | 0x51  | 0x51 |
|             | Delimiter     | 0x1A93            | 1               | 0x00  | 0x00 | 0x00  | 0x00 | 0x00  | 0x00 |
| Empty       | Unused Memory | 0x1A94–<br>0x1AB9 |                 | 0xFF  | 0xFF | 0xFF  | 0xFF | 0xFF  | 0xFF |

## 7 デバイスおよびドキュメントのサポート

### 7.1 使い始めと次の手順

MSP430ファミリのデバイス、および開発に役立つツールやライブラリの詳細については、「[MSP430™ 超低消費電力センシング / 測定マイコンの概要](#)」ページを参照してください。

### 7.2 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

**XMS** – Experimental device that is not necessarily representative of the final device's electrical specifications

**MSP** – Fully qualified production device

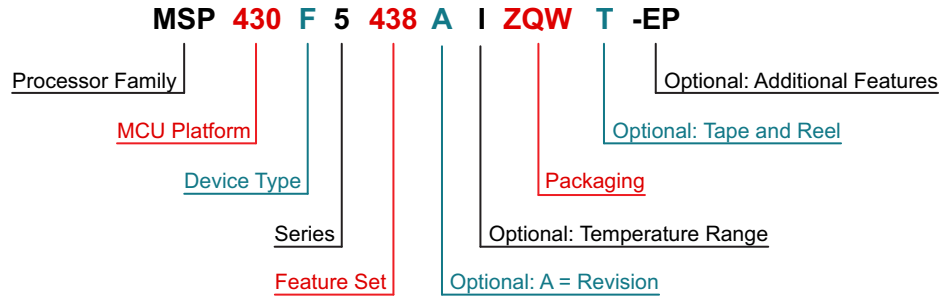
XMS devices are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format. [Figure 7-1](#) provides a legend for reading the complete device name.



|                                      |                                                                                                                                |                                                                                                                                                                                             |
|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Processor Family</b>              | CC = Embedded RF Radio<br>MSP = Mixed-Signal Processor<br>XMS = Experimental Silicon<br>PMS = Prototype Device                 |                                                                                                                                                                                             |
| <b>MCU Platform</b>                  | 430 = MSP430 low-power microcontroller platform                                                                                |                                                                                                                                                                                             |
| <b>Device Type</b>                   | <b>Memory Type</b><br>C = ROM<br>F = Flash<br>FR = FRAM<br>G = Flash or FRAM (Value Line)<br>L = No Nonvolatile Memory         | <b>Specialized Application</b><br>AFE = Analog Front End<br>BQ = Contactless Power<br>CG = ROM Medical<br>FE = Flash Energy Meter<br>FG = Flash Medical<br>FW = Flash Electronic Flow Meter |
| <b>Series</b>                        | 1 = Up to 8 MHz<br>2 = Up to 16 MHz<br>3 = Legacy<br>4 = Up to 16 MHz with LCD                                                 | 5 = Up to 25 MHz<br>6 = Up to 25 MHz with LCD<br>0 = Low-Voltage Series                                                                                                                     |
| <b>Feature Set</b>                   | Various levels of integration within a series                                                                                  |                                                                                                                                                                                             |
| <b>Optional: A = Revision</b>        | N/A                                                                                                                            |                                                                                                                                                                                             |
| <b>Optional: Temperature Range</b>   | S = 0°C to 50°C<br>C = 0°C to 70°C<br>I = -40°C to 85°C<br>T = -40°C to 105°C                                                  |                                                                                                                                                                                             |
| <b>Packaging</b>                     | <a href="http://www.ti.com/packaging">http://www.ti.com/packaging</a>                                                          |                                                                                                                                                                                             |
| <b>Optional: Tape and Reel</b>       | T = Small reel<br>R = Large reel<br>No markings = Tube or tray                                                                 |                                                                                                                                                                                             |
| <b>Optional: Additional Features</b> | -EP = Enhanced Product (-40°C to 105°C)<br>-HT = Extreme Temperature Parts (-55°C to 150°C)<br>-Q1 = Automotive Q100 Qualified |                                                                                                                                                                                             |

## ☒ 7-1. Device Nomenclature

## 7.3 ツールとソフトウェア

すべてのMSPマイクロコントローラは、広範なソフトウェアおよびハードウェア開発ツールによりサポートされています。ツールは、TIおよびさまざまなサードパーティーから入手できます。すべての一覧は「[MSP430超低消費電力マイコン – ツールとソフトウェア](#)」で参照できます。

これらのMCUのデバッグ機能の一覧を、表 7-1 に示します。利用可能な機能の詳細については、『[MSP430用Code Composer Studio IDEユーザー・ガイド](#)』を参照してください。

表 7-1. ハードウェアのデバッグ機能

| MSP430のアーキテクチャ | 4線式JTAG | 2線式JTAG | ブレーク・ポイント (N) | 範囲ブレーク・ポイント | クロック制御 | 状態シーケンサ | トレース・バッファ | LPMx.5デバッグ・サポート |
|----------------|---------|---------|---------------|-------------|--------|---------|-----------|-----------------|
| MSP430Xv2      | ○       | ○       | 3             | ○           | ○      | ×       | ×         | ×               |

### 設計キットと評価モジュール

**MSP430 40ピン・パッケージ・ボード/USBプログラマ** MSP-FET430U40はスタンドアロンの40ピンZIFソケット・ターゲット・ボードで、JTAGインターフェイスまたはSpy Bi-Wire (2線式のJTAG)プロトコル、およびMSP-FETフラッシュ・エミュレーション・ツールによるイン・システムでのMSP430のプログラムとデバッグに使用できます。

**MSP430F5x MCU用のMSP430 40ピン・ターゲット開発ボード** MSP-TS430RSB40はスタンドアロンの40ピンZIFソケット・ターゲット・ボードで、JTAGインターフェイスまたはSpy Bi-Wire (2線式のJTAG)プロトコルによるイン・システムでのMSP430 MCUのプログラムとデバッグに使用できます。

### ソフトウェア

**MSP430Ware™ソフトウェア** MSP430Wareソフトウェアは、すべてのMSP430デバイス向けのサンプル・コード、データシート、その他の設計リソースを、1つの便利なパッケージとしてまとめたものです。既存のMSP430用設計リソースの完全なコレクションに加えて、MSP430WareソフトウェアにはMSPドライバ・ライブラリという高レベルのAPIも含まれています。このライブラリにより、MSP430ハードウェアを簡単にプログラムできます。MSP430Wareソフトウェアは、Code Composer Studio™IDEのコンポーネントとして、またはスタンドアロンのパッケージとして供給されています。

**MSP430F51x2、MSP430F51x1のサンプル・コード** すべてのMSPデバイス用に、内蔵する各ペリフェラルをさまざまな用途のニーズに合わせて構成するためのCコード・サンプルが用意されています。

**MSPドライバ・ライブラリ** ドライバ・ライブラリの抽象化APIで、使いやすい関数呼び出しが用意されており、MSP430ハードウェアのビットやバイトのレベルを意識せずに、より高水準の開発作業に集中できます。使いやすいAPIガイドにより包括的な技術資料が参照でき、それぞれの関数呼び出しと、認識されるパラメータの詳細が記載されています。開発者は、ドライバ・ライブラリの関数を使用して、最小限のオーバーヘッドで完全なプロジェクトを作成できます。

**MSP EnergyTrace™テクノロジー** MSP430マイクロコントローラ用のEnergyTraceテクノロジーは、エネルギーを基準としたコード解析ツールで、アプリケーションのエネルギー・プロファイルを測定して表示し、消費電力が極めて低くなるよう最適化するため役立ちます。

**ULP (超低消費電力) Advisor** ULP Advisor™ソフトウェアは、MSPおよびMSP432マイクロコントローラ独自の超低消費電力機能を十分に活用できる、最も効率的なコードを開発者が作成できるよう手引きするツールです。ULP Advisorは、マイクロコントローラの熟練した開発者でも、新しい開発者でも使用でき、包括的なULPチェックリストと照らし合わせてコードのチェックを行い、アプリケーションの性能を最大限まで発揮できるようにします。ビルド時に、消費電力低減のためさらに最適化が可能なコードの部分を明らかにするため通知と注釈を出力します。

**IEC60730ソフトウェア・パッケージ** IEC60730 MSP430ソフトウェア・パッケージは、クラスBまでの製品について、お客様がIEC 60730-1:2010 (家庭および同様な用途に使用される自動電気制御 – 第1部: 一般的な要件)に準拠するため役立つよう開発されています。この分類には家電機器、アーク検出器、電力コンバータ、電動工具、電動アシスト自転車、その他多くの製品が含まれます。IEC60730 MSP430ソフトウェア・パッケージは、MSP430で実行するお客様のアプリケーションに組み込むことができるため、消費者向けデバイスがIEC 60730-1:2010クラスBの機能安全性に準拠していることの認定作業を簡素化できます。

**MSP用の固定小数点算術ライブラリ** MSP IQmathおよびQmathライブラリは、Cプログラマ向けの高度に最適化された高精度の算術関数のコレクションで、浮動小数点アルゴリズムをMSP430およびMSP432デバイスの固定小数点コードへシームレスに移行できます。これらのルーチンは通常、最適な実行速度、高精度、超低消費電力が重視される、演算集中型のリアルタイム・アプリケーションで使用されます。IQmathライブラリとQmathライブラリを使用すると、浮動小数点演算を使用して記述した同等のコードに比べて、実行速度を大幅に高速化するとともに、消費電力の大幅な削減が可能です。

**MSP430用の浮動小数点算術ライブラリ** 低消費電力かつ低コストのマイクロコントローラ分野で継続的な革新を行うため、TIはMSPMATHLIBを提供しています。このスカラー関数の浮動小数点数値演算ライブラリは、弊社デバイスのインテリジェントなペリフェラルを活用し、最高26倍の性能を実現します。Mathlibは、設計へ簡単に組み入れることができます。このライブラリは無償で、Code Composer Studio と IAR IDE の両方に組み込まれています。数値演算ライブラリと関連ベンチマークの詳細については、ユーザー・ガイドを参照してください。

## 開発ツール

**Code Composer Studio™: MSPマイクロコントローラ用の統合開発環境** Code Composer Studioは、すべてのMSPマイクロコントローラ・デバイスをサポートする統合開発環境(IDE)です。Code Composer Studioは、組み込みアプリケーションの開発とデバッグに使用される、組み込み用ソフトウェア・ユーティリティのスイートです。最適化C/C++コンパイラ、ソース・コード・エディタ、プロジェクト・ビルド環境、デバッグ、プロファイラなど、多数の機能が含まれています。IDEは直感的で、アプリケーションの開発フローの各段階を、すべて同一のユーザー・インターフェイスで実行できます。使い慣れたユーティリティとインターフェイスにより、ユーザーは従来より迅速に作業を開始できます。Code Composer Studioは、Eclipseソフトウェア・フレームワークの利点と、TIの先進的な組み込みデバッグ機能の利点を組み合わせ、組み込み製品の開発者向けの魅力的な、豊富な機能を持つ開発環境を実現します。CCSをMSP MCUとともに使用すると、MSPマイクロコントローラを最大限に活用するための、ユニークで強力な一連のプラグインや組み込みソフトウェア・ユーティリティを利用できます。

**コマンドライン・プログラマ** MSP Flasher は、FETプログラマまたは eZ430 を経由し、JTAG または Spy-Bi-Wire (SBW) 通信を使用して MSP マイクロコントローラをプログラムするための、オープン・ソースでシェルスクリプトベースのインターフェイスです。MSP Flasher は、IDE を使用せずにバイナリ・ファイル (.txtまたは.hex) をMSPマイクロコントローラへ直接ダウンロードできます。

**MSP MCUプログラマおよびデバッグ** MSP-FETは強力なエミュレーション開発ツールで、多くの場合、デバッグ・プローブと呼ばれています。ユーザーはこのツールを使用して、MSP低消費電力マイクロコントローラ(MCU)のアプリケーション開発を迅速に開始できます。MCUのソフトウェアを作成する場合は通常、結果として得られたバイナリ・プログラムをMSPデバイスにダウンロードし、検証とデバッグを行う必要があります。MSP-FETは、ホスト・コンピュータとターゲットMSPの間で、デバッグ通信経路を提供します。さらに、MSP-FETはコンピュータのUSBインターフェイスとMSP UARTの間で、バックチャネルUART接続も提供します。これにより、MSPプログラマは、コンピュータ上で動作している端末ソフトウェアとMSPとの間で、シリアル通信を簡単に実行できます。また、UARTやI<sup>2</sup>C通信プロトコルを経由するBSL (ブートローダー) を使用して、プログラム (多くの場合、ファームウェアと呼ばれます) をMSPターゲットにロードできます。

**MSP-GANG量産プログラマ** MSP Gang ProgrammerはMSP430またはMSP432用のデバイス・プログラマで、8つまでの同一のMSP430またはMSP432フラッシュまたはFRAMデバイスを同時にプログラムできます。MSP Gang Programmerは、標準のRS-232またはUSB接続を使用してホストPCに接続でき、柔軟なプログラミング・オプションにより、プロセスを完全にカスタマイズ可能です。MSP Gang Programmer には、Gang Splitter と呼ばれる拡張ボードが付属しており、MSP Gang Programmer と複数のターゲット・デバイスとの間で相互接続機能を実装します。拡張ボードと、8つのターゲット・デバイスとを接続するため、8本のケーブルが付属しています(JTAGまたはSpy-Bi-Wireコネクタ経由)。PCを使用してプログラムすることも、スタンドアロンのデバイスとしてプログラムすることもできます。PC側のグラフィカル・ユーザー・インターフェイスも用意されており、DLL ベースです。

## 7.4 ドキュメントのサポート

次のドキュメントには、MSP430F51x2およびMSP430F51x1デバイスについて記載されています。これらのドキュメントのコピーは、[www.ti.com](http://www.ti.com)で入手できます。

### ドキュメントの更新通知を受け取る方法

ドキュメント更新の通知を、シリコンの正誤表も含めて受け取るには、[ti.com](http://ti.com)でお使いの製品のフォルダへ移動します(プロダクト・フォルダへのリンクについては、[7.5](#)を参照してください)。右上の隅にある「通知を受け取る」ボタンをクリックします。これによって登録が行われ、変更された製品情報の概要を毎週受け取ることができます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

### 正誤表

『**MSP430F5172デバイス正誤表**』 このデバイスにおけるすべてのシリコンのリビジョンについて、機能仕様に関する既知の例外が記載されています。

『**MSP430F5152デバイス正誤表**』 このデバイスにおけるすべてのシリコンのリビジョンについて、機能仕様に関する既知の例外が記載されています。

『**MSP430F5132デバイス正誤表**』 このデバイスにおけるすべてのシリコンのリビジョンについて、機能仕様に関する既知の例外が記載されています。

『**MSP430F5171デバイス正誤表**』 このデバイスにおけるすべてのシリコンのリビジョンについて、機能仕様に関する既知の例外が記載されています。

『**MSP430F5151デバイス正誤表**』 このデバイスにおけるすべてのシリコンのリビジョンについて、機能仕様に関する既知の例外が記載されています。

『**MSP430F5131デバイス正誤表**』 このデバイスにおけるすべてのシリコンのリビジョンについて、機能仕様に関する既知の例外が記載されています。

### ユーザー・ガイド

『**MSP430x5xxおよびMSP430x6xxファミリ・ユーザー・ガイド**』 このデバイス・ファミリで利用可能なモジュールとペリフェラルについての詳細情報です。

『**MSP430 フラッシュ・デバイス・ブートローダ(BSL)ユーザー・ガイド**』 MSP430ブートローダ(BSL)を使用すると、プロトタイプ作成フェーズ、最終的な量産、およびサービス中に、MSP430マイクロコントローラの組み込みメモリと通信を行うことができます。必要に応じて、プログラム可能メモリ(フラッシュ・メモリ)とデータ・メモリ(RAM)の両方を変更できます。このブートローダは、一部のデジタル・シグナル・プロセッサ(DSP)に見られる、外部メモリからDSPの内部メモリへプログラム・コード(およびデータ)を自動的にロードする、ブートストラップ・ローダ・プログラムとは異なることに注意してください。

『**JTAGインターフェイスによるMSP430のプログラミング**』 このドキュメントでは、JTAG通信ポートを使用してMSP430のフラッシュ・ベースおよびFRAMベースのマイクロコントローラ・ファミリのメモリ・モジュールを消去、プログラム、検証するために必要な機能について解説しています。さらに、すべてのMSP430デバイスで利用可能なJTAGアクセス・セキュリティ・ヒューズのプロダクト方法についても解説しています。このドキュメントには、標準の4線式JTAGインターフェイスと2線式JTAGインターフェイスの両方を使用してデバイスにアクセスする方法が解説されています。2線式JTAGインターフェイスはSpy-Bi-Wire (SBW)とも呼ばれます。

『**MSP430ハードウェア・ツール ユーザー・ガイド**』 このマニュアルには、TI MSP-FET430フラッシュ・エミュレーション・ツール(FET)のハードウェアについて解説されています。このFETは、MSP430 超低消費電力マイクロコントローラ用のプログラム開発ツールです。利用可能なインターフェイスとして、パラレル・ポート・インターフェイスとUSBインターフェイスの両方について解説されています。

### アプリケーション・レポート

『**MSP430 32kHz水晶発振器**』 適切な水晶、正しい負荷回路、および適切な基板レイアウトの選択は、安定した水晶発振器のために重要です。このアプリケーション・レポートでは、水晶発振器の機能について要約し、MSP430の超低消費電力動作の適切な水晶を選択するためのパラメータについて説明します。また、正しい基板レイアウトについてのヒントや例も紹介しています。このドキュメントには、量産時の安定した発振器の動作を保証するために行うことができる、発振器のテストについての詳細情報も記載されています。

『**MSP430 システム・レベルESDの考慮事項**』 シリコン・テクノロジーがますます低電圧化し、コスト効率に優れ非常に消費電力の低いコンポーネントを設計する必要性が高まっていくにつれ、システム・レベルESDの要求はますます高くなりつつあります。このアプリケーション・レポートでは、基板設計者とOEMが堅牢なシステム・レベルのデザインを理解し設計できるよう、3種類の異なるESDトピックについて扱います。(1) コンポーネント・レベルESDテストとシステム・レベルESDテスト、その違い、コンポーネント・レベルESD評価ではシステム・レベルの耐性が保証されない理由。(2) 筐体、ケーブル、PCBレイアウト、オンボードのESD保護デバイスなど各レベルにおいてシステム・レベルのESD保護を行うための、一般的な設計ガイドライン。(3) System Efficient ESD Design (SEED)の概要、システム・レベルESD耐性を達成するオンボードおよびオンチップESD保護のコードデザイン手法、サンプル・シミュレーションとテスト結果。現実世界でのシステム・レベルのESD保護設計の例のいくつかと、その結果についても解説します。

## 7.5 関連リンク

表 7-2 に、クイック・アクセス・リンクの一覧を示します。カテゴリには、技術資料、サポートおよびコミュニティ・リソース、ツールとソフトウェア、およびサンプル注文またはご購入へのクイック・アクセスが含まれます。

表 7-2. 関連リンク

| 製品          | プロダクト・フォルダ              | ご注文はこちら                 | 技術資料                    | ツールとソフトウェア              | サポートとコミュニティ             |
|-------------|-------------------------|-------------------------|-------------------------|-------------------------|-------------------------|
| MSP430F5172 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |
| MSP430F5152 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |
| MSP430F5132 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |
| MSP430F5171 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |
| MSP430F5151 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |
| MSP430F5131 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |

## 7.6 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### TI E2E™ Community

TI's *Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas, and help solve problems with fellow engineers.

### TI Embedded Processors Wiki

*Texas Instruments Embedded Processors Wiki*. Established to help developers get started with embedded processors from Texas Instruments and to foster innovation and growth of general knowledge about the hardware and software surrounding these devices.

## 7.7 商標

MSP430, MSP430Ware, Code Composer Studio, EnergyTrace, ULP Advisor, E2E are trademarks of Texas Instruments.

All other trademarks are the property of their respective owners.

## 7.8 静電気放電に関する注意事項



すべての集積回路は、適切なESD保護方法を用いて、取扱いと保存を行うようにして下さい。

静電気放電はわずかな性能の低下から完全なデバイスの故障に至るまで、様々な損傷を与えます。高精度の集積回路は、損傷に対して敏感であり、極めてわずかなパラメータの変化により、デバイスに規定された仕様に適合しなくなる場合があります。

## 7.9 Export Control Notice

Recipient agrees to not knowingly export or re-export, directly or indirectly, any product or technical data (as defined by the U.S., EU, and other Export Administration Regulations) including software, or any controlled product restricted by other applicable national regulations, received from disclosing party under nondisclosure obligations (if any), or any direct product of such technology, to any destination to which such export or re-export is restricted or prohibited by U.S. or other applicable laws, without obtaining prior authorization from U.S. Department of Commerce and other competent Government authorities to the extent required by those laws.

## 7.10 Glossary

**TI Glossary** This glossary lists and explains terms, acronyms, and definitions.

## 8 メカニカル、パッケージ、および注文情報

以下のページには、メカニカル、パッケージ、および注文情報が記載されています。これらの情報は、指定のデバイスに対して提供されている最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。

## PACKAGING INFORMATION

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">MSP430F5131IDA</a>   | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| MSP430F5131IDA.B                 | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| <a href="#">MSP430F5131IDAR</a>  | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| MSP430F5131IDAR.B                | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| <a href="#">MSP430F5131IRSB</a>  | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| MSP430F5131IRSB.B                | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| <a href="#">MSP430F5131IRSBT</a> | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| MSP430F5131IRSBT.B               | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5131           |
| <a href="#">MSP430F5131IYFFR</a> | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5131           |
| MSP430F5131IYFFR.B               | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5131           |
| <a href="#">MSP430F5131IYFFT</a> | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5131           |
| MSP430F5131IYFFT.B               | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5131           |
| <a href="#">MSP430F5132IDA</a>   | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| MSP430F5132IDA.B                 | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| <a href="#">MSP430F5132IDAR</a>  | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| MSP430F5132IDAR.B                | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| <a href="#">MSP430F5132IRSB</a>  | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| MSP430F5132IRSB.B                | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| <a href="#">MSP430F5132IRSBT</a> | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| MSP430F5132IRSBT.B               | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5132           |
| <a href="#">MSP430F5132IYFFR</a> | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5132           |
| MSP430F5132IYFFR.B               | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5132           |
| <a href="#">MSP430F5132IYFFT</a> | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5132           |

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| MSP430F5132IYFFT.B               | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5132           |
| <a href="#">MSP430F5151IDA</a>   | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5151           |
| MSP430F5151IDA.B                 | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5151           |
| <a href="#">MSP430F5151IRSBR</a> | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5151       |
| MSP430F5151IRSBR.B               | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5151       |
| <a href="#">MSP430F5151IRSBT</a> | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5151       |
| MSP430F5151IRSBT.B               | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5151       |
| <a href="#">MSP430F5151IYFFR</a> | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5151           |
| MSP430F5151IYFFR.B               | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5151           |
| <a href="#">MSP430F5151IYFFT</a> | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5151           |
| MSP430F5151IYFFT.B               | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5151           |
| <a href="#">MSP430F5152IDA</a>   | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5152           |
| MSP430F5152IDA.B                 | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5152           |
| <a href="#">MSP430F5152IDAR</a>  | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5152           |
| MSP430F5152IDAR.B                | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5152           |
| <a href="#">MSP430F5152IRSBR</a> | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5152       |
| MSP430F5152IRSBR.B               | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5152       |
| <a href="#">MSP430F5152IRSBT</a> | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5152       |
| MSP430F5152IRSBT.B               | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5152       |
| <a href="#">MSP430F5152IYFFR</a> | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5152           |
| MSP430F5152IYFFR.B               | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5152           |
| <a href="#">MSP430F5152IYFFT</a> | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5152           |
| MSP430F5152IYFFT.B               | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5152           |
| <a href="#">MSP430F5171IDA</a>   | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5171           |
| MSP430F5171IDA.B                 | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5171           |

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">MSP430F5171IDAR</a>  | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5171           |
| MSP430F5171IDAR.B                | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5171           |
| <a href="#">MSP430F5171IRSB</a>  | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5171       |
| MSP430F5171IRSB.B                | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5171       |
| MSP430F5171IRSBG4                | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5171       |
| MSP430F5171IRSBG4.B              | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5171       |
| <a href="#">MSP430F5171IRSBT</a> | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5171       |
| MSP430F5171IRSBT.B               | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5171       |
| <a href="#">MSP430F5171IYFFR</a> | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5171           |
| MSP430F5171IYFFR.B               | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5171           |
| <a href="#">MSP430F5171IYFFT</a> | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5171           |
| MSP430F5171IYFFT.B               | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5171           |
| <a href="#">MSP430F5172IDA</a>   | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5172           |
| MSP430F5172IDA.B                 | Active        | Production           | TSSOP (DA)   38  | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5172           |
| <a href="#">MSP430F5172IDAR</a>  | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5172           |
| MSP430F5172IDAR.B                | Active        | Production           | TSSOP (DA)   38  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430F5172           |
| <a href="#">MSP430F5172IRSB</a>  | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5172       |
| MSP430F5172IRSB.B                | Active        | Production           | WQFN (RSB)   40  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5172       |
| <a href="#">MSP430F5172IRSBT</a> | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5172       |
| MSP430F5172IRSBT.B               | Active        | Production           | WQFN (RSB)   40  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | M430<br>F5172       |
| <a href="#">MSP430F5172IYFFR</a> | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5172           |
| MSP430F5172IYFFR.B               | Active        | Production           | DSBGA (YFF)   40 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5172           |
| <a href="#">MSP430F5172IYFFT</a> | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5172           |

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| MSP430F5172IYFFT.B    | Active        | Production           | DSBGA (YFF)   40 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | M430F5172           |

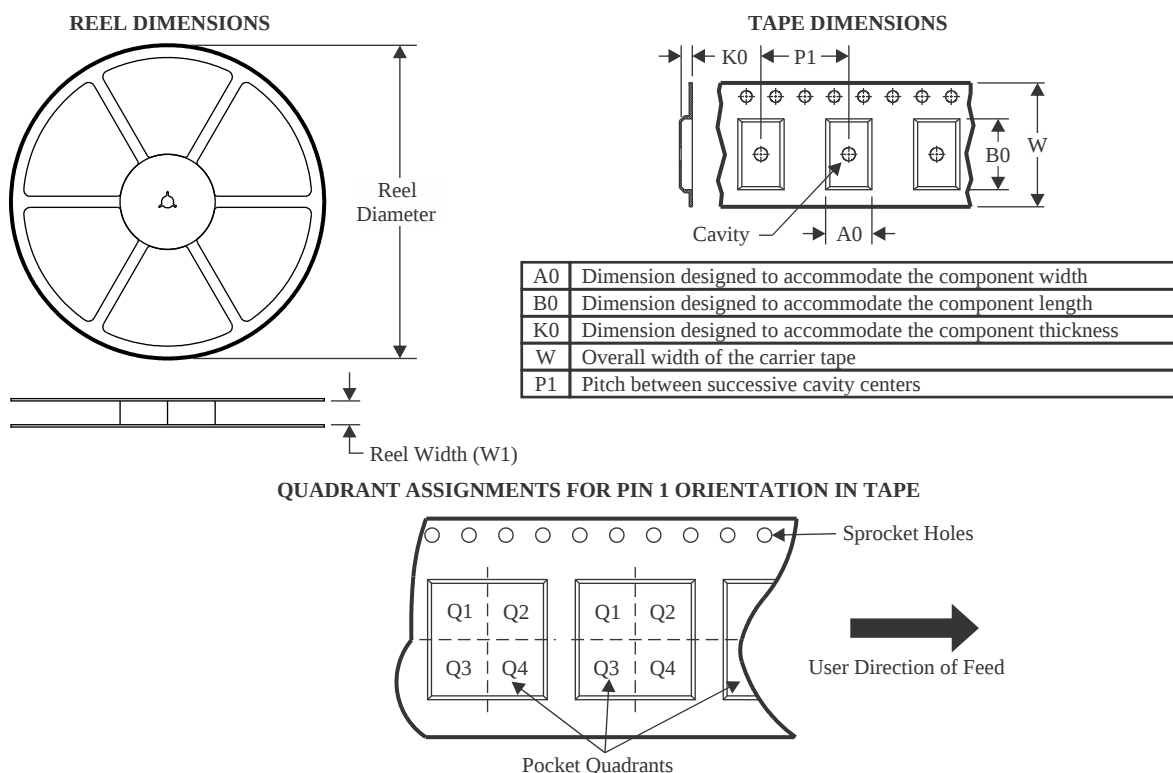
- <sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).
- <sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.
- <sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.
- <sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- <sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- <sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION

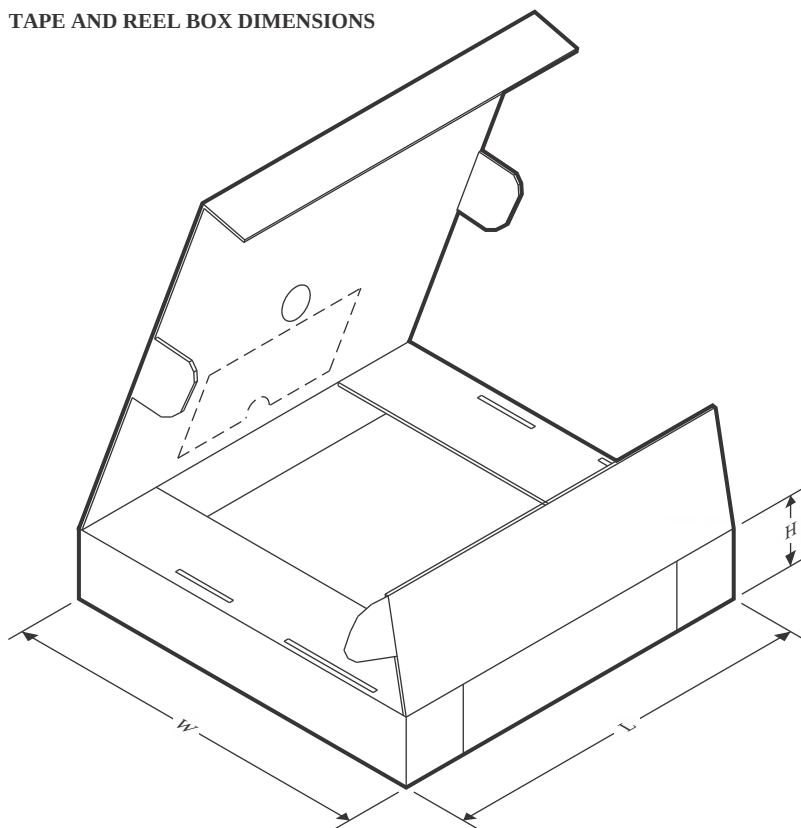


\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MSP430F5131IDAR | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5131IRSB | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5131IRSB | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5131IRSB | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5131IRSB | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5131IYFF | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5131IYFF | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5132IDAR | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5132IRSB | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5132IRSB | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5132IRSB | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5132IRSB | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5132IYFF | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5132IYFF | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5151IRSB | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5151IRSB | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MSP430F5151IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5151IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5151IYFFR  | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5151IYFFT  | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5152IDAR   | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5152IRSB   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5152IRSB   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5152IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5152IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5152IYFFR  | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5152IYFFT  | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5171IDAR   | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5171IRSB   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5171IRSB   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5171IRSBG4 | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5171IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5171IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5171IYFFR  | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5171IYFFT  | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5172IDAR   | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5172IRSB   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5172IRSB   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5172IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5172IRSBT  | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| MSP430F5172IYFFR  | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5172IYFFT  | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS

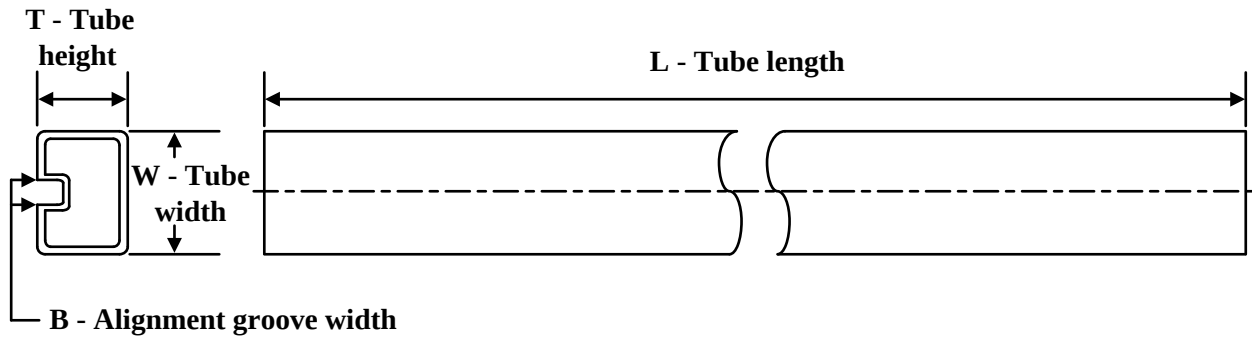


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MSP430F5131IDAR  | TSSOP        | DA              | 38   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430F5131IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5131IRSB  | WQFN         | RSB             | 40   | 3000 | 353.0       | 353.0      | 32.0        |
| MSP430F5131IRSBT | WQFN         | RSB             | 40   | 250  | 213.0       | 191.0      | 35.0        |
| MSP430F5131IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5131IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5131IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5132IDAR  | TSSOP        | DA              | 38   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430F5132IRSB  | WQFN         | RSB             | 40   | 3000 | 353.0       | 353.0      | 32.0        |
| MSP430F5132IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5132IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5132IRSBT | WQFN         | RSB             | 40   | 250  | 213.0       | 191.0      | 35.0        |
| MSP430F5132IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5132IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5151IRSB  | WQFN         | RSB             | 40   | 3000 | 353.0       | 353.0      | 32.0        |
| MSP430F5151IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5151IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5151IRSBT | WQFN         | RSB             | 40   | 250  | 213.0       | 191.0      | 35.0        |

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MSP430F5151IYFFR  | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5151IYFFT  | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5152IDAR   | TSSOP        | DA              | 38   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430F5152IRSB   | WQFN         | RSB             | 40   | 3000 | 353.0       | 353.0      | 32.0        |
| MSP430F5152IRSB   | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5152IRSBT  | WQFN         | RSB             | 40   | 250  | 213.0       | 191.0      | 35.0        |
| MSP430F5152IRSBT  | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5152IYFFR  | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5152IYFFT  | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5171IDAR   | TSSOP        | DA              | 38   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430F5171IRSB   | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5171IRSB   | WQFN         | RSB             | 40   | 3000 | 353.0       | 353.0      | 32.0        |
| MSP430F5171IRSBG4 | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5171IRSBT  | WQFN         | RSB             | 40   | 250  | 213.0       | 191.0      | 35.0        |
| MSP430F5171IRSBT  | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5171IYFFR  | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5171IYFFT  | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5172IDAR   | TSSOP        | DA              | 38   | 2000 | 350.0       | 350.0      | 43.0        |
| MSP430F5172IRSB   | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5172IRSB   | WQFN         | RSB             | 40   | 3000 | 353.0       | 353.0      | 32.0        |
| MSP430F5172IRSBT  | WQFN         | RSB             | 40   | 250  | 213.0       | 191.0      | 35.0        |
| MSP430F5172IRSBT  | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5172IYFFR  | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5172IYFFT  | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |

## TUBE



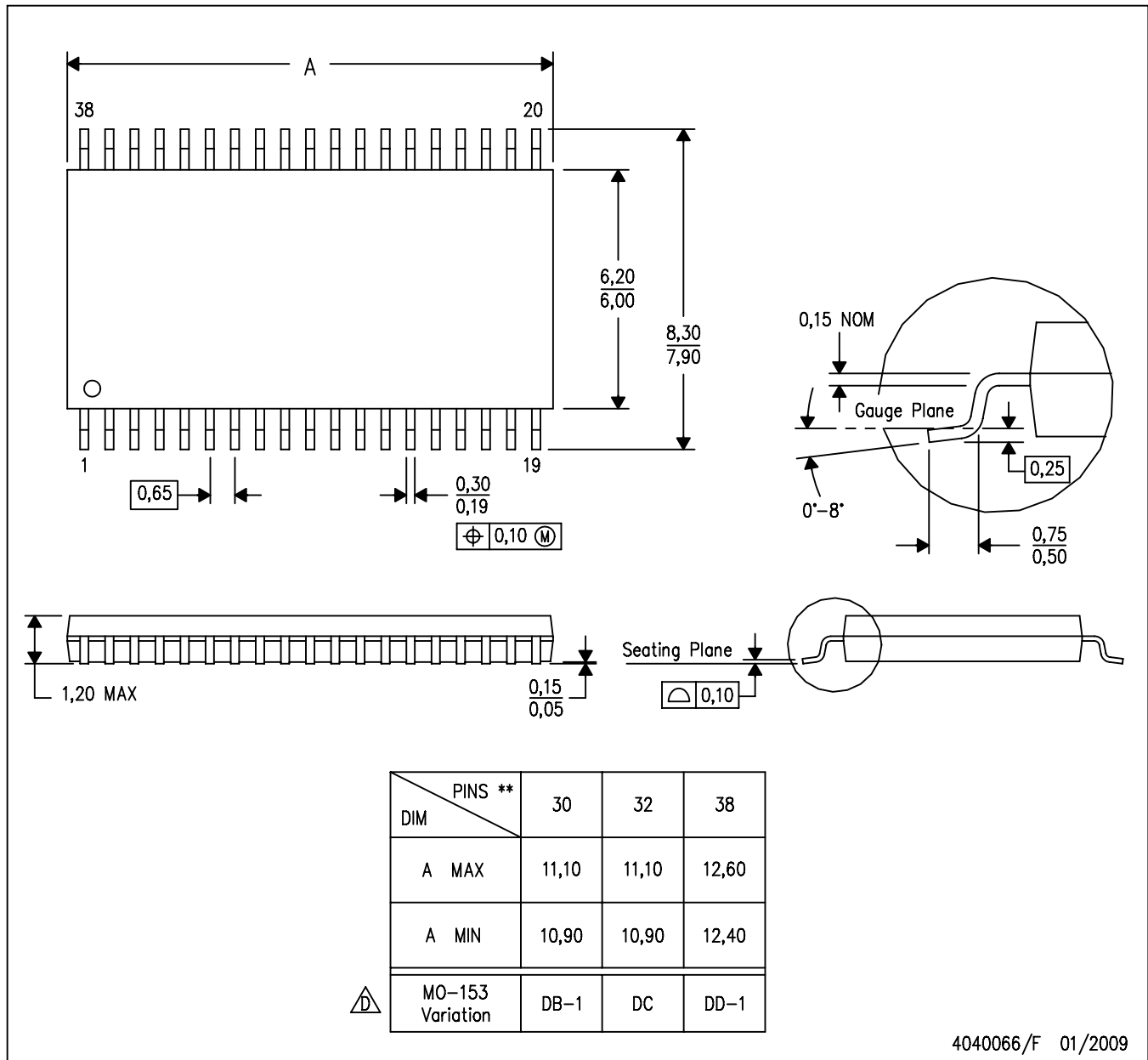
\*All dimensions are nominal

| Device           | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| MSP430F5131IDA   | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5131IDA.B | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5132IDA   | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5132IDA.B | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5151IDA   | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5151IDA.B | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5152IDA   | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5152IDA.B | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5171IDA   | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5171IDA.B | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5172IDA   | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |
| MSP430F5172IDA.B | DA           | TSSOP        | 38   | 40  | 530    | 11.89  | 3600   | 4.9    |

DA (R-PDSO-G\*\*)

38 PIN SHOWN

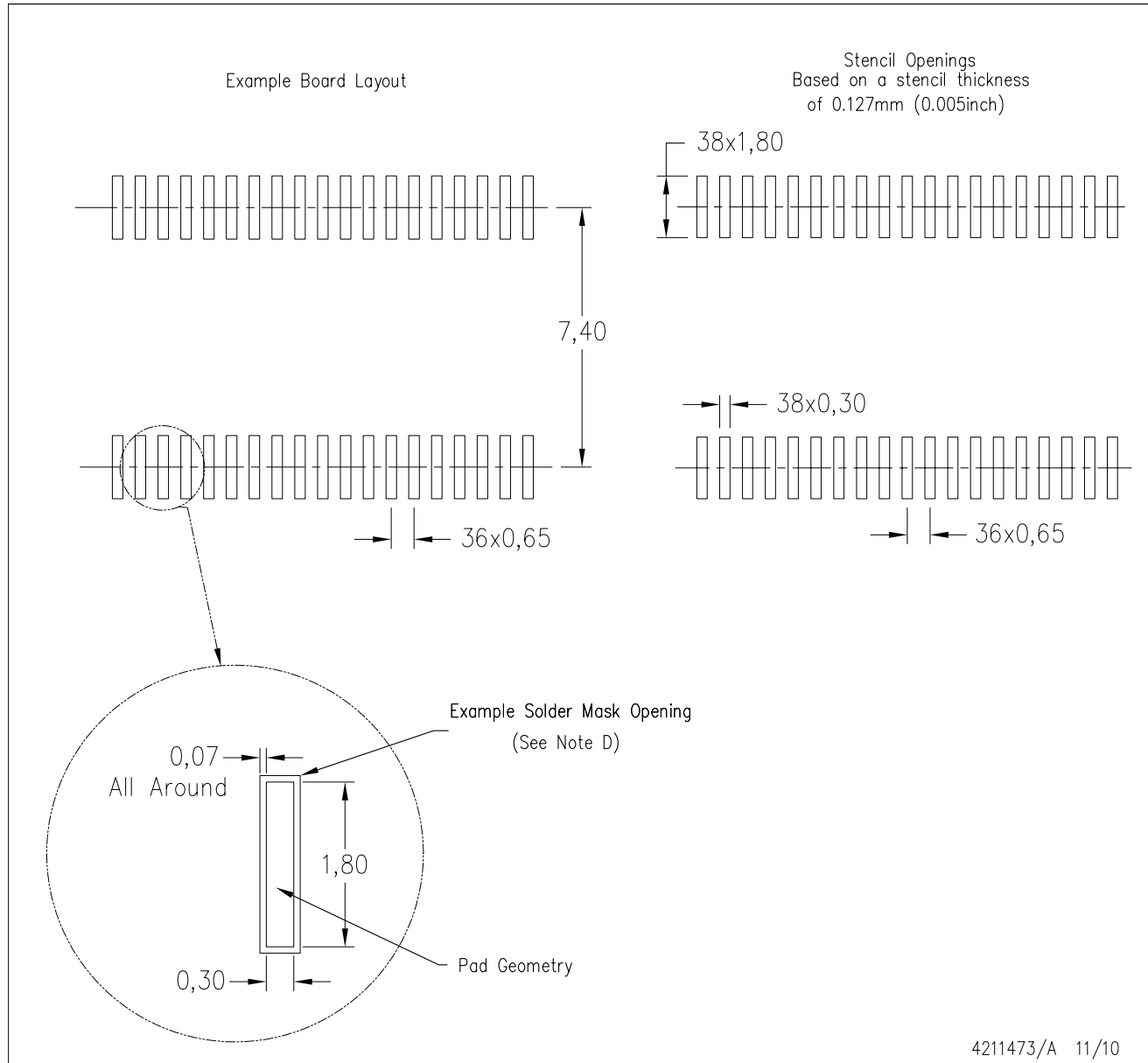
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-153, except 30 pin body length.

DA (R-PDSO-G38)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
  - D. Contact the board fabrication site for recommended soldermask tolerances.

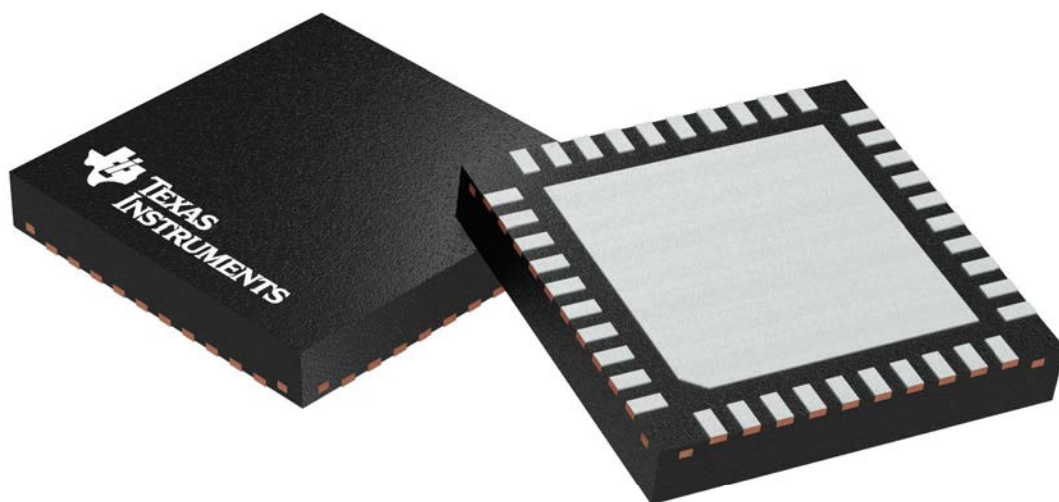
## GENERIC PACKAGE VIEW

**RSB 40**

**WQFN - 0.8 mm max height**

**5 x 5 mm, 0.4 mm pitch**

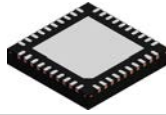
PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4207182/D

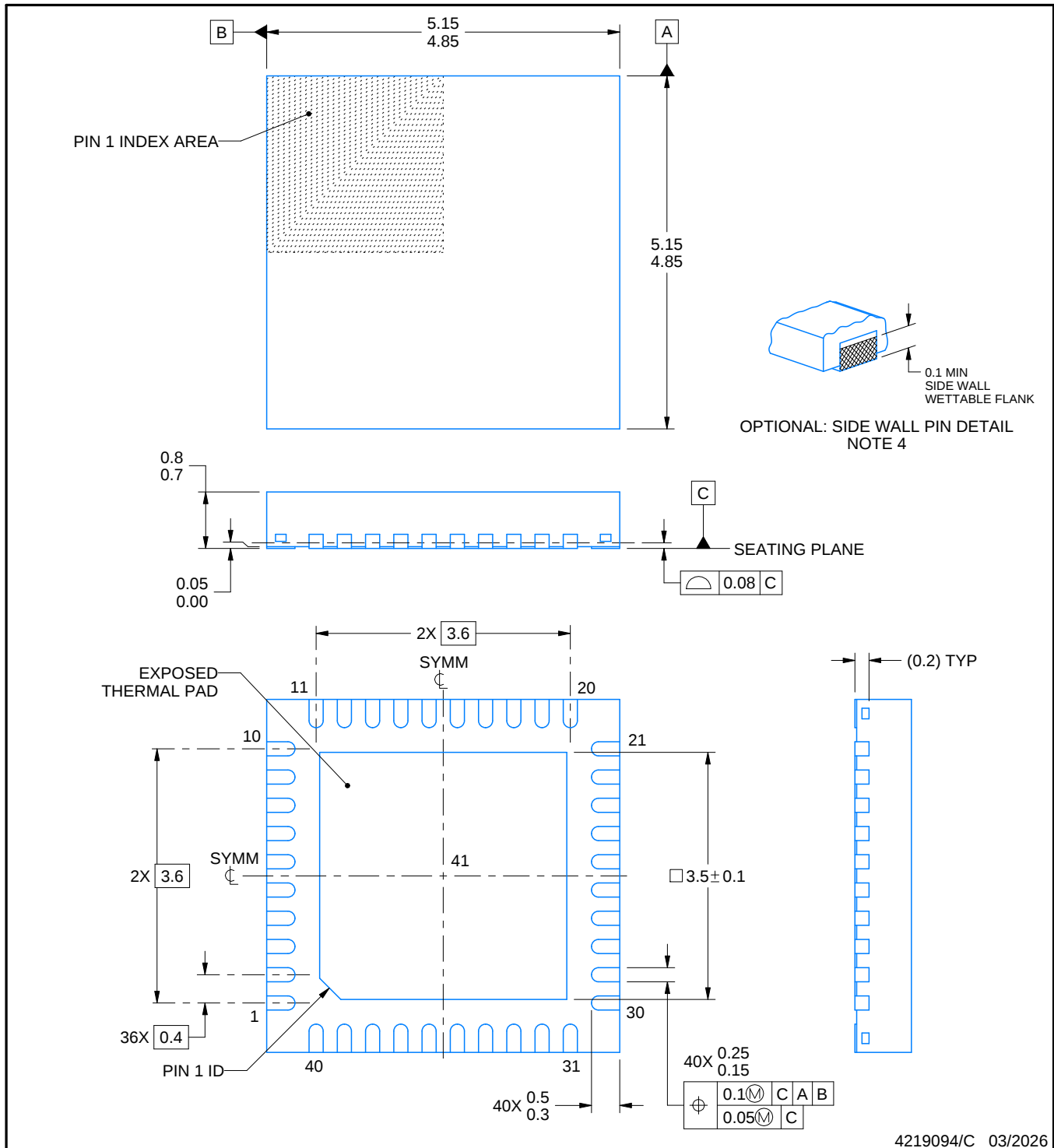
RSB0040B



# PACKAGE OUTLINE

## WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4219094/C 03/2026

### NOTES:

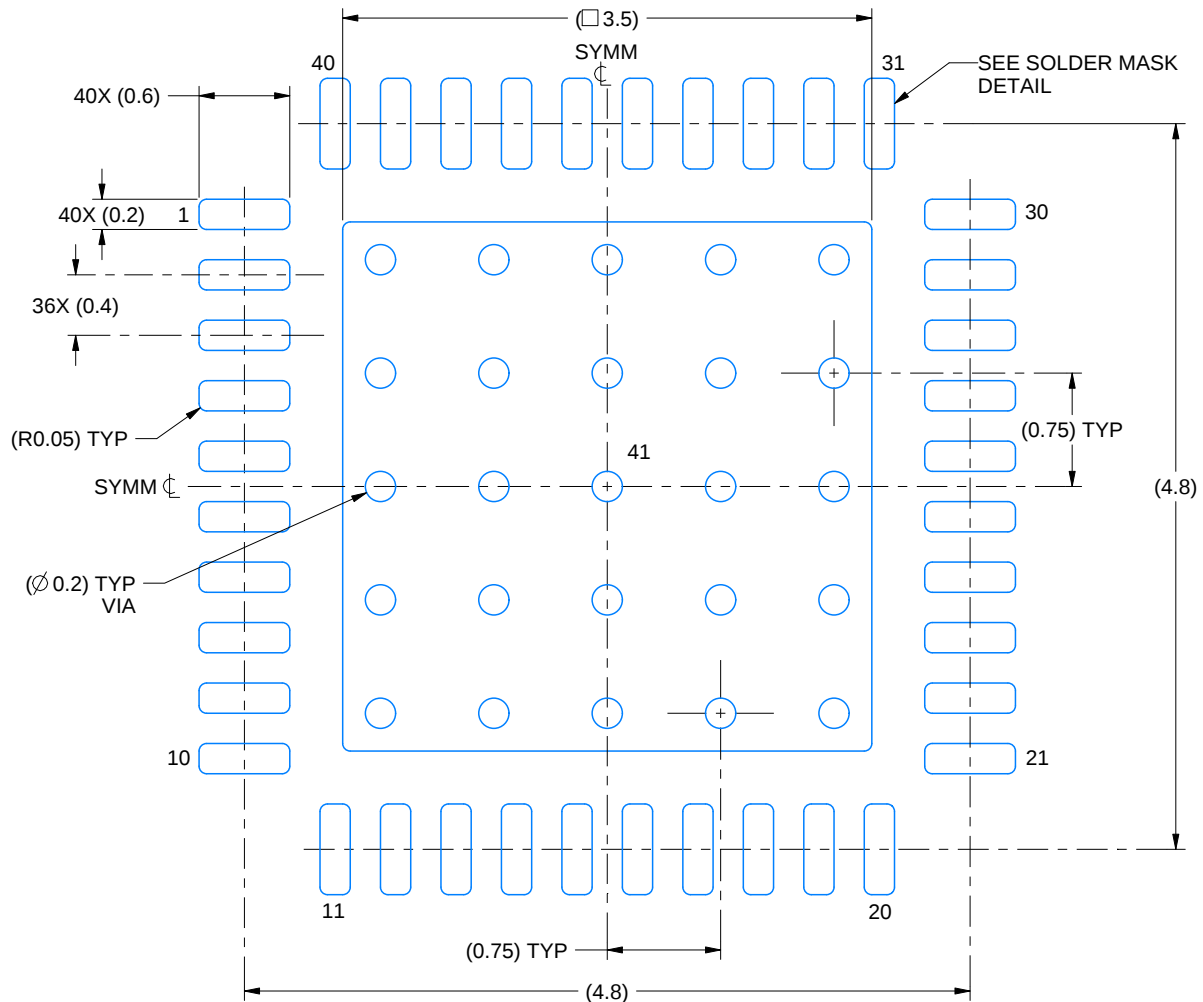
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.
4. Minimum 0.1 mm solder wetting on pin side wall. Available for wettable flank version only.

# EXAMPLE BOARD LAYOUT

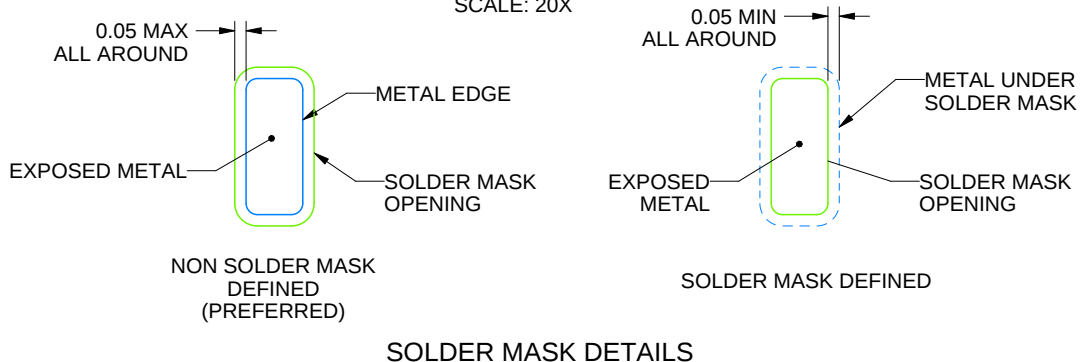
RSB0040B

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 20X



4219094/C 03/2026

NOTES: (continued)

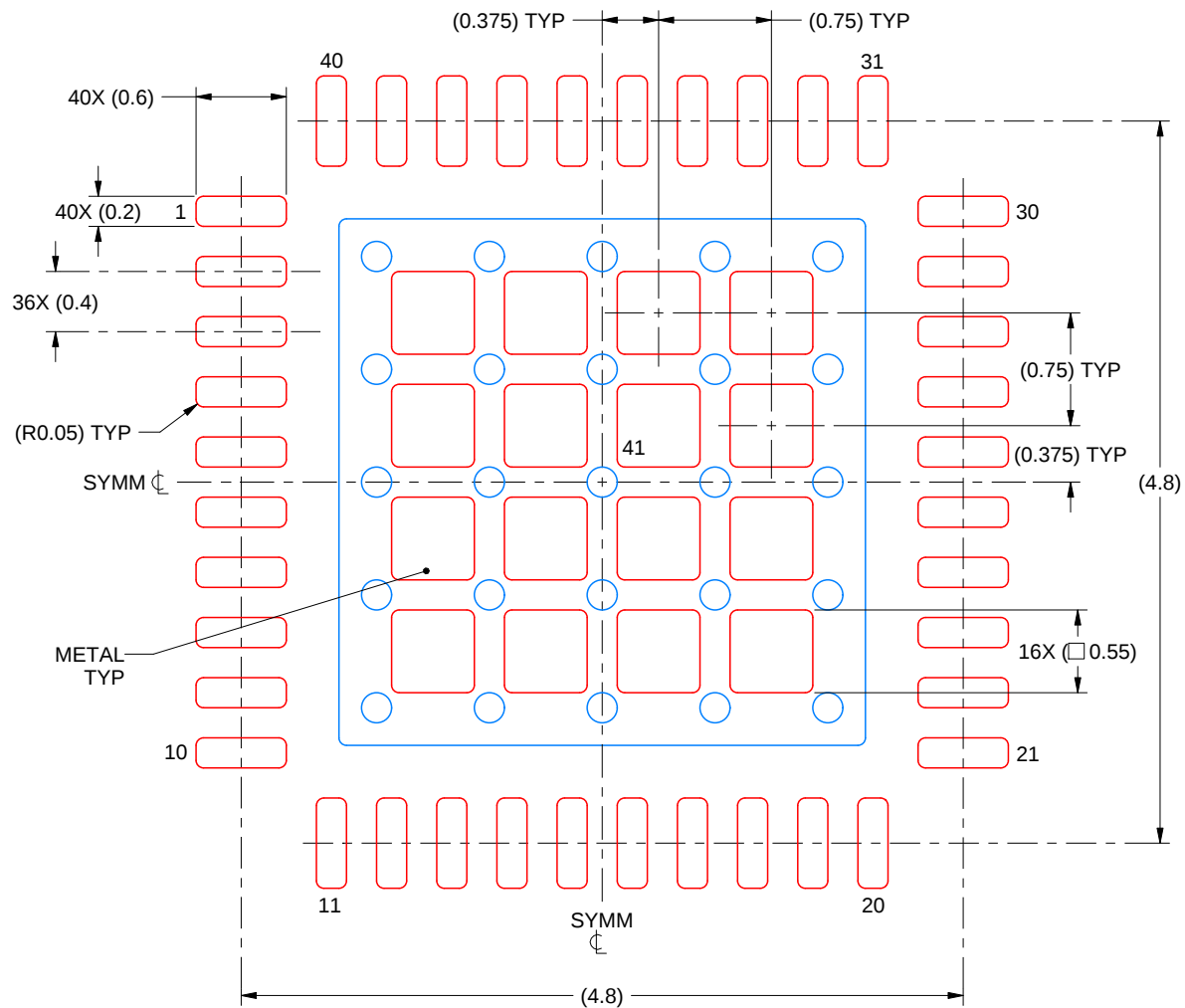
5. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
6. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RSB0040B

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
 BASED ON 0.125 MM THICK STENCIL  
 SCALE: 20X

EXPOSED PAD 41  
 40% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

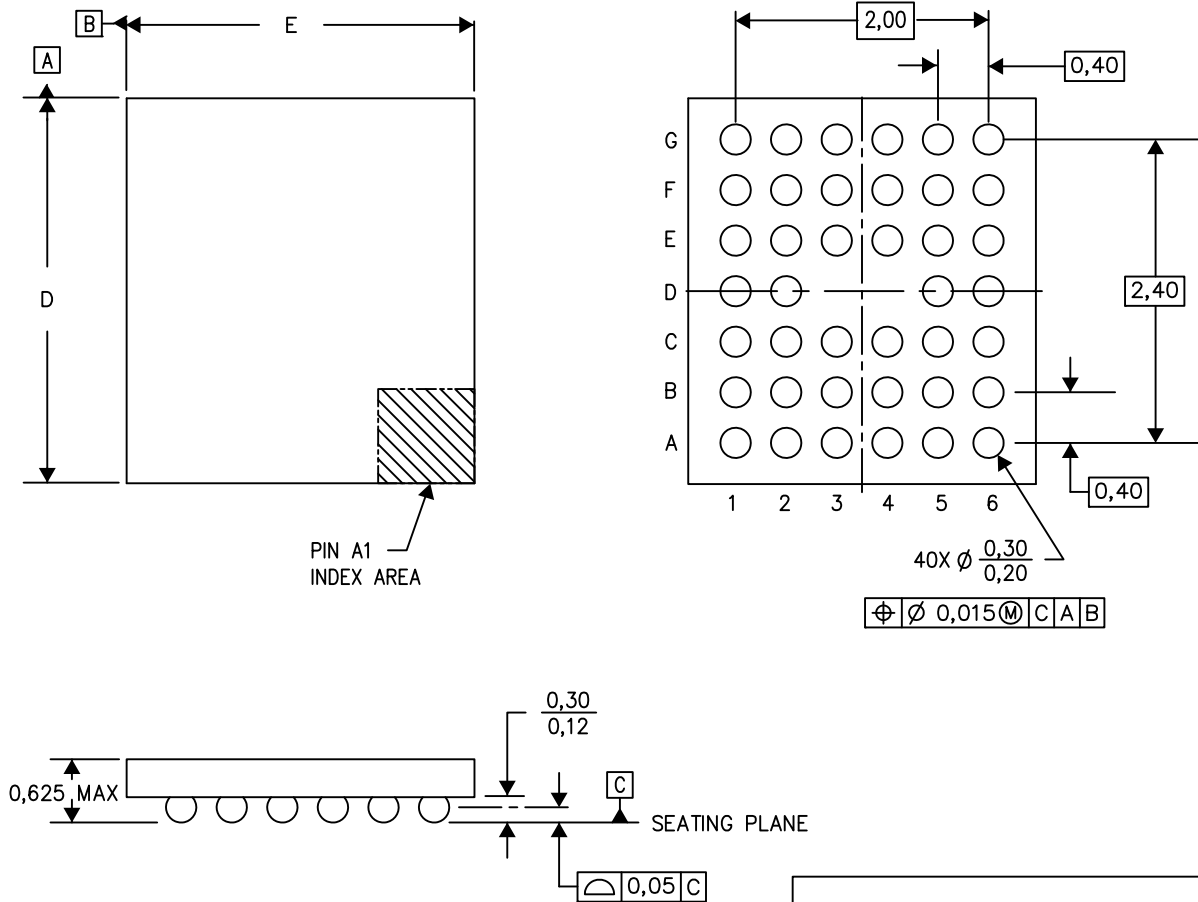
4219094/C 03/2026

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

YFF (R-XBGA-N40)

DIE-SIZE BALL GRID ARRAY



D: Max = 3.09 mm, Min = 3.03 mm

E: Max = 2.79 mm, Min = 2.73 mm

4207625-35/A0 12/13

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.

## 重要なお知らせと免責事項

TI は、技術データと信頼性データ (データシートを含みます)、設計リソース (リファレンス デザインを含みます)、アプリケーションや設計に関する各種アドバイス、Web ツール、安全性情報、その他のリソースを、欠陥が存在する可能性のある「現状のまま」提供しており、商品性および特定目的に対する適合性の黙示保証、第三者の知的財産権の非侵害保証を含みいかなる保証も、明示的または黙示的にかかわらず拒否します。

これらのリソースは、TI 製品を使用する設計の経験を積んだ開発者への提供を意図したものです。(1) お客様のアプリケーションに適した TI 製品の選定、(2) お客様のアプリケーションの設計、検証、試験、(3) お客様のアプリケーションに該当する各種規格や、その他のあらゆる安全性、セキュリティ、規制、または他の要件への確実な適合に関する責任を、お客様のみが単独で負うものとし、TI は一切の責任を拒否します。

上記の各種リソースは、予告なく変更される可能性があります。これらのリソースは、リソースで説明されている TI 製品を使用するアプリケーションの開発の目的でのみ、TI はその使用をお客様に許諾します。これらのリソースに関して、他の目的で複製することや掲載することは禁止されています。TI や第三者の知的財産権のライセンスが付与されている訳ではありません。お客様は、これらのリソースを自身で使用した結果発生するあらゆる申し立て、損害、費用、損失、責任について、TI およびその代理人を完全に補償するものとし、TI は一切の責任を拒否します。

TI の製品は、[TI の販売条件](#)、[TI の総合的な品質ガイドライン](#)、[ti.com](#) または TI 製品などに関連して提供される他の適用条件に従い提供されます。TI がこれらのリソースを提供することは、適用される TI の保証または他の保証の放棄の拡大や変更を意味するものではありません。TI がカスタム、またはカスタマー仕様として明示的に指定していない限り、TI の製品は標準的なカタログに掲載される汎用機器です。

お客様がいかなる追加条項または代替条項を提案する場合も、TI はそれらに異議を唱え、拒否します。

Copyright © 2026, Texas Instruments Incorporated

最終更新日：2025 年 10 月